

ADC344x 四通道、14 位、25MSPS 至 125MSPS 模数转换器

1 特性

- 四通道
- 14 位分辨率
- 单电源：1.8V
- 串行低压差分信号 (LVDS) 接口
- 支持 1 分频、2 分频和 4 分频的灵活输入时钟缓冲器
- $f_{IN} = 70\text{MHz}$ 时，信噪比 (SNR) = 72.4dBFS，无杂散动态范围 (SFDR) = 87dBc
- 超低功耗：
 - 125MSPS 时为每通道 98mW
- 通道隔离：105dB
- 内部抖动和斩波
- 支持多芯片同步
- 与 12 位版本器件之间具有引脚到引脚兼容性
- 封装：超薄四方扁平无引线 (VQFN)-56 (8mm x 8mm)

2 应用

- 多载波、多模式蜂窝基站
- 雷达和智能天线阵列
- 炮弹制导
- 电机控制反馈
- 网络和矢量分析器
- 通信测试设备
- 无损检测
- 微波接收器
- 软件定义无线电 (SDR)
- 正交和分集无线电接收器

3 说明

ADC344x 器件属于高线性度、超低功耗、四通道、14 位、25MSPS 至 125MSPS 模数转换器 (ADC) 系列。此类器件专门设计用于支持具有宽动态范围需求且要求苛刻的高输入频率信号。输入时钟分频器可给予系统时钟架构设计更高的灵活性，同时 SYSREF 输入可实现整个系统同步。

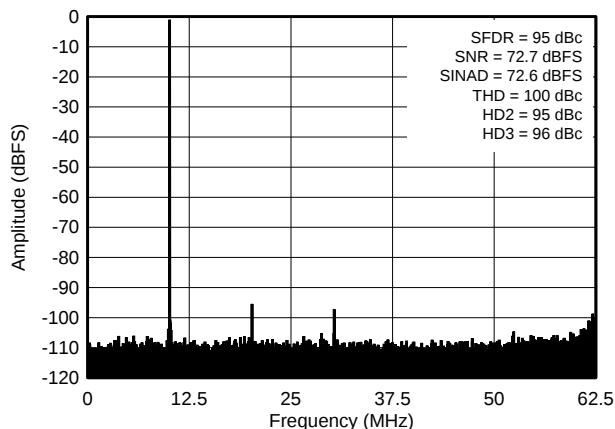
ADC344x 系列支持串行低压差分信号 (LVDS)，从而减少接口线路的数量，实现高系统集成密度。串行 LVDS 接口为双线制，通过两个 LVDS 对串行输出每个 ADC 数据。此外，也可提供单线制串行 LVDS 接口。内部锁相环 (PLL) 会将传入的 ADC 采样时钟加倍，以获得串行输出各通道的 14 位输出数据时所使用的位时钟。除了串行数据流之外，数据帧和位时钟也作为 LVDS 输出进行传送。

器件信息

器件型号	封装	封装尺寸 (标称值)
ADC344x	VQFN (56)	8.00mm x 8.00mm

(1) 要了解所有可用封装，请参阅数据表末尾的可订购产品附录。

10MHz 时的频谱



目录

1 特性	1	7.20 Typical Characteristics: Contour	44
2 应用	1	8 Parameter Measurement Information	44
3 说明	1	8.1 Timing Diagrams	44
4 修订历史记录	2	9 Detailed Description	47
5 Device Comparison Table	4	9.1 Overview	47
6 Pin Configuration and Functions	4	9.2 Functional Block Diagram	47
7 Specifications	6	9.3 Feature Description	48
7.1 Absolute Maximum Ratings	6	9.4 Device Functional Modes	53
7.2 ESD Ratings	6	9.5 Programming	54
7.3 Recommended Operating Conditions	6	9.6 Register Maps	59
7.4 Thermal Information	7	10 Application and Implementation	74
7.5 Electrical Characteristics: General	7	10.1 Application Information	74
7.6 Electrical Characteristics: ADC3441, ADC3442	8	10.2 Typical Applications	75
7.7 Electrical Characteristics: ADC3443, ADC3444	8	11 Power Supply Recommendations	77
7.8 AC Performance: ADC3441	9	12 Layout	78
7.9 AC Performance: ADC3442	11	12.1 Layout Guidelines	78
7.10 AC Performance: ADC3443	13	12.2 Layout Example	78
7.11 AC Performance: ADC3444	15	13 器件和文档支持	79
7.12 Digital Characteristics	17	13.1 相关链接	79
7.13 Timing Requirements: General	17	13.2 接收文档更新通知	79
7.14 Timing Requirements: LVDS Output	18	13.3 社区资源	79
7.15 Typical Characteristics: ADC3441	19	13.4 商标	79
7.16 Typical Characteristics: ADC3442	25	13.5 静电放电警告	79
7.17 Typical Characteristics: ADC3443	31	13.6 Glossary	79
7.18 Typical Characteristics: ADC3444	37	14 机械、封装和可订购信息	79
7.19 Typical Characteristics: Common	43		

4 修订历史记录

注：之前版本的页码可能与当前版本有所不同。

Changes from Revision A (October 2015) to Revision B	Page
• 已添加 在 说明部分添加了有关可提供单线制串行 LVDS 接口的说明	1
• 已更改 10MHz 时的频谱图，显示曲线内的情况	1
• Changed description of AVDD, DVDD, and GND pins and added <i>active high</i> to description of PDN pin in <i>Pin Functions</i> table	5
• Deleted <i>maximum</i> from parameter description in <i>Recommended Operating Conditions</i> table	6
• Changed Digital Outputs, R_{LOAD} parameter description in <i>Recommended Operating Conditions</i> table	6
• Changed conditions of all <i>Electrical Characteristics</i> and <i>AC Performance</i> tables	7
• Added minimum and maximum specifications to Analog Input, $V_{OC(VCM)}$ parameter in <i>Electrical Characteristics: General</i> table	7
• Changed description of Analog Input, <i>Analog input bandwidth</i> parameter in <i>Electrical Characteristics: General</i> table	7
• Deleted footnote 1 from <i>Electrical Characteristics: General</i> table	7
• Added DC Accuracy, E_G parameter with its test conditions and footnote 3 to <i>Electrical Characteristics: General</i> table	7
• Deleted $E_{G(REF)}$ and $E_{G(CHAN)}$ from DC Accuracy in <i>Electrical Characteristics: General</i> table	7
• Changed DC Accuracy, $\alpha_{(EGCHAN)}$ to α_{EG} and updated its parameter in <i>Electrical Characteristics: General</i> table	7
• Changed Channel-to-Channel Isolation, <i>Crosstalk</i> parameter in <i>Electrical Characteristics: General</i> table: changed test conditions, added footnote 2	7
• Changed test conditions for IMD3 parameter in <i>AC Performance: ADC3441</i> table	10
• Added INL and DNL rows to all <i>AC Performance</i> tables	10
• Changed <i>Digital Inputs (SYSREFP, SYSREFM)</i> subsection in <i>Digital Characteristics</i> table, added footnote 2	17

修订历史记录 (接下页)

• Changed specifications of Digital Outputs (LVDS Interface), V_{OCM} parameter in <i>Digital Characteristics</i> table.....	17
• Changed <i>rising</i> to <i>falling</i> in description of <i>SYSREF reference time</i> parameter in <i>Timing Requirements: General</i> table ...	17
• Changed <i>Typical Characteristics</i> sections: added <i>dither on</i> to all section condition statements, changed <i>Non 23</i> to <i>excluding HD2, HD3</i>	19
• Added INL and DNL plots in Typical Characteristics: ADC3441 section	24
• Changed conditions of Figure 34 , Figure 35	25
• Added INL and DNL plots in Typical Characteristics: ADC3442 section	30
• Changed conditions of Figure 67 , Figure 68	31
• Added INL and DNL plots in Typical Characteristics: ADC3443 section	36
• Changed conditions of Figure 100 , Figure 101	37
• Added INL and DNL plots in Typical Characteristics: ADC3444 section.	42
• Changed conditions of Figure 134	43
• Added Figure 141 to <i>Timing Diagrams</i> section	44
• Added <i>Using the SYSREF Input</i> section	50
• Changed the description about synchronization of the phase of the divided clock in each device to the common sampling clock in Using the SYSREF Input section.	50
• Added <i>ADC3441 Power-Up Requirements</i> section, deleted the <i>Register Initialization</i> section	57
• Added last sentence to <i>Detailed Design Procedure</i> section of first typical application.....	75
• Added <i>Chopper On</i> to caption of Figure 198	75
• Added <i>Chopper Off</i> to caption of Figure 200	76
• Changed the caption of Figure 202 from <i>FFT for 450-MHz Input Signal (Dither On)</i> to <i>FFT for 450-MHz Input Signal (Chopper Off, Dither On)</i>	77

Changes from Original (July 2014) to Revision A

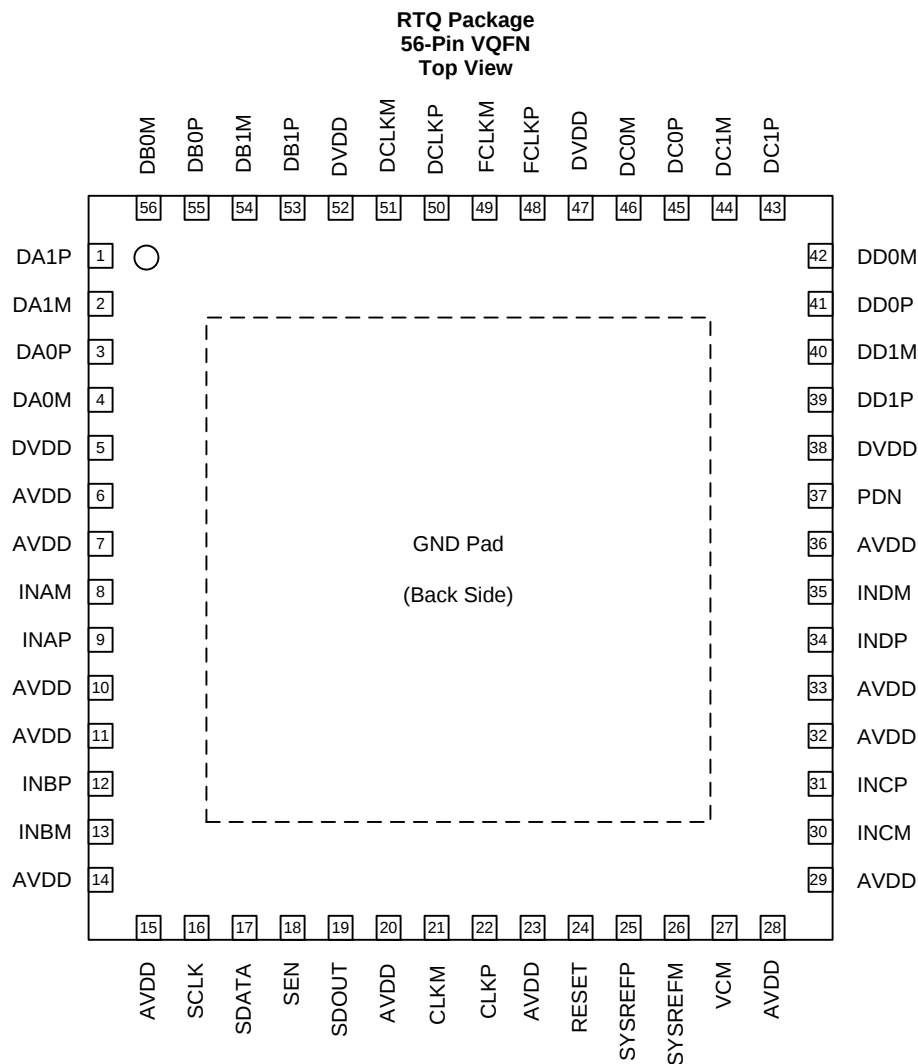
Page

• 已发布量产	1
---------------	---

5 Device Comparison Table

INTERFACE	RESOLUTION (Bits)	25 MSPS	50 MSPS	80 MSPS	125 MSPS	160 MSPS
Serial LVDS	12	ADC3421	ADC3422	ADC3423	ADC3424	—
	14	ADC3441	ADC3442	ADC3443	ADC3444	—
JESD204B	12	—	ADC34J22	ADC34J23	ADC34J24	ADC34J25
	14	—	ADC34J42	ADC34J43	ADC34J44	ADC34J45

6 Pin Configuration and Functions



Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO.		
AVDD	6, 7, 10, 11, 14, 15, 20, 23, 28, 29, 32, 33, 36	I	Analog 1.8-V power supply, decoupled with capacitors
CLKM	21	I	Negative differential clock input for the ADC
CLKP	22	I	Positive differential clock input for the ADC
DA0M	4	O	Negative serial LVDS output for wire-0 of channel A
DA0P	3	O	Positive serial LVDS output for wire-0 of channel A
DA1M	2	O	Negative serial LVDS output for wire-1 of channel A
DA1P	1	O	Positive serial LVDS output for wire-1 of channel A
DB0M	56	O	Negative serial LVDS output for wire-0 of channel B
DB0P	55	O	Positive serial LVDS output for wire-0 of channel B
DB1M	54	O	Negative serial LVDS output for wire-1 of channel B
DB1P	53	O	Positive serial LVDS output for wire-1 of channel B
DC0M	46	O	Negative serial LVDS output for wire-0 of channel C
DC0P	45	O	Positive serial LVDS output for wire-0 of channel C
DC1M	44	O	Negative serial LVDS output for wire-1 of channel C
DC1P	43	O	Positive serial LVDS output for wire-1 of channel C
DD0M	42	O	Negative serial LVDS output for wire-0 of channel D
DD0P	41	O	Positive serial LVDS output for wire-0 of channel D
DD1M	40	O	Negative serial LVDS output for wire-1 of channel D
DD1P	39	O	Positive serial LVDS output for wire-1 of channel D
DCLKM	51	O	Negative bit clock output
DCLKP	50	O	Positive bit clock output
DVDD	5, 38, 47, 52	I	Digital 1.8-V power supply, decoupled with capacitors
FCLKM	49	O	Negative frame clock output
FCLKP	48	O	Positive frame clock output
GND	PowerPAD™	I	Ground, 0 V. Connect to the printed circuit board (PCB) ground plane.
INAM	8	I	Negative differential analog input for channel A
INAP	9	I	Positive differential analog input for channel A
INBM	13	I	Negative differential analog input for channel B
INBP	12	I	Positive differential analog input for channel B
INCM	30	I	Negative differential analog input for channel C
INCP	31	I	Positive differential analog input for channel C
INDM	35	I	Negative differential analog input for channel D
INDP	34	I	Positive differential analog input for channel D
PDN	37	I	Power-down control; active high. This pin may be configured through the SPI. This pin has an internal 150-kΩ pulldown resistor.
RESET	24	I	Hardware reset; active high. This pin has an internal 150-kΩ pulldown resistor.
SCLK	16	I	Serial interface clock input. This pin has an internal 150-kΩ pulldown resistor.
SDATA	17	I	Serial interface data input. This pin has an internal 150-kΩ pulldown resistor.
SDOUT	19	O	Serial interface data output
SEN	18	I	Serial interface enable; active low. This pin has an internal 150-kΩ pullup resistor to AVDD.
SYSREFM	26	I	Negative external SYSREF input
SYSREFP	25	I	Positive external SYSREF input
VCM	27	O	Common-mode voltage for analog inputs

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Analog supply voltage range, AVDD		−0.3	2.1	V
Digital supply voltage range, DVDD		−0.3	2.1	V
Voltage applied to input pins	INAP, INBP, INAM, INBM	−0.3	min (1.9, AVDD + 0.3)	V
	CLKP, CLKM	−0.3	AVDD + 0.3	
	SYSREFP, SYSREFM	−0.3	AVDD + 0.3	
	SCLK, SEN, SDATA, RESET, PDN	−0.3	3.9	
Temperature	Operating free-air, T _A	−40	85	°C
	Operating junction, T _J		125	
	Storage, T _{stg}	−65	150	

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
V _(ESD)	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	NOM	MAX	UNIT
SUPPLIES					
AVDD	Analog supply voltage range	1.7	1.8	1.9	V
DVDD	Digital supply voltage range	1.7	1.8	1.9	V
ANALOG INPUT					
V _{ID}	Differential input voltage	For input frequencies < 450 MHz	2		V _{PP}
		For input frequencies < 600 MHz	1		
V _{IC}	Input common-mode voltage	VCM ± 0.025			V
CLOCK INPUT					
Input clock frequency		Sampling clock frequency	15 ⁽²⁾	125 ⁽³⁾	MSPS
Input clock amplitude (differential)	Sine wave, ac-coupled		0.2	1.5	V _{PP}
	LPECL, ac-coupled		1.6		
	LVDS, ac-coupled		0.7		
Input clock duty cycle		35%	50%	65%	
Input clock common-mode voltage		0.95			V
DIGITAL OUTPUTS					
C _{LOAD}	External load capacitance from each output pin to GND		3.3		pF
R _{LOAD}	Differential load resistance to be placed across the positive and negative pins of the LVDS output pair		100		Ω

- (1) After power-up, only use the RESET pin to reset the device for the first time; see the [Register Initialization](#) section for details.
(2) See [Table 3](#) for details.
(3) With the clock divider enabled by default for divide-by-1. Maximum sampling clock frequency for the divide-by-4 option is 500 MSPS.

7.4 Thermal Information

THERMAL METRIC ⁽¹⁾		ADC344x	UNIT
		RTQ (VQFN)	
		56 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	25.3	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	9.5	°C/W
R _{θJB}	Junction-to-board thermal resistance	3.4	°C/W
ψ _{JT}	Junction-to-top characterization parameter	0.2	°C/W
ψ _{JB}	Junction-to-board characterization parameter	3.3	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	0.5	°C/W

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

7.5 Electrical Characteristics: General

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
ANALOG INPUT							
	Differential input full-scale			2.0			V _{PP}
r _i	Input resistance	Differential at dc		6.6			kΩ
c _i	Input capacitance	Differential at dc		3.7			pF
V _{OC(VCM)}	VCM common-mode voltage output			0.8	0.95	1.1	V
	VCM output current capability			10			mA
	Input common-mode current	Per analog input pin		1.5			μA/MSPS
	Analog input bandwidth (–3-dB point)	50-Ω differential source driving 50-Ω termination across INP and INM		540			MHz
DC ACCURACY							
E _O	Offset error			–25		25	mV
α _{EO}	Temperature coefficient of offset error			±0.024			mV/°C
E _G	Overall dc gain error of a channel	ADC3441		–2		2	%FS
		ADC3442, ADC3443, ADC3444		–2.5		2.5	
α _{EG}	Temperature coefficient of overall gain error			0.005			Δ%FS/°C
CHANNEL-TO-CHANNEL ISOLATION							
Crosstalk ⁽¹⁾⁽²⁾	f _{IN} = 10 MHz	Between near channels		105			dB
		Between far channels		105			
	f _{IN} = 100 MHz	Between near channels		95			
		Between far channels		105			
	f _{IN} = 200 MHz	Between near channels		94			
		Between far channels		105			
	f _{IN} = 230 MHz	Between near channels		92			
		Between far channels		105			
	f _{IN} = 300 MHz	Between near channels		85			
		Between far channels		105			

(1) Crosstalk is measured with a –1-dBFS input signal on the aggressor channel and no input on the victim channel.

(2) Channels A and B are near to each other but far from channels C and D. Similarly, channels C and D are near to each other but far from channels A and B; see the [Pin Configuration and Functions](#) section for more information.

7.6 Electrical Characteristics: ADC3441, ADC3442

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER	ADC3441			ADC3442			UNIT
	MIN	TYP	MAX	MIN	TYP	MAX	
ADC clock frequency			25			50	MSPS
Resolution	14			14			Bits
1.8-V analog supply current		54	74		71	97	mA
1.8-V digital supply current		45	67		56	83	mA
Total power dissipation		177	215		228	277	mW
Global power-down dissipation		5	17		5	17	mW
Standby power-down dissipation		34	103		35	103	mW

7.7 Electrical Characteristics: ADC3443, ADC3444

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER	ADC3443			ADC3444			UNIT
	MIN	TYP	MAX	MIN	TYP	MAX	
ADC clock frequency			80			125	MSPS
Resolution	14			14			Bits
1.8-V analog supply current		92	125		119	162	mA
1.8-V digital supply current		68	101		98	145	mA
Total power dissipation		288	350		391	475	mW
Global power-down dissipation		5	17		5	17	mW
Standby power-down dissipation		40	103		43	103	mW

7.8 AC Performance: ADC3441

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS	ADC3441 (f _S = 25 MSPS)						UNIT
			DITHER ON			DITHER OFF			
			MIN	TYP	MAX	MIN	TYP	MAX	
SNR	Signal-to-noise ratio (from 1-MHz offset)	f _{IN} = 10 MHz		73.1			73.5		dBFS
		f _{IN} = 20 MHz	70.9	72.9			73.4		
		f _{IN} = 70 MHz		72.5			73		
		f _{IN} = 100 MHz		72.4			72.7		
		f _{IN} = 170 MHz		71.4			71.7		
		f _{IN} = 230 MHz		70.3			70.5		
	Signal-to-noise ratio (full Nyquist band)	f _{IN} = 10 MHz		72.4			72.9		
		f _{IN} = 20 MHz		72.2			72.7		
		f _{IN} = 70 MHz		71.9			72.4		
		f _{IN} = 100 MHz		71.7			72.0		
		f _{IN} = 170 MHz		70.9			71.1		
		f _{IN} = 230 MHz		69.7			69.9		
NSD ⁽¹⁾	Noise spectral density (averaged across Nyquist zone)	f _{IN} = 10 MHz		–143.7			–144.1		dBFS/Hz
		f _{IN} = 20 MHz		–143.5	–141.5		–143.9		
		f _{IN} = 70 MHz		–143.1			–143.6		
		f _{IN} = 100 MHz		–143.0			–143.3		
		f _{IN} = 170 MHz		–142.0			–142.3		
		f _{IN} = 230 MHz		–140.9			–141.1		
SINAD ⁽¹⁾	Signal-to-noise and distortion ratio	f _{IN} = 10 MHz		73.1			73.4		dBFS
		f _{IN} = 20 MHz	69.9	72.9			73.2		
		f _{IN} = 70 MHz		71.7			71.9		
		f _{IN} = 100 MHz		72.6			72.8		
		f _{IN} = 170 MHz		71.2			71.4		
		f _{IN} = 230 MHz		69.9			70.1		
ENOB ⁽¹⁾	Effective number of bits	f _{IN} = 10 MHz		11.9			11.9		Bits
		f _{IN} = 20 MHz	11.3	11.8			11.8		
		f _{IN} = 70 MHz		11.7			11.8		
		f _{IN} = 100 MHz		11.8			11.8		
		f _{IN} = 170 MHz		11.5			11.6		
		f _{IN} = 230 MHz		11.3			11.4		
SFDR	Spurious-free dynamic range	f _{IN} = 10 MHz		91			89		dBc
		f _{IN} = 20 MHz	82	91			85		
		f _{IN} = 70 MHz		92			87		
		f _{IN} = 100 MHz		85			82		
		f _{IN} = 170 MHz		86			85		
		f _{IN} = 230 MHz		81			81		

(1) Reported from a 1-MHz offset.

AC Performance: ADC3441 (continued)

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS	ADC3441 (f _S = 25 MSPS)						UNIT
			DITHER ON			DITHER OFF			
			MIN	TYP	MAX	MIN	TYP	MAX	
HD2	Second-order harmonic distortion	f _{IN} = 10 MHz	92			93			dBc
		f _{IN} = 20 MHz	82	92	91				
		f _{IN} = 70 MHz	92			91			
		f _{IN} = 100 MHz	96			94			
		f _{IN} = 170 MHz	86			85			
		f _{IN} = 230 MHz	84			84			
HD3	Third-order harmonic distortion	f _{IN} = 10 MHz	96			90			dBc
		f _{IN} = 20 MHz	82	93	89				
		f _{IN} = 70 MHz	93			88			
		f _{IN} = 100 MHz	85			82			
		f _{IN} = 170 MHz	89			89			
		f _{IN} = 230 MHz	82			82			
Non HD2, HD3	Spurious-free dynamic range (excluding HD2, HD3)	f _{IN} = 10 MHz	100			93			dBc
		f _{IN} = 20 MHz	87	97	92				
		f _{IN} = 70 MHz	97			92			
		f _{IN} = 100 MHz	97			94			
		f _{IN} = 170 MHz	92			90			
		f _{IN} = 230 MHz	98			92			
THD	Total harmonic distortion	f _{IN} = 10 MHz	90			86			dBc
		f _{IN} = 20 MHz	79	90	85				
		f _{IN} = 70 MHz	90			85			
		f _{IN} = 100 MHz	84			80			
		f _{IN} = 170 MHz	84			83			
		f _{IN} = 230 MHz	80			80			
IMD3	Two-tone, third-order intermodulation distortion	f _{IN1} = 45 MHz, f _{IN2} = 50 MHz, each tone at –7 dBFS	–97			–97			dBFS
		f _{IN1} = 185 MHz, f _{IN2} = 190 MHz, each tone at –7 dBFS	–88			–88			
INL	Integral nonlinearity	f _{IN} = 20 MHz	±0.75		±3	±0.75		LSBs	
DNL	Differential nonlinearity	f _{IN} = 20 MHz	–0.95	±0.6		±0.6		LSBs	

7.9 AC Performance: ADC3442

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS	ADC3442 (f _S = 50 MSPS)						UNIT
			DITHER ON			DITHER OFF			
			MIN	TYP	MAX	MIN	TYP	MAX	
SNR	Signal-to-noise ratio (from 1-MHz offset)	f _{IN} = 10 MHz		73.1			73.5		dBFS
		f _{IN} = 20 MHz	70.7	72.9			73.3		
		f _{IN} = 70 MHz		72.7			73.1		
		f _{IN} = 100 MHz		71.9			72.6		
		f _{IN} = 170 MHz		71.5			71.8		
		f _{IN} = 230 MHz		70.4			70.8		
	Signal-to-noise ratio (full Nyquist band)	f _{IN} = 10 MHz		72.5			72.9		
		f _{IN} = 20 MHz		72.3			72.7		
		f _{IN} = 70 MHz		71.9			72.3		
		f _{IN} = 100 MHz		71.3			72.1		
		f _{IN} = 170 MHz		71.0			71.2		
		f _{IN} = 230 MHz		69.8			70.2		
NSD ⁽¹⁾	Noise spectral density (averaged across Nyquist zone)	f _{IN} = 10 MHz		–146.9			–147.3		dBFS/Hz
		f _{IN} = 20 MHz		–146.7	–144.5		–146.9		
		f _{IN} = 70 MHz		–146.5			–146.9		
		f _{IN} = 100 MHz		–145.7			–146.4		
		f _{IN} = 170 MHz		–145.3			–145.6		
		f _{IN} = 230 MHz		–144.2			–144.6		
SINAD ⁽¹⁾	Signal-to-noise and distortion ratio	f _{IN} = 10 MHz		73			73.4		dBFS
		f _{IN} = 20 MHz	69.7	72.2			72.7		
		f _{IN} = 70 MHz		72.2			72.7		
		f _{IN} = 100 MHz		72.1			73.2		
		f _{IN} = 170 MHz		71.4			71.8		
		f _{IN} = 230 MHz		69.8			70.1		
ENOB ⁽¹⁾	Effective number of bits	f _{IN} = 10 MHz		11.9			11.9		Bits
		f _{IN} = 20 MHz	11.3	11.8			11.8		
		f _{IN} = 70 MHz		11.8			11.8		
		f _{IN} = 100 MHz		11.7			11.9		
		f _{IN} = 170 MHz		11.6			11.6		
		f _{IN} = 230 MHz		11.4			11.4		
SFDR	Spurious-free dynamic range	f _{IN} = 10 MHz		90			90		dBc
		f _{IN} = 20 MHz	82	92			90		
		f _{IN} = 70 MHz		92			90		
		f _{IN} = 100 MHz		87			87		
		f _{IN} = 170 MHz		86			84		
		f _{IN} = 230 MHz		83			82		

(1) Reported from a 1-MHz offset.

AC Performance: ADC3442 (continued)

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS	ADC3442 (f _S = 50 MSPS)						UNIT
			DITHER ON			DITHER OFF			
			MIN	TYP	MAX	MIN	TYP	MAX	
HD2	Second-order harmonic distortion	f _{IN} = 10 MHz	95			92			dBc
		f _{IN} = 20 MHz	83	99	94				
		f _{IN} = 70 MHz	93			91			
		f _{IN} = 100 MHz	92			92			
		f _{IN} = 170 MHz	87			85			
		f _{IN} = 230 MHz	85			83			
HD3	Third-order harmonic distortion	f _{IN} = 10 MHz	90			92			dBc
		f _{IN} = 20 MHz	82	94	91				
		f _{IN} = 70 MHz	94			91			
		f _{IN} = 100 MHz	87			87			
		f _{IN} = 170 MHz	88			89			
		f _{IN} = 230 MHz	83			88			
Non HD2, HD3	Spurious-free dynamic range (excluding HD2, HD3)	f _{IN} = 10 MHz	99			95			dBc
		f _{IN} = 20 MHz	87	99	93				
		f _{IN} = 70 MHz	99			93			
		f _{IN} = 100 MHz	92			94			
		f _{IN} = 170 MHz	97			89			
		f _{IN} = 230 MHz	97			91			
THD	Total harmonic distortion	f _{IN} = 10 MHz	89			87			dBc
		f _{IN} = 20 MHz	79	90	87				
		f _{IN} = 70 MHz	90			87			
		f _{IN} = 100 MHz	86			85			
		f _{IN} = 170 MHz	85			83			
		f _{IN} = 230 MHz	81			81			
IMD3	Two-tone, third-order intermodulation distortion	f _{IN1} = 45 MHz, f _{IN2} = 50 MHz	–92			–92			dBFS
		f _{IN1} = 185 MHz, f _{IN2} = 190 MHz	–87			–87			
INL	Integral nonlinearity	f _{IN} = 20 MHz	±0.8		±3	±0.8		LSBs	
DNL	Differential nonlinearity	f _{IN} = 20 MHz	–0.95	±0.6			±0.6	LSBs	

7.10 AC Performance: ADC3443

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS	ADC3443 (f _S = 80 MSPS)						UNIT
			DITHER ON			DITHER OFF			
			MIN	TYP	MAX	MIN	TYP	MAX	
SNR	Signal-to-noise ratio (from 1-MHz offset)	f _{IN} = 10 MHz		72.9			73.2		dBFS
		f _{IN} = 70 MHz	70.7	72.8			73.1		
		f _{IN} = 100 MHz		72.5			72.9		
		f _{IN} = 170 MHz		72.1			72.4		
		f _{IN} = 230 MHz		71.4			71.7		
	Signal-to-noise ratio (full Nyquist band)	f _{IN} = 10 MHz		72.5			72.8		
		f _{IN} = 70 MHz		72.4			72.8		
		f _{IN} = 100 MHz		72.1			72.6		
		f _{IN} = 170 MHz		71.7			72.0		
		f _{IN} = 230 MHz		71.1			71.4		
NSD ⁽¹⁾	Noise spectral density (averaged across Nyquist zone)	f _{IN} = 10 MHz		−148.8			−149.1		dBFS/Hz
		f _{IN} = 70 MHz		−148.7	−146.6		−149.0		
		f _{IN} = 100 MHz		−148.4			−148.8		
		f _{IN} = 170 MHz		−148.0			−148.3		
		f _{IN} = 230 MHz		−147.3			−147.6		
SINAD ⁽¹⁾	Signal-to-noise and distortion ratio	f _{IN} = 10 MHz		72.8			73.2		dBFS
		f _{IN} = 70 MHz	69.7	72.2			72.4		
		f _{IN} = 100 MHz		72.7			73		
		f _{IN} = 170 MHz		71.9			72.2		
		f _{IN} = 230 MHz		71.2			71.4		
ENOB ⁽¹⁾	Effective number of bits	f _{IN} = 10 MHz		11.8			11.9		Bits
		f _{IN} = 70 MHz	11.3	11.8			11.8		
		f _{IN} = 100 MHz		11.8			11.8		
		f _{IN} = 170 MHz		11.7			11.7		
		f _{IN} = 230 MHz		11.5			11.6		
SFDR	Spurious-free dynamic range	f _{IN} = 10 MHz		89			89		dBc
		f _{IN} = 70 MHz	81	90			89		
		f _{IN} = 100 MHz		92			92		
		f _{IN} = 170 MHz		88			86		
		f _{IN} = 230 MHz		86			84		

(1) Reported from a 1-MHz offset.

AC Performance: ADC3443 (continued)

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS	ADC3443 (f _S = 80 MSPS)						UNIT
			DITHER ON			DITHER OFF			
			MIN	TYP	MAX	MIN	TYP	MAX	
HD2	Second-order harmonic distortion	f _{IN} = 10 MHz	94			91			dBc
		f _{IN} = 70 MHz	81	96	91				
		f _{IN} = 100 MHz	97			94			
		f _{IN} = 170 MHz	88			86			
		f _{IN} = 230 MHz	87			85			
HD3	Third-order harmonic distortion	f _{IN} = 10 MHz	89			90			dBc
		f _{IN} = 70 MHz	81	91	90				
		f _{IN} = 100 MHz	94			100			
		f _{IN} = 170 MHz	95			93			
		f _{IN} = 230 MHz	87			87			
Non HD2, HD3	Spurious-free dynamic range (excluding HD2, HD3)	f _{IN} = 10 MHz	100			95			dBc
		f _{IN} = 70 MHz	86	98	94				
		f _{IN} = 100 MHz	95			94			
		f _{IN} = 170 MHz	95			94			
		f _{IN} = 230 MHz	94			92			
THD	Total harmonic distortion	f _{IN} = 10 MHz	88			86			dBc
		f _{IN} = 70 MHz	78	89	87				
		f _{IN} = 100 MHz	91			90			
		f _{IN} = 170 MHz	87			84			
		f _{IN} = 230 MHz	84			82			
IMD3	Two-tone, third-order intermodulation distortion	f _{IN1} = 45 MHz, f _{IN2} = 50 MHz	–98			–98			dBFS
		f _{IN1} = 185 MHz, f _{IN2} = 190 MHz	–88			–88			
INL	Integral nonlinearity	f _{IN} = 70 MHz	±0.8		±3	±0.8		LSBs	
DNL	Differential nonlinearity	f _{IN} = 70 MHz	–0.95	±0.7		±0.7		LSBs	

7.11 AC Performance: ADC3444

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS	ADC3444 (f _S = 125 MSPS)						UNIT
			DITHER ON			DITHER OFF			
			MIN	TYP	MAX	MIN	TYP	MAX	
SNR	Signal-to-noise ratio (from 1-MHz offset)	f _{IN} = 10 MHz		72.6			73		dBFS
		f _{IN} = 70 MHz	70.2	72.5			72.9		
		f _{IN} = 100 MHz		72.2			72.7		
		f _{IN} = 170 MHz		71.7			72.3		
		f _{IN} = 230 MHz		70.8			71.7		
	Signal-to-noise ratio (full Nyquist band)	f _{IN} = 10 MHz		72.4			72.8		
		f _{IN} = 70 MHz		72.3			72.7		
		f _{IN} = 100 MHz		72.1			72.5		
		f _{IN} = 170 MHz		71.5			72.1		
		f _{IN} = 230 MHz		70.6			71.5		
NSD ⁽¹⁾	Noise spectral density (averaged across Nyquist zone)	f _{IN} = 10 MHz		–150.4			–150.9		dBFS/Hz
		f _{IN} = 70 MHz		–150.4	–148.1		–150.8		
		f _{IN} = 100 MHz		–150.1			–150.5		
		f _{IN} = 170 MHz		–149.5			–150.2		
		f _{IN} = 230 MHz		–148.7			–149.6		
SINAD ⁽¹⁾	Signal-to-noise and distortion ratio	f _{IN} = 10 MHz		72.6			72.9		dBFS
		f _{IN} = 70 MHz	69.3	72.3			72.7		
		f _{IN} = 100 MHz		72.3			72.7		
		f _{IN} = 170 MHz		71.5			72		
		f _{IN} = 230 MHz		69.9			70.6		
ENOB ⁽¹⁾	Effective number of bits	f _{IN} = 10 MHz		11.8			11.8		Bits
		f _{IN} = 70 MHz	11.2	11.8			11.8		
		f _{IN} = 100 MHz		11.7			11.8		
		f _{IN} = 170 MHz		11.6			11.7		
		f _{IN} = 230 MHz		11.4			11.6		
SFDR	Spurious-free dynamic range	f _{IN} = 10 MHz		92			87		dBc
		f _{IN} = 70 MHz	80	93			88		
		f _{IN} = 100 MHz		89			89		
		f _{IN} = 170 MHz		86			84		
		f _{IN} = 230 MHz		82			82		

(1) Reported from a 1-MHz offset.

AC Performance: ADC3444 (continued)

at maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); typical values are specified at an ambient temperature of 25°C; minimum and maximum values are specified over an ambient temperature range of –40°C to +85°C

PARAMETER		TEST CONDITIONS	ADC3444 (f _S = 125 MSPS)						UNIT
			DITHER ON			DITHER OFF			
			MIN	TYP	MAX	MIN	TYP	MAX	
HD2	Second-order harmonic distortion	f _{IN} = 10 MHz	93			93			dBc
		f _{IN} = 70 MHz	80	94	91				
		f _{IN} = 100 MHz	90			90			
		f _{IN} = 170 MHz	86			85			
		f _{IN} = 230 MHz	81			80			
HD3	Third-order harmonic distortion	f _{IN} = 10 MHz	96			88			dBc
		f _{IN} = 70 MHz	81	95	89				
		f _{IN} = 100 MHz	95			89			
		f _{IN} = 170 MHz	93			87			
		f _{IN} = 230 MHz	87			86			
Non HD2, HD3	Spurious-free dynamic range (excluding HD2, HD3)	f _{IN} = 10 MHz	100			93			dBc
		f _{IN} = 70 MHz	86	99	94				
		f _{IN} = 100 MHz	94			92			
		f _{IN} = 170 MHz	96			93			
		f _{IN} = 230 MHz	94			90			
THD	Total harmonic distortion	f _{IN} = 10 MHz	91			85			dBc
		f _{IN} = 70 MHz	77	91	85				
		f _{IN} = 100 MHz	88			86			
		f _{IN} = 170 MHz	85			82			
		f _{IN} = 230 MHz	80			78			
IMD3	Two-tone, third-order intermodulation distortion	f _{IN1} = 45 MHz, f _{IN2} = 50 MHz	–97			–97			dBFS
		f _{IN1} = 185 MHz, f _{IN2} = 190 MHz	–87			–87			
INL	Integral nonlinearity	f _{IN} = 70 MHz	±0.75		±3	±0.75			LSBs
DNL	Differential nonlinearity	f _{IN} = 70 MHz	–0.95	±0.7		±0.7			LSBs

7.12 Digital Characteristics

the dc specifications refer to the condition where the digital outputs are not switching, but are permanently at a valid logic level 0 or 1; AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted)

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
DIGITAL INPUTS (RESET, SCLK, SDATA, SEN, PDN)							
V _{IH}	High-level input voltage		All digital inputs support 1.8-V and 3.3-V CMOS logic levels	1.3			V
V _{IL}	Low-level input voltage					0.4	V
I _{IH}	High-level input current	RESET, SDATA, SCLK, PDN	V _{HIGH} = 1.8 V	10			μA
		SEN ⁽¹⁾	V _{HIGH} = 1.8 V	0			
I _{IL}	Low-level input current	RESET, SDATA, SCLK, PDN	V _{LOW} = 0 V	0			μA
		SEN	V _{LOW} = 0 V	10			
DIGITAL INPUTS (SYSREFP, SYSREFM)							
Differential swing				0.2	0.8	1.0	V
Common-mode voltage for SYSREF ⁽²⁾				0.9			V
DIGITAL OUTPUTS (CMOS Interface, SDOUT)							
V _{OH}	High-level output voltage			DVDD – 0.1	DVDD		V
V _{OL}	Low-level output voltage				0	0.1	V
DIGITAL OUTPUTS (LVDS Interface)							
V _{ODH}	High-level output differential voltage		With an external 100-Ω termination	280	350	–280	mV
V _{ODL}	Low-level output differential voltage		With an external 100-Ω termination	–460	–350	–460	mV
V _{OCM}	Output common-mode voltage			0.9	1.05	1.2	V

(1) SEN has an internal 150-kΩ pullup resistor to AVDD. SPI pins (SEN, SCLK, SDATA) may be driven by 1.8 V or 3.3 V CMOS buffers.

(2) SYSREF is internally biased to 0.9 V.

7.13 Timing Requirements: General

typical values are at T_A = 25°C, AVDD = DVDD = 1.8 V, and –1-dBFS differential input (unless otherwise noted); minimum and maximum values are across the full temperature range: T_{MIN} = –40°C to T_{MAX} = +85°C

			MIN	TYP	MAX	UNIT
t _A	Aperture delay		1.24	1.44	1.64	ns
	Aperture delay matching between two channels of the same device		±70			ps
	Variation of aperture delay between two devices at the same temperature and supply voltage		±150			ps
t _J	Aperture jitter		130			f _S rms
Wake-up time		Time to valid data after exiting standby power-down mode		35	200	μs
		Time to valid data after exiting global power-down mode (in this mode, both channels power down)		85	450	μs
ADC latency ⁽¹⁾		2-wire mode (default)	9			Clock cycles
		1-wire mode	8			Clock cycles
t _{SU_SYSREF}	SYSREF reference time	Setup time for SYSREF referenced to input clock falling edge	1000			ps
t _{H_SYSREF}		Hold time for SYSREF referenced to input clock falling edge	100			ps

(1) Overall latency = ADC latency + t_{PDI}; see [Figure 141](#).

7.14 Timing Requirements: LVDS Output

typical values are at 25°C, AVDD = DVDD = 1.8 V, –1-dBFS differential input, 7x serialization (2-wire mode), C_{LOAD} = 3.3 pF⁽¹⁾, and R_{LOAD} = 100 Ω⁽²⁾ (unless otherwise noted); minimum and maximum values are across the full temperature range: T_{MIN} = –40°C to T_{MAX} = +85°C⁽³⁾⁽⁴⁾

		MIN	TYP	MAX	UNIT
t _{SU}	Data setup time: data valid to zero-crossing of differential output clock (CLKOUTP – CLKOUTM) ⁽⁵⁾	0.36	0.42		ns
t _{HO}	Data hold time: zero-crossing of differential output clock (CLKOUTP – CLKOUTM) to data becoming invalid ⁽⁵⁾	0.36	0.47		ns
	LVDS bit clock duty cycle: duty cycle of differential clock (CLKOUTP – CLKOUTM)	49%			
t _{PDI}	Clock propagation delay: input clock falling edge cross-over to frame clock rising edge cross-over 15 MSPS < sampling frequency < 125 MSPS	1-wire mode			ns
		2-wire mode			ns
t _{DELAY}	Delay time	3	4.5	5.9	ns
t _{FALL} , t _{RISE}	Data fall time, data rise time: rise time measured from –100 mV to 100 mV, 15 MSPS ≤ Sampling frequency ≤ 125 MSPS	0.11			ns
t _{CLKRISE} , t _{CLKFALL}	Output clock rise time, output clock fall time: rise time measured from –100 mV to 100 mV, 15 MSPS ≤ Sampling frequency ≤ 125 MSPS	0.11			ns

- (1) C_{LOAD} is the effective external single-ended load capacitance between each output pin and ground
- (2) R_{LOAD} is the differential load resistance between the LVDS output pair.
- (3) Measurements are done with a transmission line of a 100-Ω characteristic impedance between the device and load. Setup and hold time specifications take into account the effect of jitter on the output data and clock.
- (4) Timing parameters are ensured by design and characterization and are not tested in production.
- (5) Data valid refers to a logic high of +100 mV and a logic low of –100 mV.

Table 1. LVDS Timings at Lower Sampling Frequencies: 7x Serialization (2-Wire Mode)

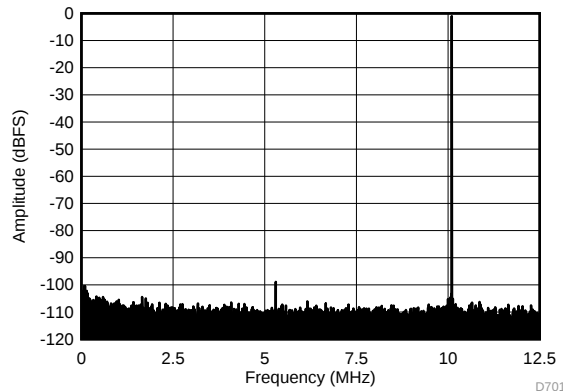
SAMPLING FREQUENCY (MSPS)	SETUP TIME (t _{SU} , ns)			HOLD TIME (t _{HO} , ns)		
	MIN	TYP	MAX	MIN	TYP	MAX
25	2.27	2.6		2.41	2.6	
40	1.44	1.6		1.51	1.7	
50	1.2	1.32		1.24	1.4	
60	0.95	1.04		0.97	1.09	
80	0.68	0.75		0.72	0.81	
100	0.5	0.57		0.53	0.62	

Table 2. LVDS Timings at Lower Sampling Frequencies: 14x Serialization (1-Wire Mode)

SAMPLING FREQUENCY (MSPS)	SETUP TIME (t _{SU} , ns)			HOLD TIME (t _{HO} , ns)		
	MIN	TYP	MAX	MIN	TYP	MAX
25	1.1	1.24		1.19	1.34	
40	0.66	0.72		0.74	0.82	
50	0.48	0.55		0.54	0.64	
60	0.35	0.41		0.42	0.51	
80	0.17	0.24		0.3	0.38	

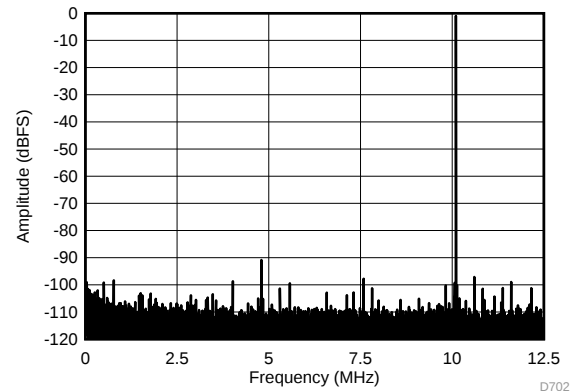
7.15 Typical Characteristics: ADC3441

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 25 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2-V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



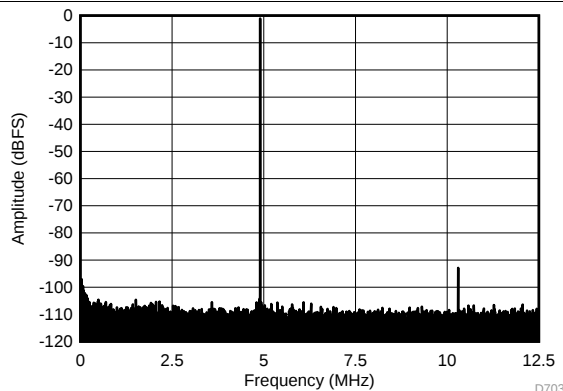
SFDR = 98 dBc, SNR = 73.1 dBFS, SINAD = 73 dBFS,
THD = 97 dBc, HD2 = 110.0 dBc,
HD3 = 98 dBc, SFDR = 100 dBc (excluding HD2, HD3)

Figure 1. FFT for 10-MHz Input Signal (Dither On)



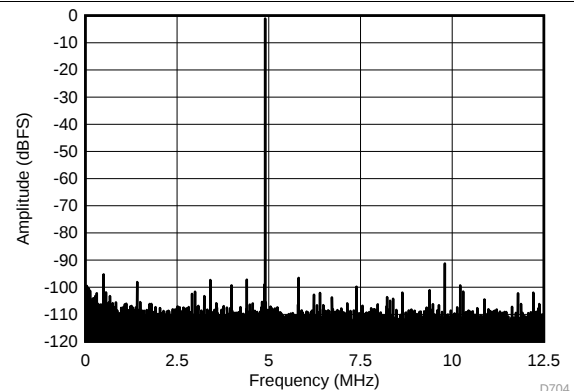
SFDR = 90 dBc, SNR = 73.5 dBFS, SINAD = 73.2 dBFS,
THD = 88 dBc, HD2 = 90 dBc,
HD3 = 100 dBc, SFDR = 92 dBc (excluding HD2, HD3)

Figure 2. FFT for 10-MHz Input Signal (Dither Off)



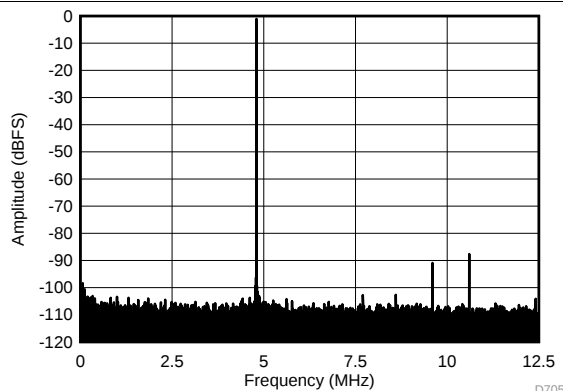
SFDR = 92 dBc, SNR = 72.5 dBFS, SINAD = 72.3 dBFS,
THD = 91 dBc, HD2 = 108 dBc,
HD3 = 92 dBc, SFDR = 101 dBc (excluding HD2, HD3)

Figure 3. FFT for 70-MHz Input Signal (Dither On)



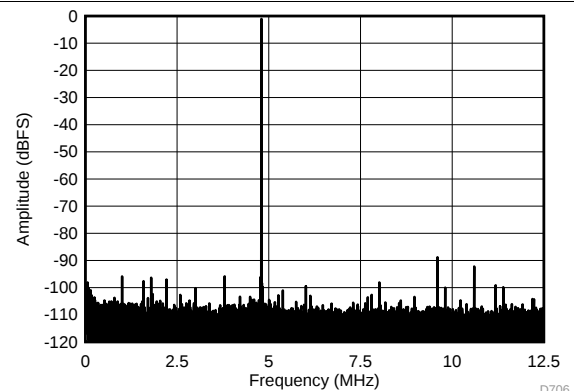
SFDR = 90 dBc, SNR = 72.9 dBFS, SINAD = 72.7 dBFS,
THD = 89 dBc, HD2 = 90 dBc,
HD3 = 101 dBc, SFDR = 93 dBc (excluding HD2, HD3)

Figure 4. FFT for 70-MHz Input Signal (Dither Off)



SFDR = 87 dBc, SNR = 71.5 dBFS, SINAD = 71.1 dBFS,
THD = 85 dBc, HD2 = 90 dBc,
HD3 = 87 dBc, SFDR = 100 dBc (excluding HD2, HD3)

Figure 5. FFT for 170-MHz Input Signal (Dither On)



SFDR = 88 dBc, SNR = 71.7 dBFS, SINAD = 71.4 dBFS,
THD = 85 dBc, HD2 = 88 dBc,
HD3 = 91 dBc, SFDR = 93 dBc (excluding HD2, HD3)

Figure 6. FFT for 170-MHz Input Signal (Dither Off)

Typical Characteristics: ADC3441 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 25 MSPS, 50% clock duty cycle, $AV_{DD} = 1.8\text{ V}$, $DV_{DD} = 1.8\text{ V}$, -1 dBFS differential input, $2 \cdot V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

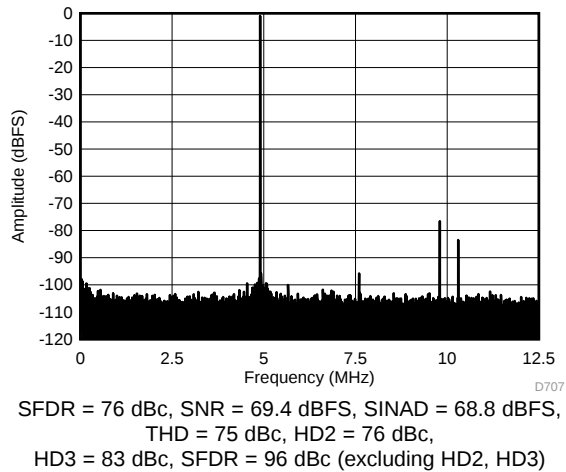


Figure 7. FFT for 270-MHz Input Signal (Dither On)

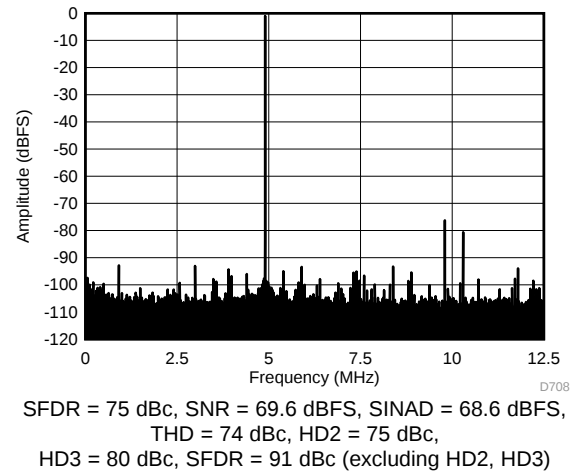


Figure 8. FFT for 270-MHz Input Signal (Dither Off)

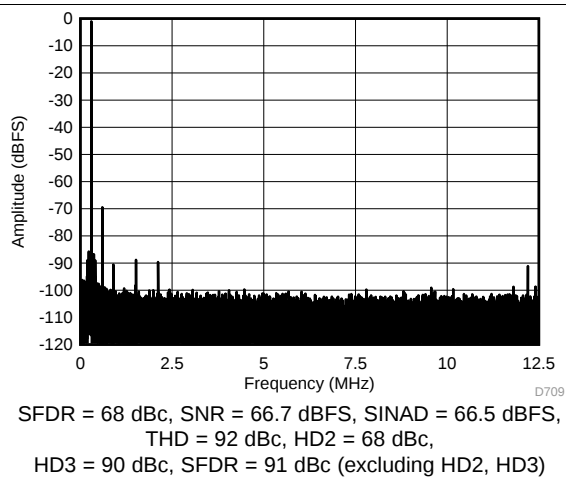


Figure 9. FFT for 450-MHz Input Signal (Dither On)

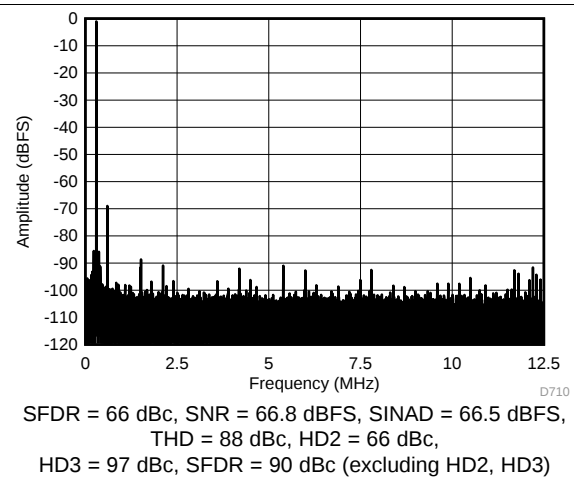
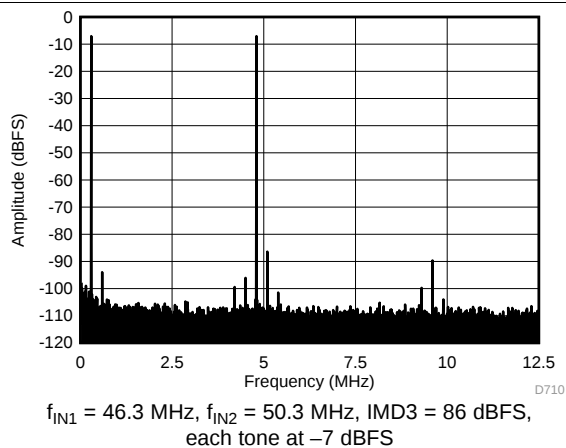
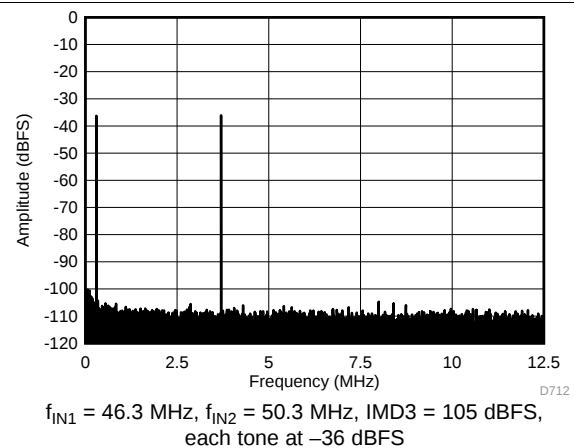


Figure 10. FFT for 450-MHz Input Signal (Dither Off)



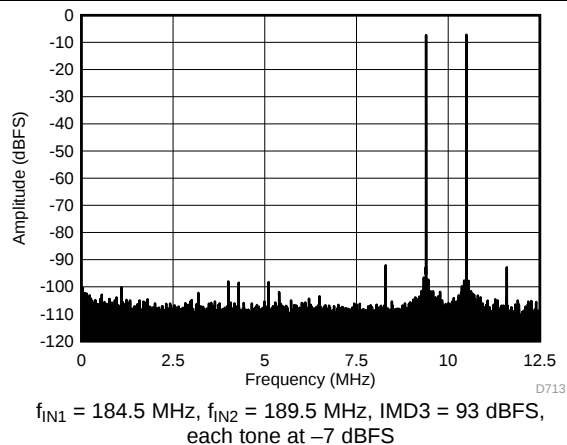
**Figure 11. FFT for Two-Tone Input Signal
(-7 dBFS at 46 MHz and 50 MHz)**



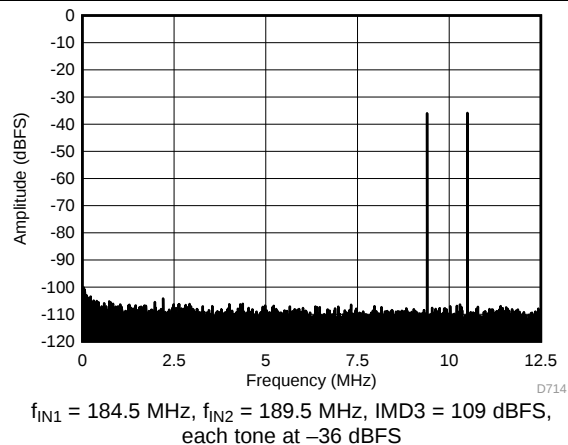
**Figure 12. FFT for Two-Tone Input Signal
(-36 dBFS at 46 MHz and 50 MHz)**

Typical Characteristics: ADC3441 (continued)

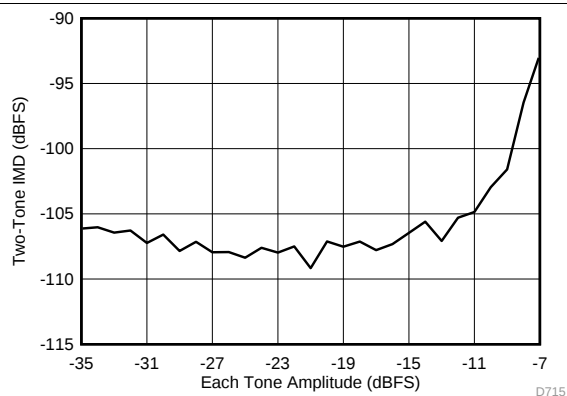
typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 25 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



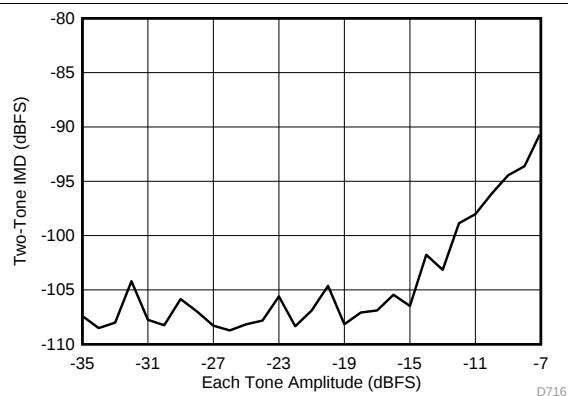
**Figure 13. FFT for Two-Tone Input Signal
(-7 dBFS at 185 MHz and 190 MHz)**



**Figure 14. FFT for Two-Tone Input Signal
(-36 dBFS at 185 MHz and 190 MHz)**



**Figure 15. Intermodulation Distortion vs Input Amplitude
(46 MHz and 50 MHz)**



**Figure 16. Intermodulation Distortion vs Input Amplitude
(185 MHz and 190 MHz)**

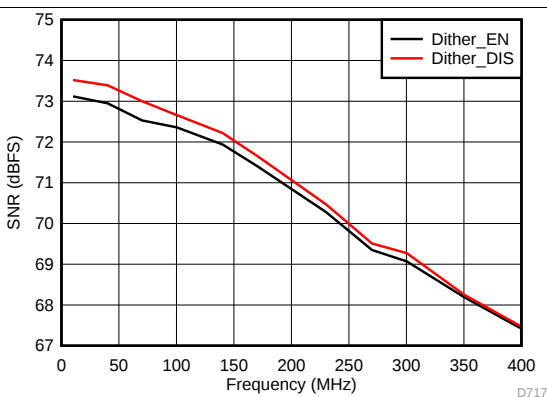
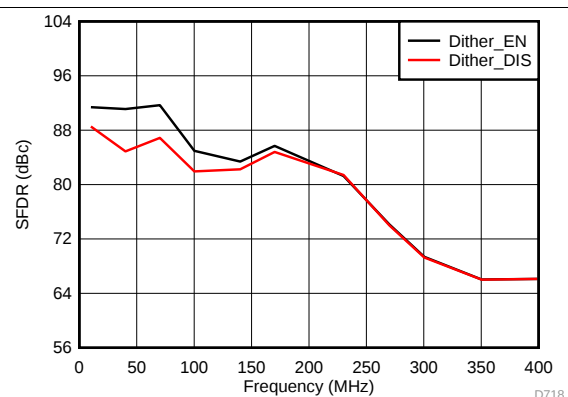


Figure 17. Signal-to-Noise Ratio vs Input Frequency



**Figure 18. Spurious-Free Dynamic Range vs
Input Frequency**

Typical Characteristics: ADC3441 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 25 MSPS, 50% clock duty cycle, AVDD = 1.8 V, DVDD = 1.8 V, –1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

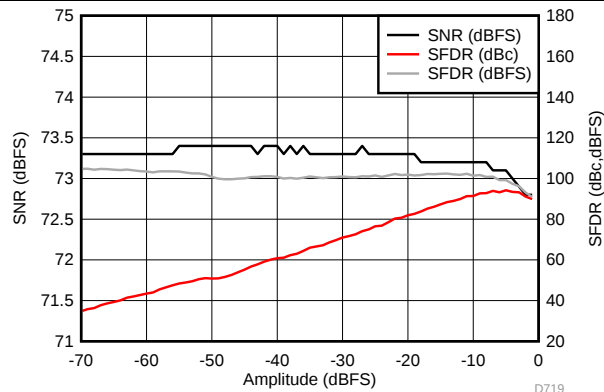


Figure 19. Performance vs Input Amplitude (30 MHz)

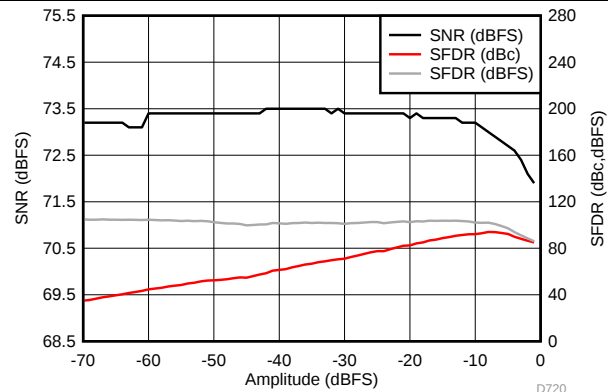


Figure 20. Performance vs Input Amplitude (170 MHz)

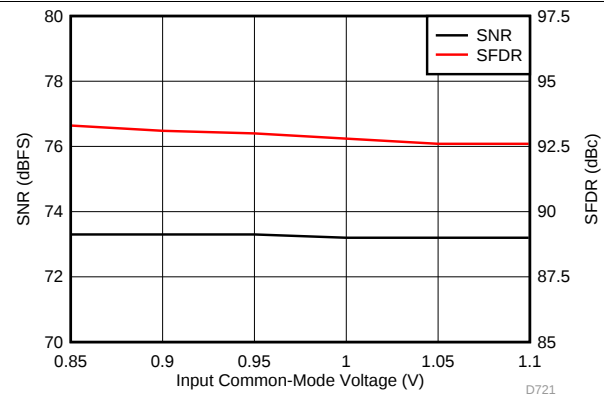


Figure 21. Performance vs Input Common-Mode Voltage (30 MHz)

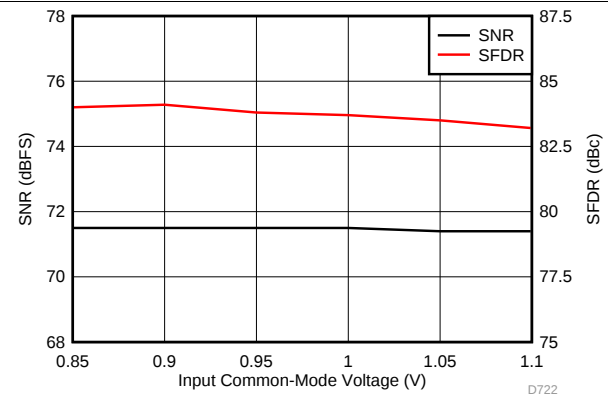


Figure 22. Performance vs Input Common-Mode Voltage (170 MHz)

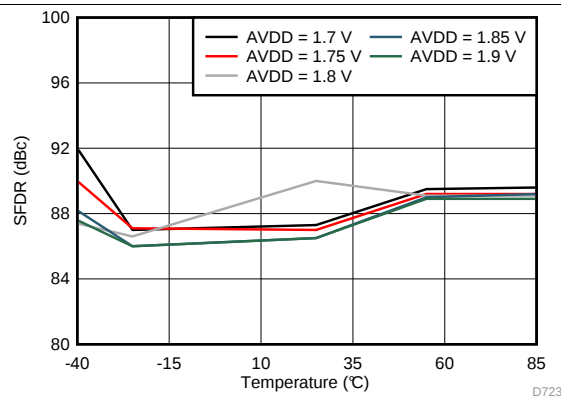


Figure 23. Spurious-Free Dynamic Range vs AVDD Supply and Temperature (30 MHz)

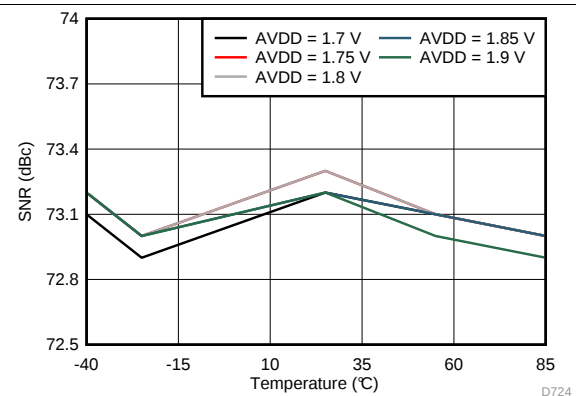


Figure 24. Signal-to-Noise Ratio vs AVDD Supply and Temperature (30 MHz)

Typical Characteristics: ADC3441 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 25 MSPS, 50% clock duty cycle, AVDD = 1.8 V, DVDD = 1.8 V, –1-dBFS differential input, 2- V_{PP} full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

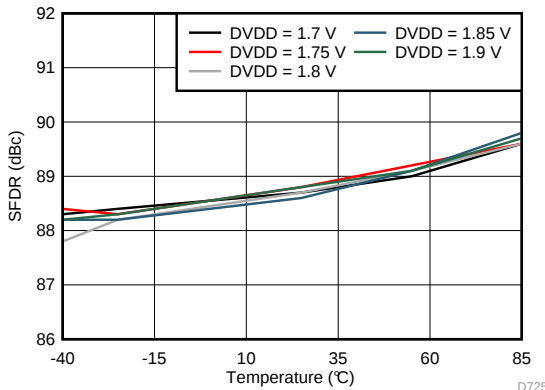


Figure 25. Spurious-Free Dynamic Range vs DVDD Supply and Temperature (30 MHz)

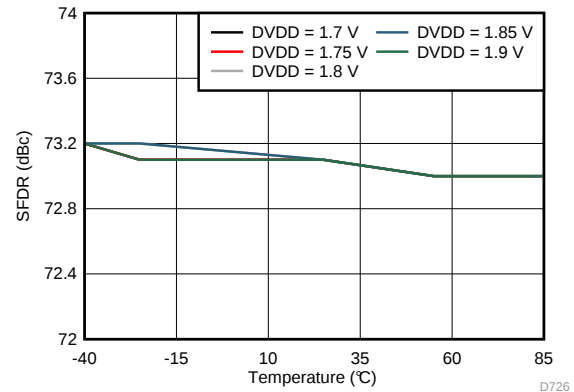


Figure 26. Signal-to-Noise Ratio vs DVDD Supply and Temperature (30 MHz)

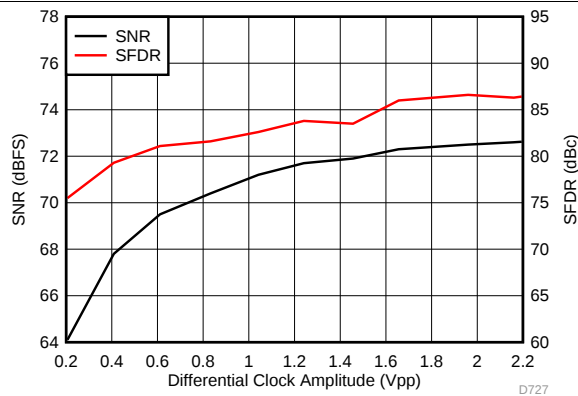


Figure 27. Performance vs Clock Amplitude (40 MHz)

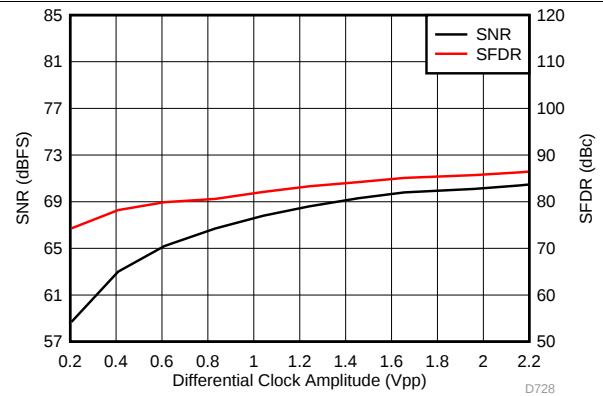


Figure 28. Performance vs Clock Amplitude (150 MHz)

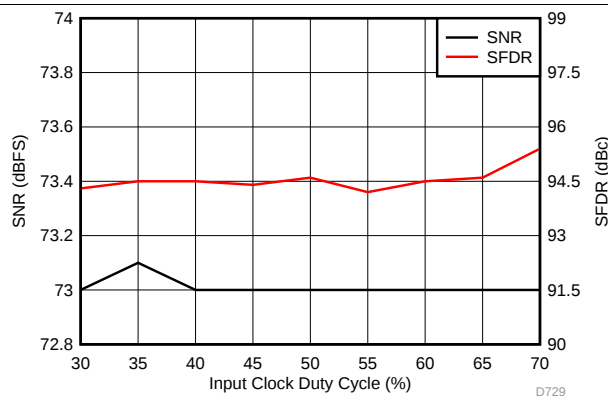


Figure 29. Performance vs Clock Duty Cycle (30 MHz)

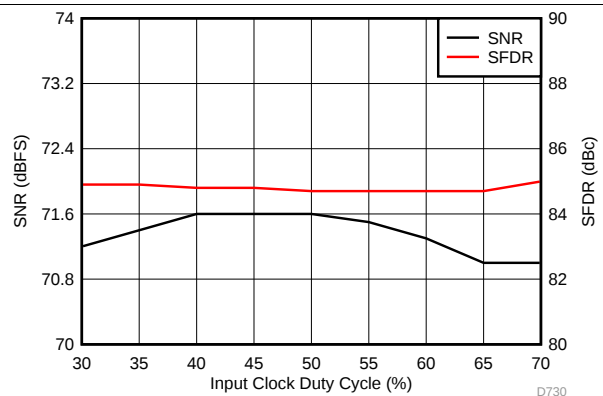


Figure 30. Performance vs Clock Duty Cycle (150 MHz)

Typical Characteristics: ADC3441 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 25 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

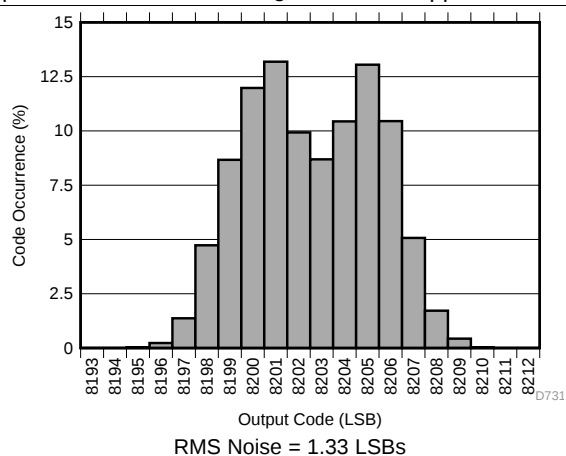


Figure 31. Idle Channel Histogram

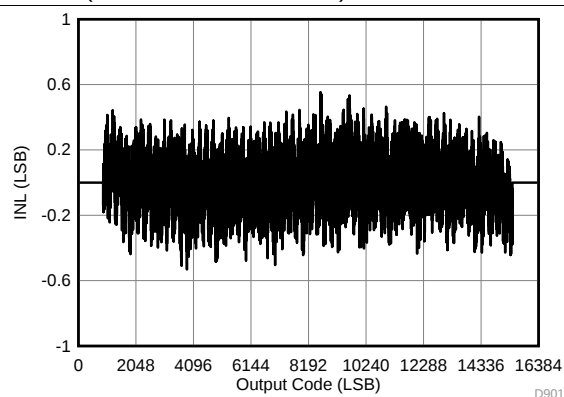


Figure 32. Integral Nonlinearity for 20-MHz Input

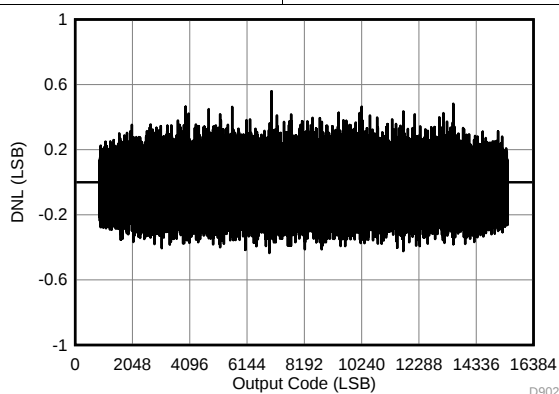
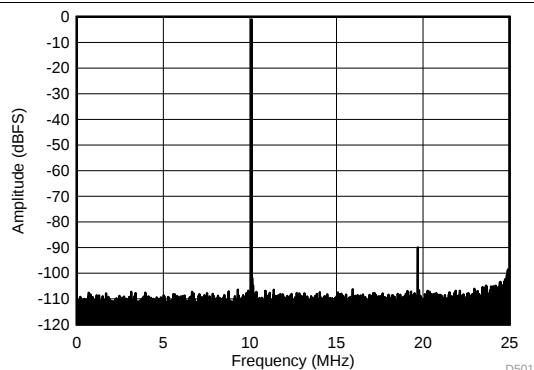


Figure 33. Differential Nonlinearity for 20-MHz Input

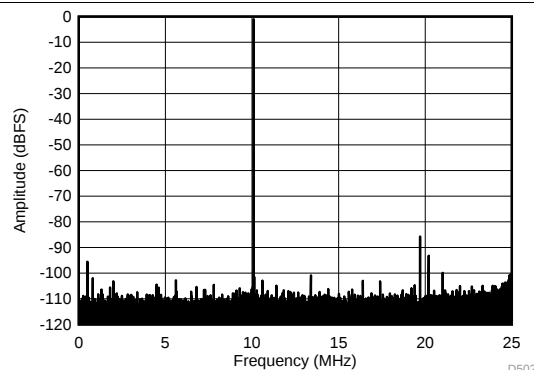
7.16 Typical Characteristics: ADC3442

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2-V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



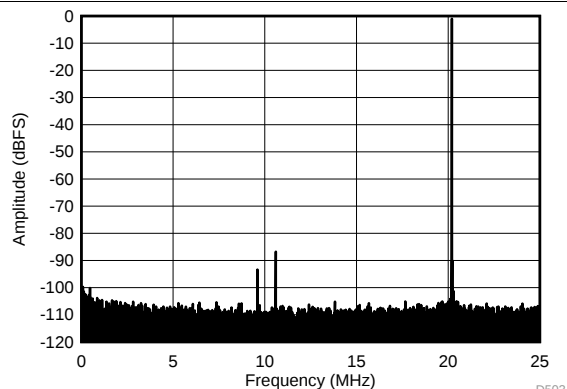
SFDR = 89 dBc, SNR = 73.1 dBFS, SINAD = 73 dBFS,
THD = 89 dBc, HD2 = 111 dBc,
HD3 = 89 dBc, SFDR = 100 dBc (excluding HD2, HD3)

**Figure 34. FFT for 10-MHz Input Signal
(Chopper On, Dither On)**



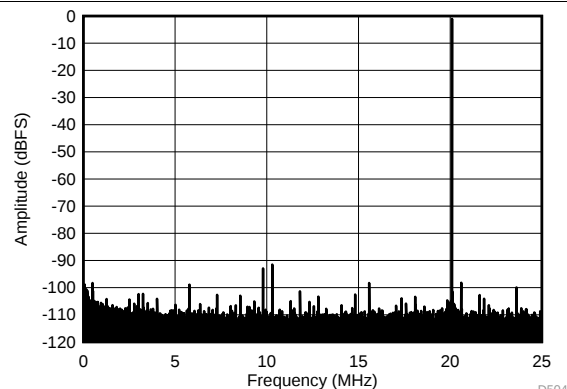
SFDR = 85 dBc, SNR = 73.5 dBFS, SINAD = 73.3 dBFS,
THD = 84 dBc, HD2 = 92 dBc,
HD3 = 85 dBc, SFDR = 96 dBc (excluding HD2, HD3)

**Figure 35. FFT for 10-MHz Input Signal
(Chopper On, Dither Off)**



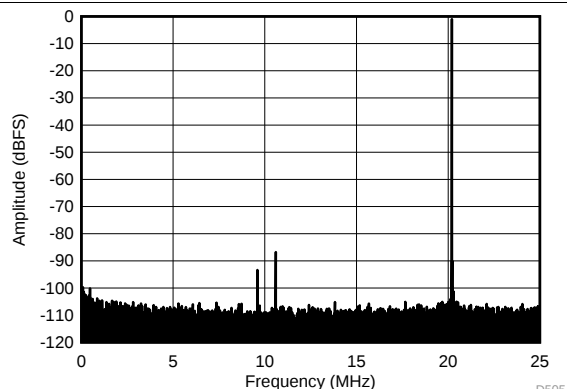
SFDR = 86 dBc, SNR = 72.7 dBFS, SINAD = 72.5 dBFS,
THD = 85 dBc, HD2 = 92 dBc,
HD3 = 86 dBc, SFDR = 100 dBc (excluding HD2, HD3)

Figure 36. FFT for 70-MHz Input Signal (Dither On)



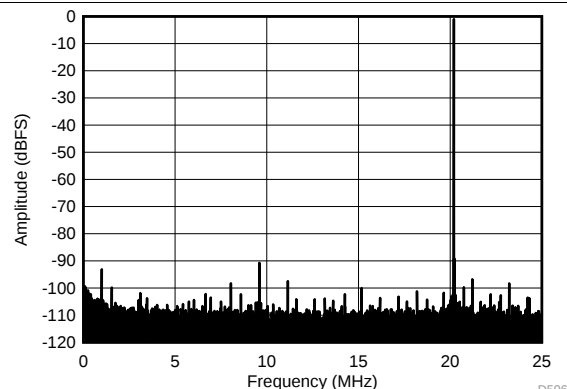
SFDR = 90 dBc, SNR = 73.1 dBFS, SINAD = 73 dBFS,
THD = 88 dBc, HD2 = 92 dBc,
HD3 = 90 dBc, SFDR = 95 dBc (excluding HD2, HD3)

Figure 37. FFT for 70-MHz Input Signal (Dither Off)



SFDR = 86 dBc, SNR = 71.6 dBFS, SINAD = 71.4 dBFS,
THD = 85 dBc, HD2 = 92 dBc,
HD3 = 86 dBc, SFDR = 99 dBc (excluding HD2, HD3)

Figure 38. FFT for 170-MHz Input Signal (Dither On)

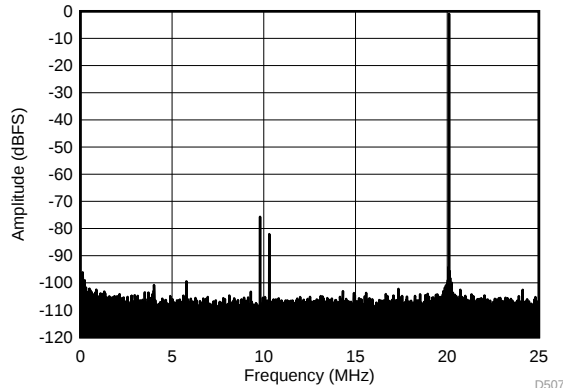


SFDR = 90 dBc, SNR = 71.8 dBFS, SINAD = 71.6 dBFS,
THD = 87 dBc, HD2 = 90 dBc,
HD3 = 108 dBc, SFDR = 93 dBc (excluding HD2, HD3)

Figure 39. FFT for 170-MHz Input Signal (Dither Off)

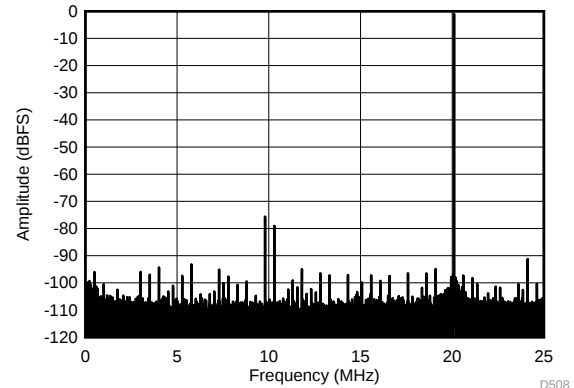
Typical Characteristics: ADC3442 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



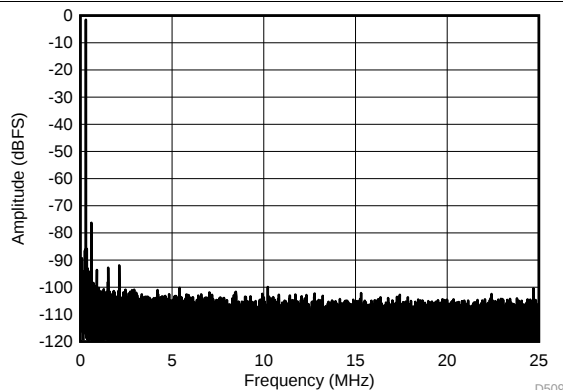
SFDR = 75 dBc, SNR = 70.3 dBFS, SINAD = 69.1 dBFS,
THD = 74 dBc, HD2 = -75 dBc,
HD3 = 81 dBc, SFDR = 95 dBc (excluding HD2, HD3)

Figure 40. FFT for 270-MHz Input Signal (Dither On)



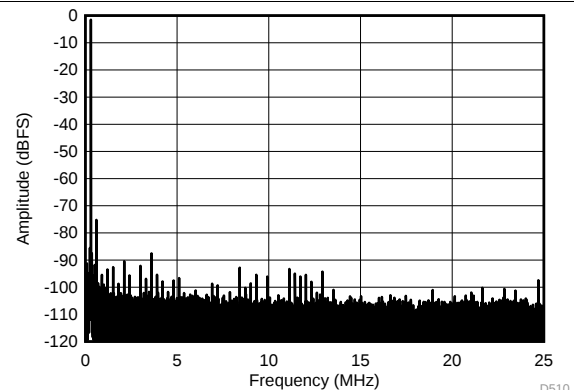
SFDR = 75 dBc, SNR = 70.6 dBFS, SINAD = 69.6 dBFS,
THD = 73 dBc, HD2 = 75 dBc,
HD3 = 78 dBc, SFDR = 91 dBc (excluding HD2, HD3)

Figure 41. FFT for 270-MHz Input Signal (Dither Off)



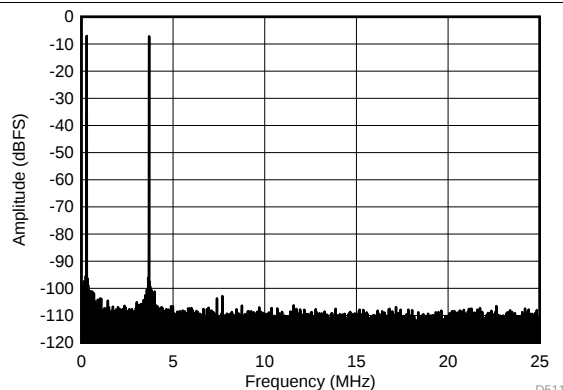
SFDR = 68 dBc, SNR = 68.2 dBFS, SINAD = 68 dBFS,
THD = 86 dBc, HD2 = 68 dBc, HD3 = 87 dBc

Figure 42. FFT for 450-MHz Input Signal (Dither On)



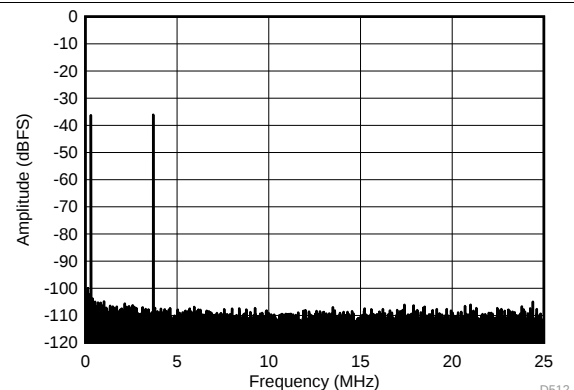
SFDR = 68 dBc, SNR = 68.5 dBFS, SINAD = 68.3 dBFS,
THD = 86 dBc, HD2 = 68 dBc, HD3 = 90 dBc

Figure 43. FFT for 450-MHz Input Signal (Dither Off)



$f_{IN1} = 46.3\text{ MHz}$, $f_{IN2} = 50.3\text{ MHz}$, IMD3 = 102 dBFS,
each tone at -7 dBFS

**Figure 44. FFT for Two-Tone Input Signal
(-7 dBFS at 46 MHz and 50 MHz)**

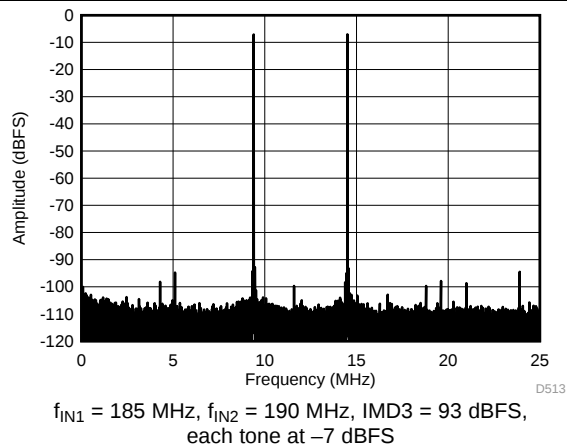


$f_{IN1} = 46.3\text{ MHz}$, $f_{IN2} = 50.3\text{ MHz}$, IMD3 = 110 dBFS,
each tone at -36 dBFS

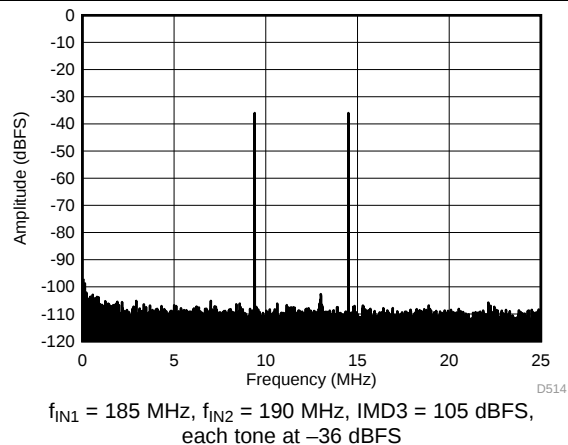
**Figure 45. FFT for Two-Tone Input Signal
(-36 dBFS at 46 MHz and 50 MHz)**

Typical Characteristics: ADC3442 (continued)

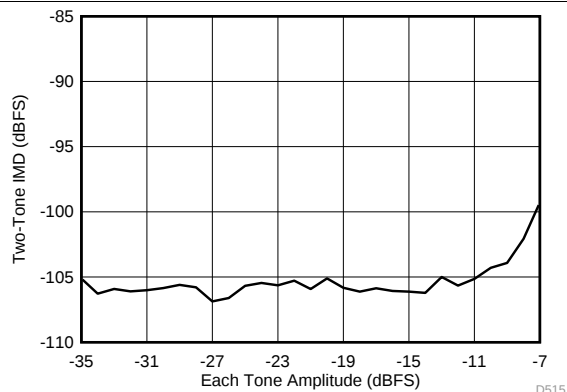
typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



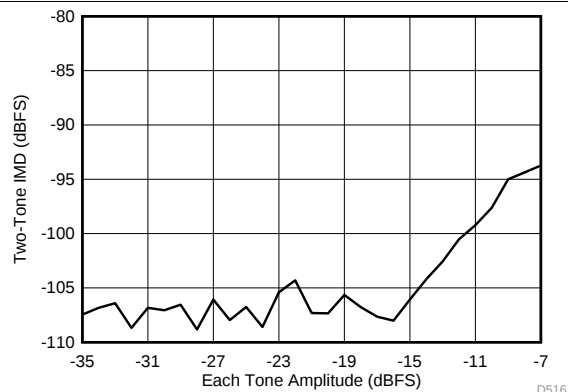
**Figure 46. FFT for Two-Tone Input Signal
(-7 dBFS at 185 MHz and 190 MHz)**



**Figure 47. FFT for Two-Tone Input Signal
(-36 dBFS at 185 MHz and 190 MHz)**



**Figure 48. Intermodulation Distortion vs Input Amplitude
(46 MHz and 50 MHz)**



**Figure 49. Intermodulation Distortion vs Input Amplitude
(185 MHz and 190 MHz)**

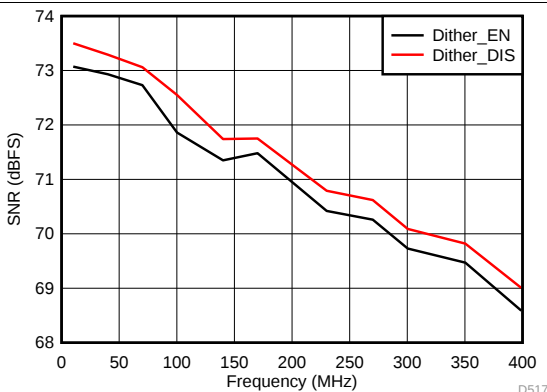
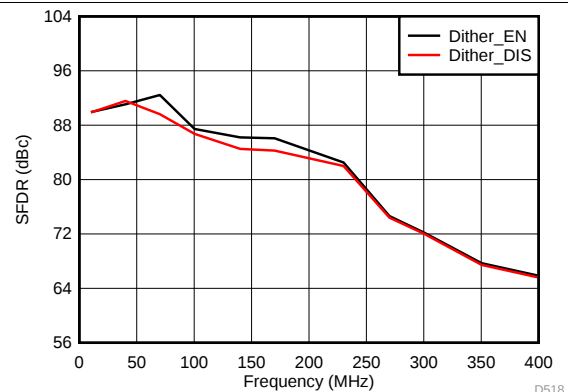


Figure 50. Signal-to-Noise Ratio vs Input Frequency



**Figure 51. Spurious-Free Dynamic Range vs
Input Frequency**

Typical Characteristics: ADC3442 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, AVDD = 1.8 V, DVDD = 1.8 V, –1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

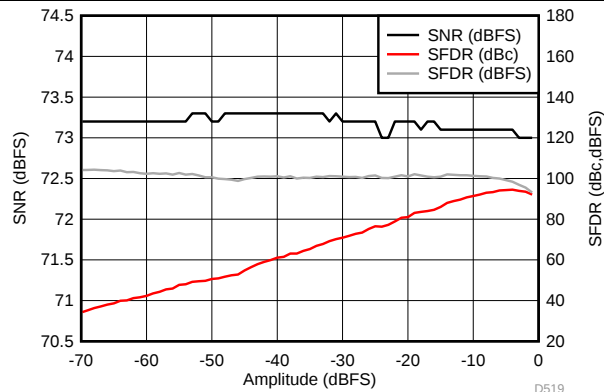


Figure 52. Performance vs Input Amplitude (30 MHz)

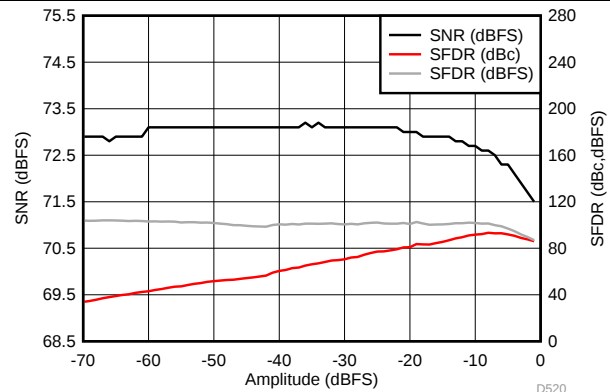


Figure 53. Performance vs Input Amplitude (170 MHz)

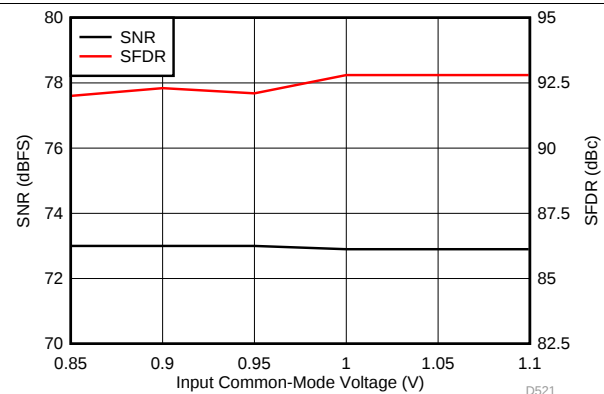


Figure 54. Performance vs Input Common-Mode Voltage (30 MHz)

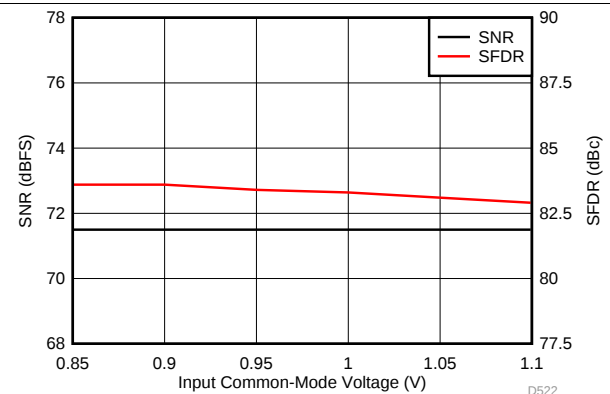


Figure 55. Performance vs Input Common-Mode Voltage (170 MHz)

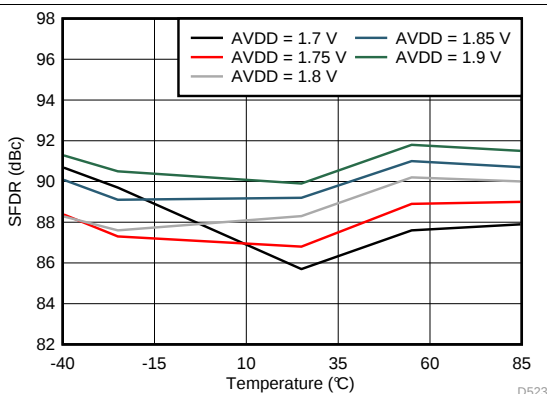


Figure 56. Spurious-Free Dynamic Range vs AVDD Supply and Temperature (30 MHz)

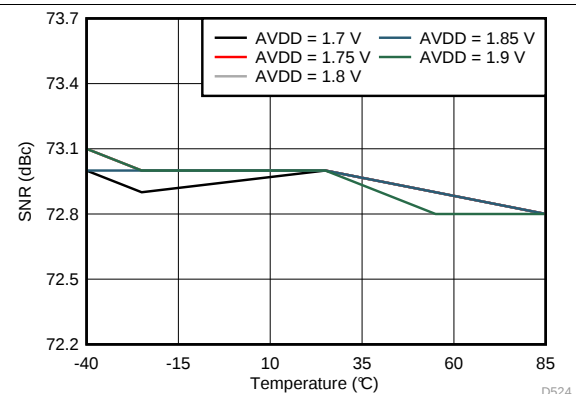


Figure 57. Signal-to-Noise Ratio vs AVDD Supply and Temperature (30 MHz)

Typical Characteristics: ADC3442 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, AVDD = 1.8 V, DVDD = 1.8 V, –1-dBFS differential input, 2- V_{PP} full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

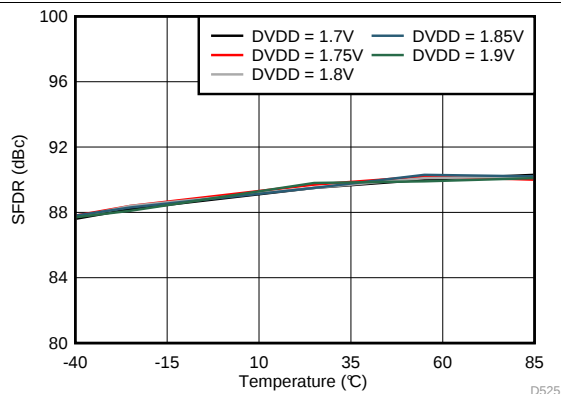


Figure 58. Spurious-Free Dynamic Range vs DVDD Supply and Temperature (30 MHz)

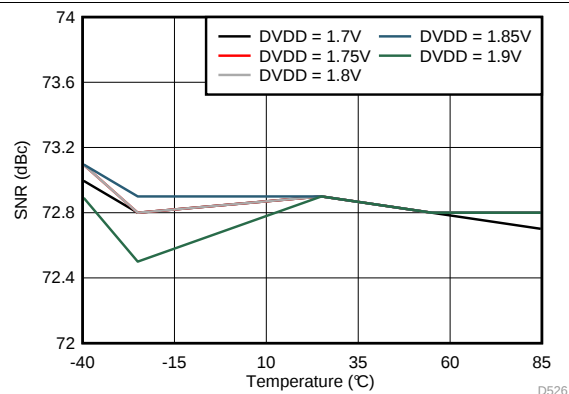


Figure 59. Signal-to-Noise Ratio vs DVDD Supply and Temperature (30 MHz)

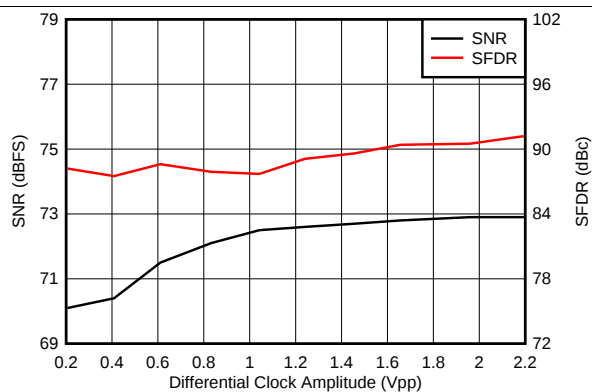


Figure 60. Performance vs Clock Amplitude (40 MHz)

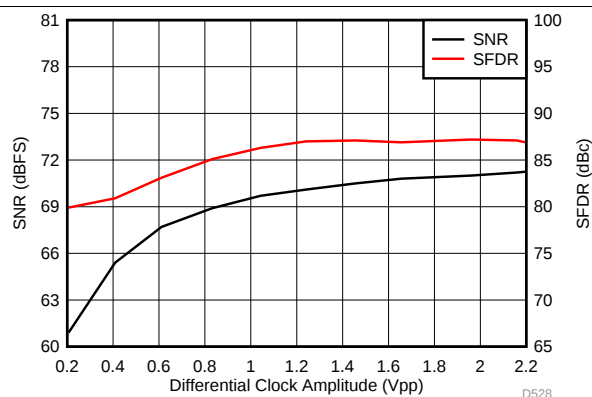


Figure 61. Performance vs Clock Amplitude (150 MHz)

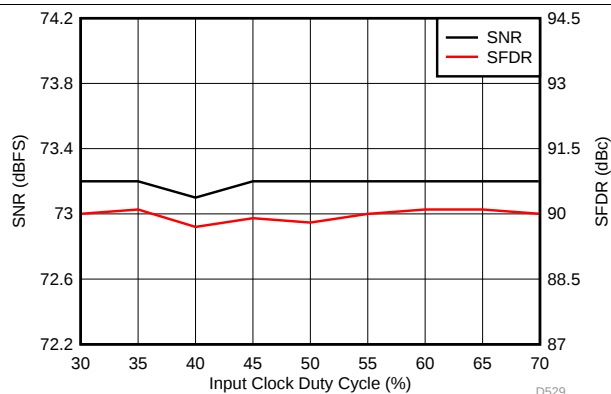


Figure 62. Performance vs Clock Duty Cycle (30 MHz)

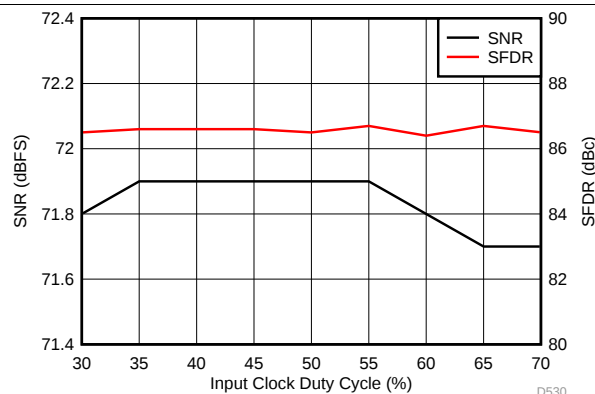


Figure 63. Performance vs Clock Duty Cycle (150 MHz)

Typical Characteristics: ADC3442 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

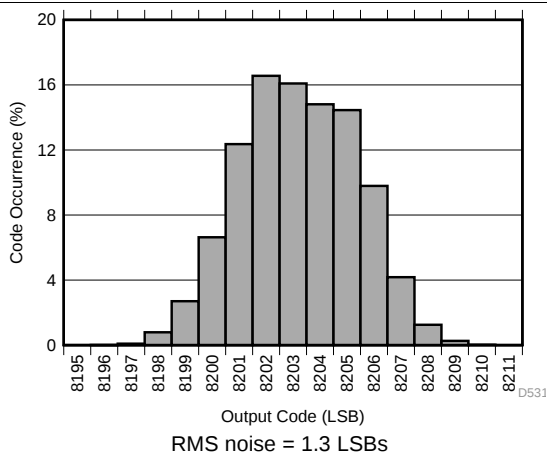


Figure 64. Idle Channel Histogram

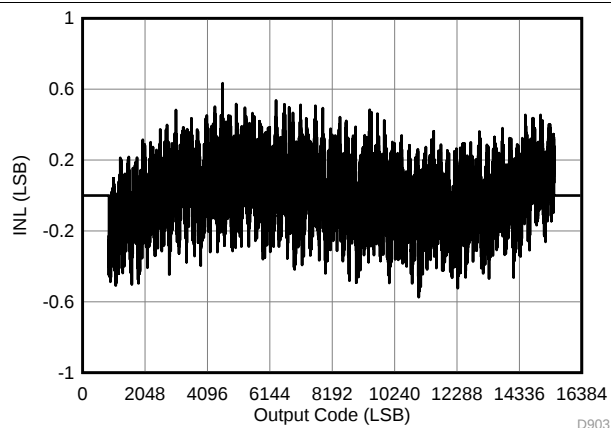


Figure 65. Integral Nonlinearity for 20-MHz Input

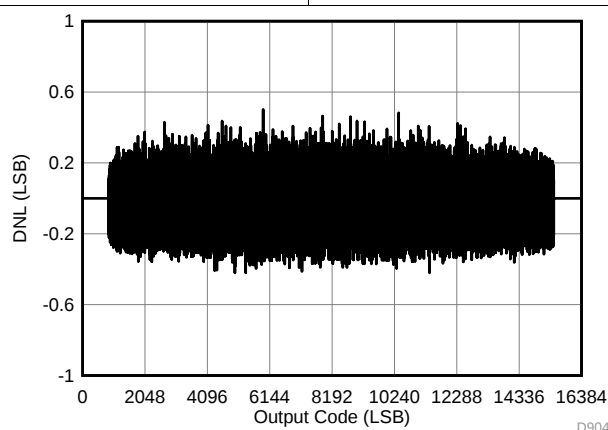
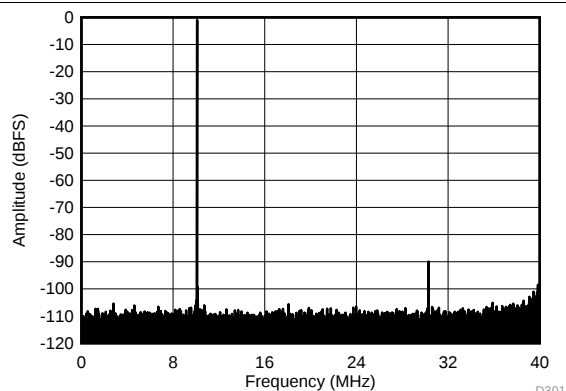


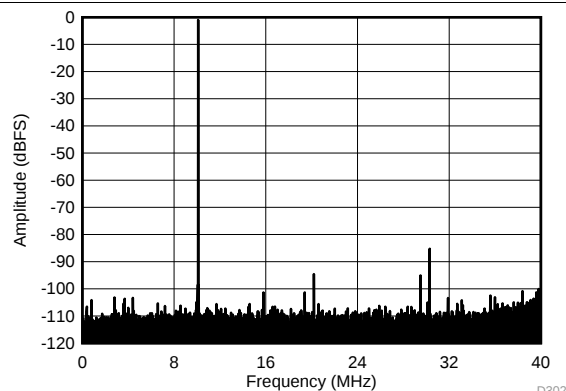
Figure 66. Differential Nonlinearity for 20-MHz Input

7.17 Typical Characteristics: ADC3443

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2-V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



**Figure 67. FFT for 10-MHz Input Signal
(Chopper On, Dither On)**



**Figure 68. FFT for 10-MHz Input Signal
(Chopper On, Dither Off)**

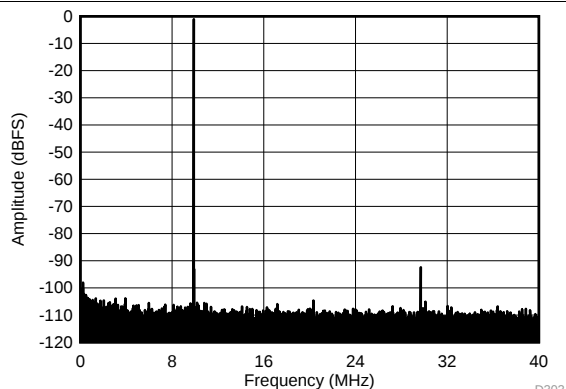


Figure 69. FFT for 70-MHz Input Signal (Dither On)

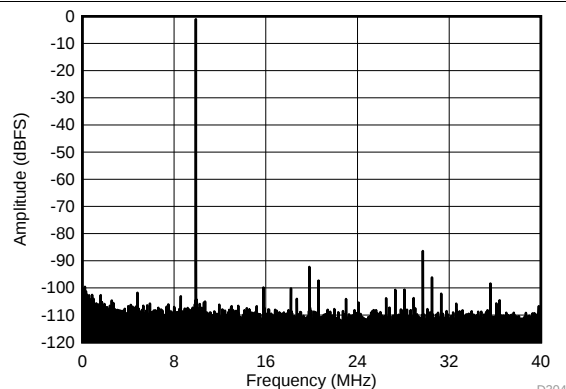


Figure 70. FFT for 70-MHz Input Signal (Dither Off)

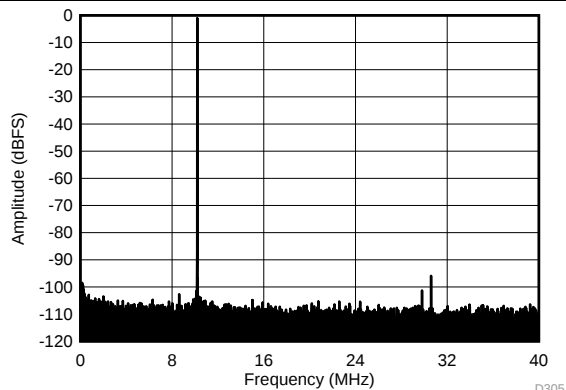


Figure 71. FFT for 170-MHz Input Signal (Dither On)

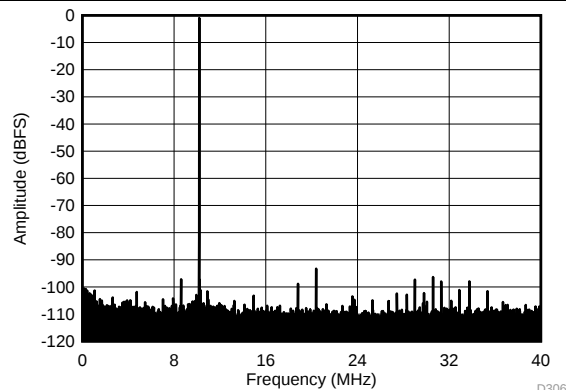


Figure 72. FFT for 170-MHz Input Signal (Dither Off)

Typical Characteristics: ADC3443 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AV_{DD} = 1.8\text{ V}$, $DV_{DD} = 1.8\text{ V}$, -1 dBFS differential input, $2 \cdot V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

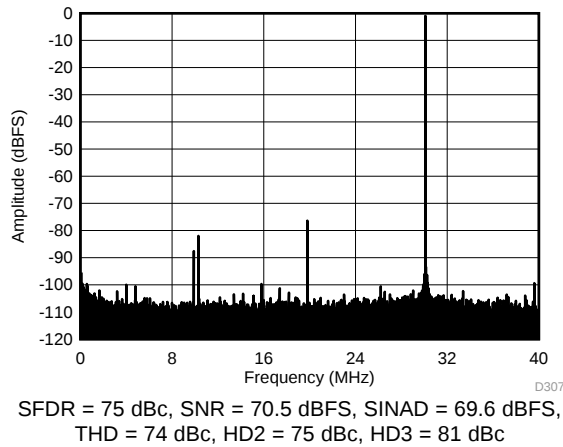


Figure 73. FFT for 270-MHz Input Signal (Dither On)

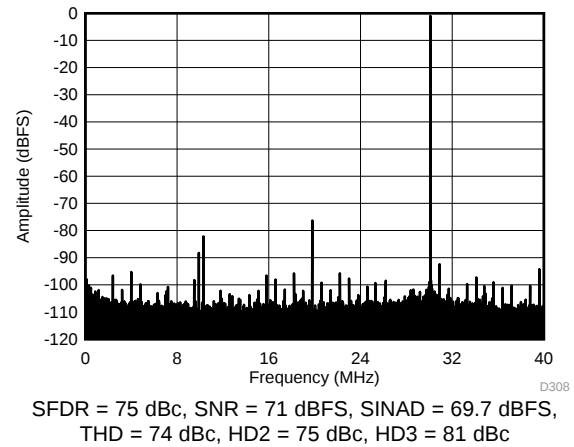


Figure 74. FFT for 270-MHz Input Signal (Dither Off)

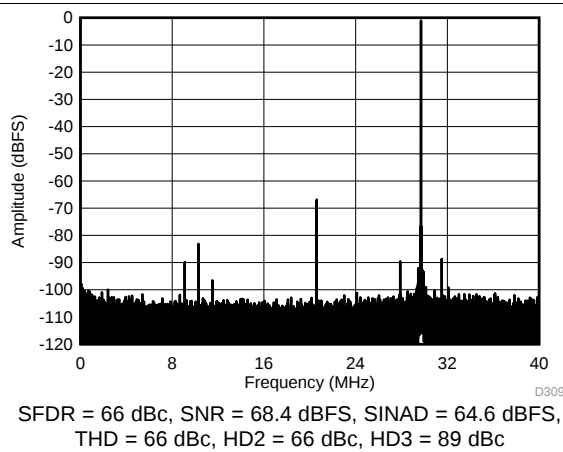


Figure 75. FFT for 450-MHz Input Signal (Dither On)

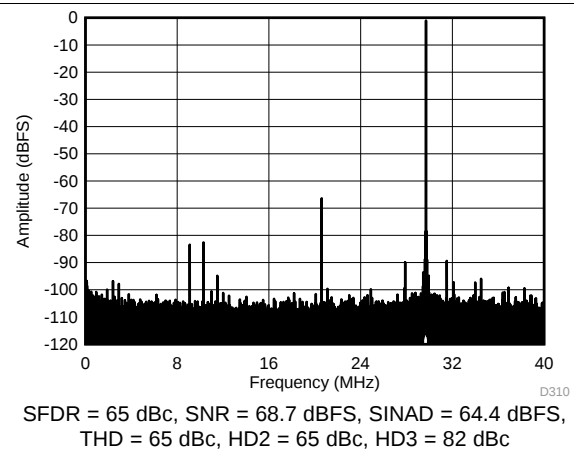
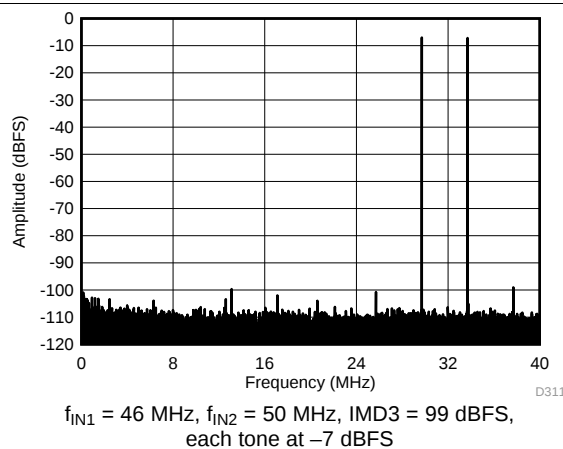
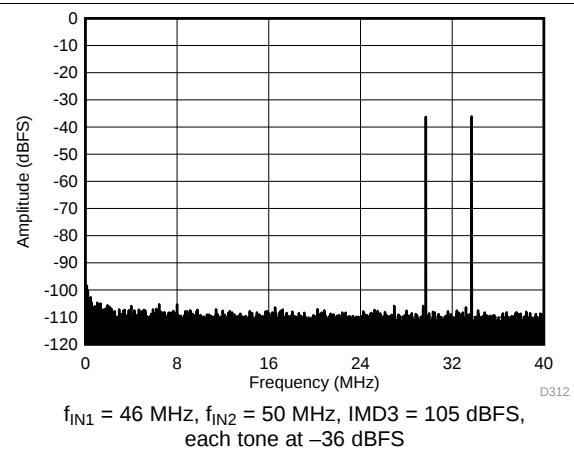


Figure 76. FFT for 450-MHz Input Signal (Dither Off)



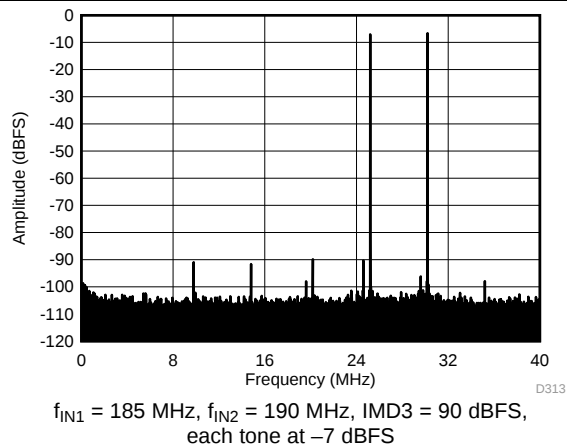
**Figure 77. FFT for Two-Tone Input Signal
(-7 dBFS at 46 MHz and 50 MHz)**



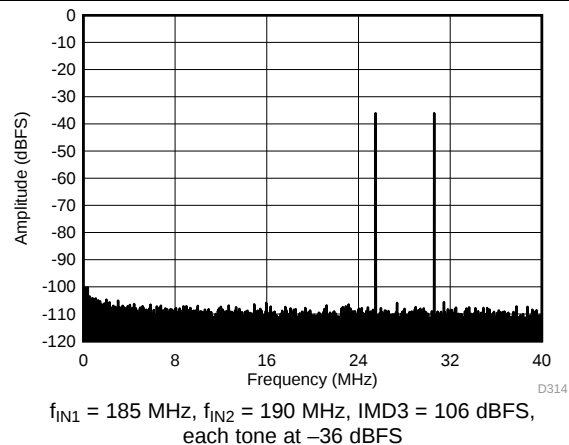
**Figure 78. FFT for Two-Tone Input Signal
(-36 dBFS at 46 MHz and 50 MHz)**

Typical Characteristics: ADC3443 (continued)

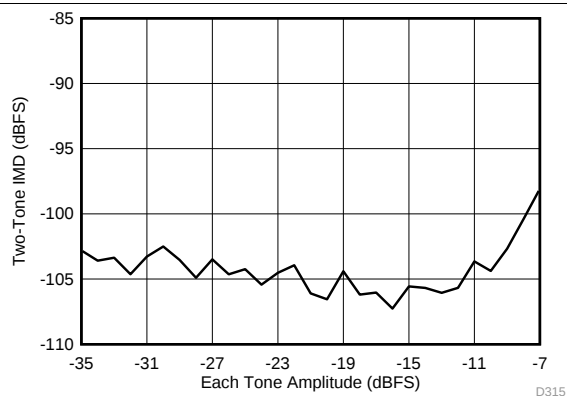
typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



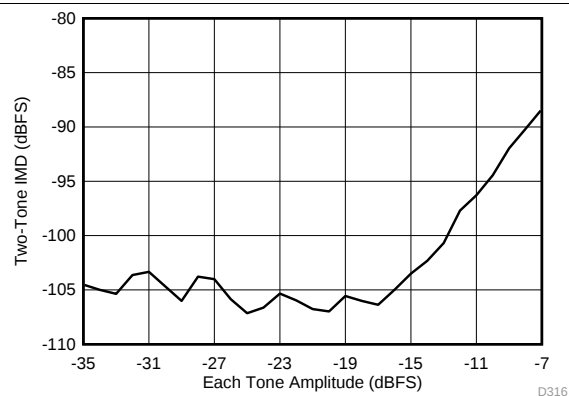
**Figure 79. FFT FOR Two-Tone Input Signal
(-7 dBFS at 185 MHz and 190 MHz)**



**Figure 80. FFT FOR Two-Tone Input Signal
(-36 dBFS at 185 MHz and 190 MHz)**



**Figure 81. Intermodulation Distortion vs Input Amplitude
(46 MHz and 50 MHz)**



**Figure 82. Intermodulation Distortion vs Input Amplitude
(185 MHz and 190 MHz)**

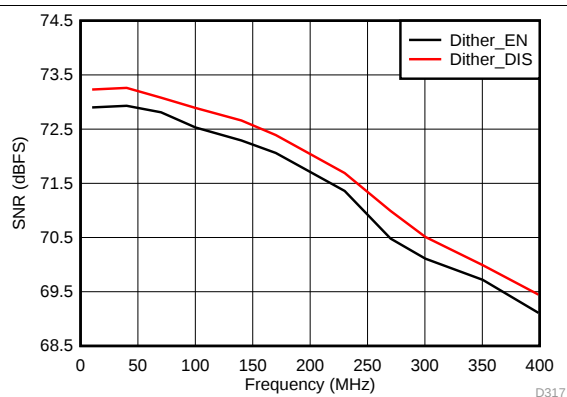
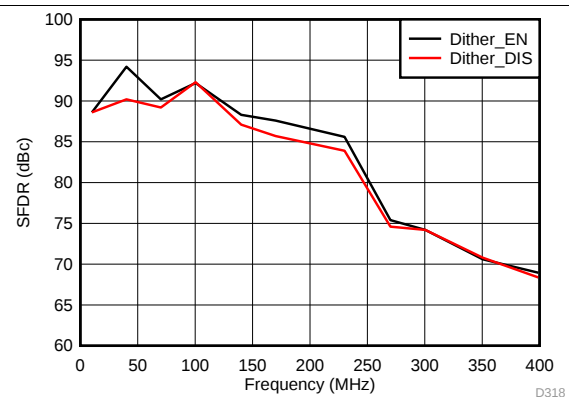


Figure 83. Signal-to-Noise Ratio vs Input Frequency



**Figure 84. Spurious-Free Dynamic Range vs
Input Frequency**

Typical Characteristics: ADC3443 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, AVDD = 1.8 V, DVDD = 1.8 V, –1-dBFS differential input, $2 \cdot V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

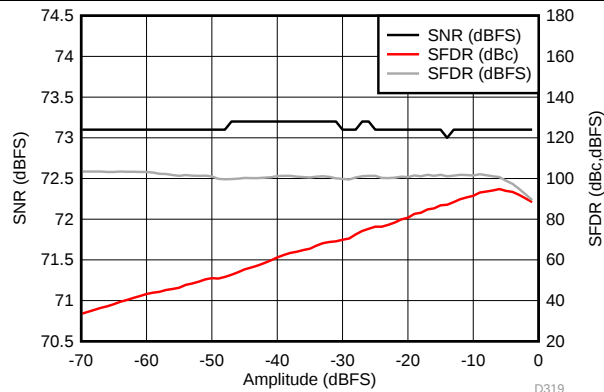


Figure 85. Performance vs Input Amplitude (30 MHz)

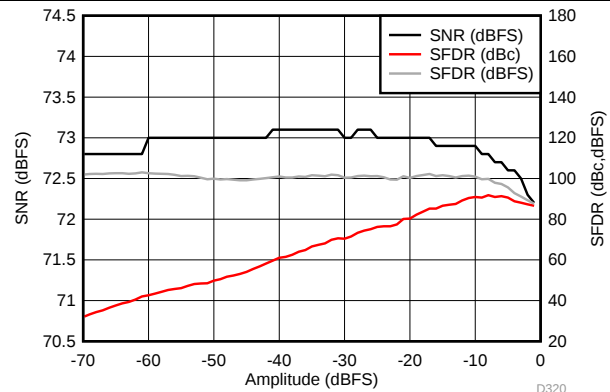


Figure 86. Performance vs Input Amplitude (170 MHz)

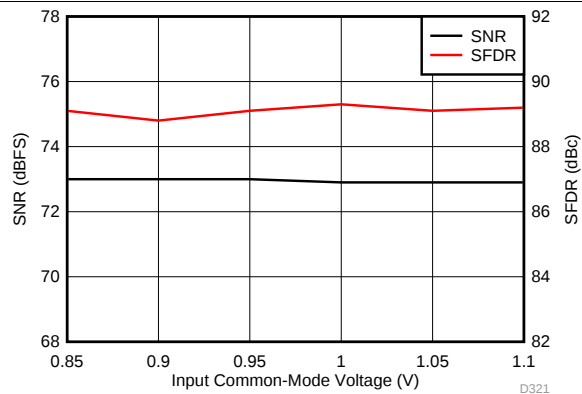


Figure 87. Performance vs Input Common-Mode Voltage (30 MHz)

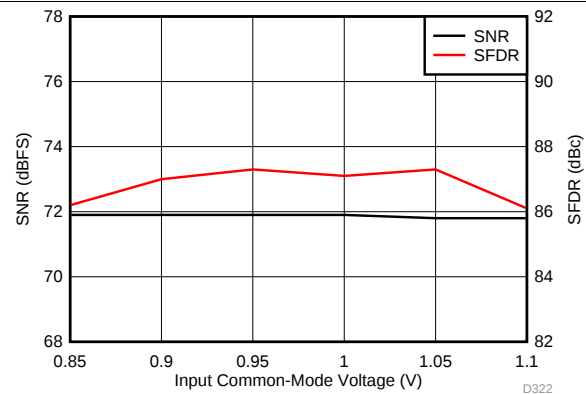


Figure 88. Performance vs Input Common-Mode Voltage (170 MHz)

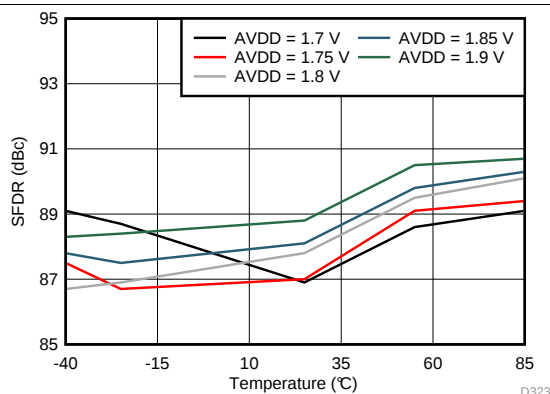


Figure 89. Spurious-Free Dynamic Range vs AVDD Supply and Temperature (170 MHz)

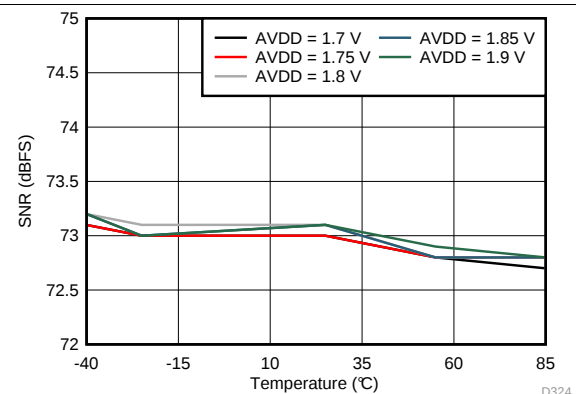


Figure 90. Signal-to-Noise Ratio vs AVDD Supply and Temperature (170 MHz)

Typical Characteristics: ADC3443 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, AVDD = 1.8 V, DVDD = 1.8 V, –1-dBFS differential input, 2- V_{PP} full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_S / 2$ when chopper is enabled, and dither on (unless otherwise noted)

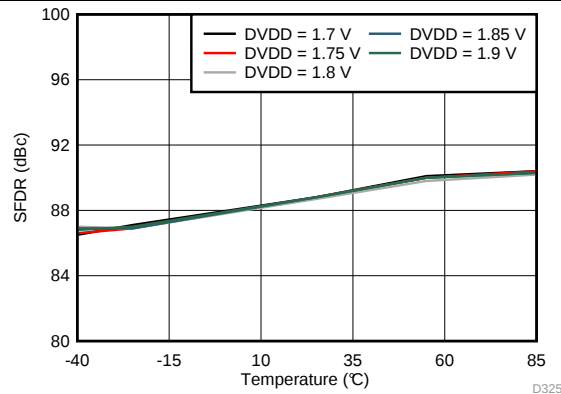


Figure 91. Spurious-Free Dynamic Range vs DVDD Supply and Temperature (170 MHz)

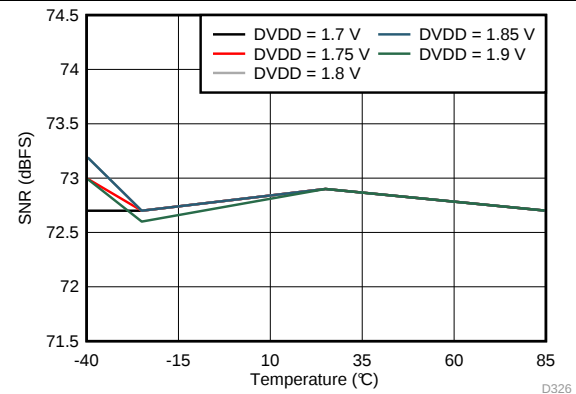


Figure 92. Signal-to-Noise Ratio vs DVDD Supply and Temperature (170 MHz)

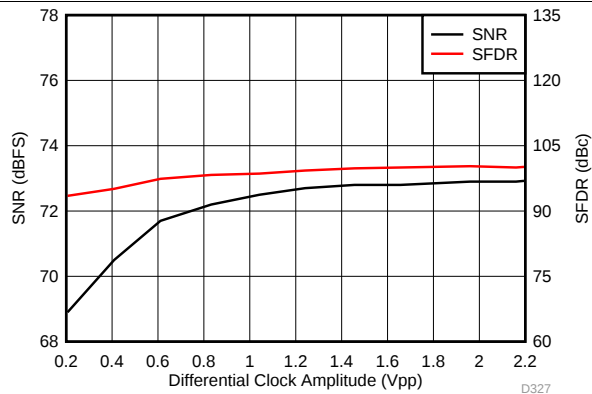


Figure 93. Performance vs Clock Amplitude (40 MHz)

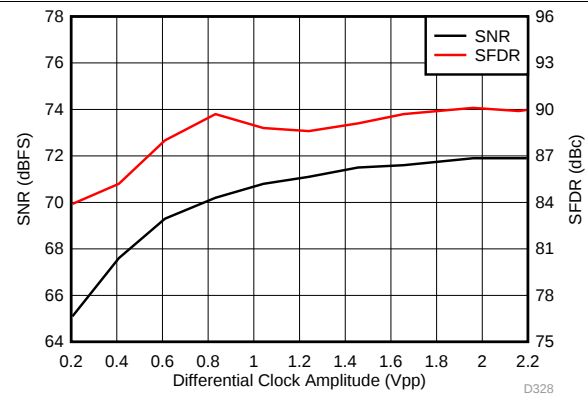


Figure 94. Performance vs Clock Amplitude (150 MHz)

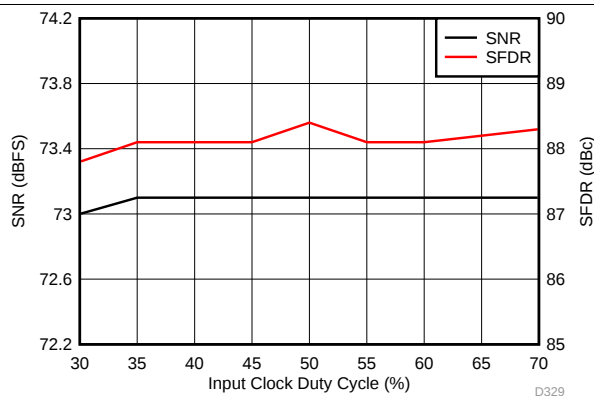


Figure 95. Performance vs Clock Duty Cycle (30 MHz)

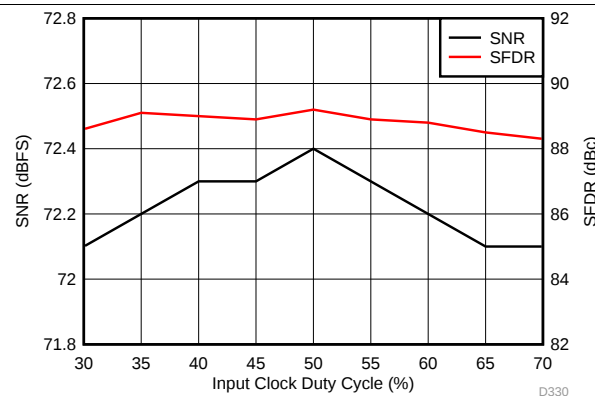


Figure 96. Performance vs Clock Duty Cycle (150 MHz)

Typical Characteristics: ADC3443 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

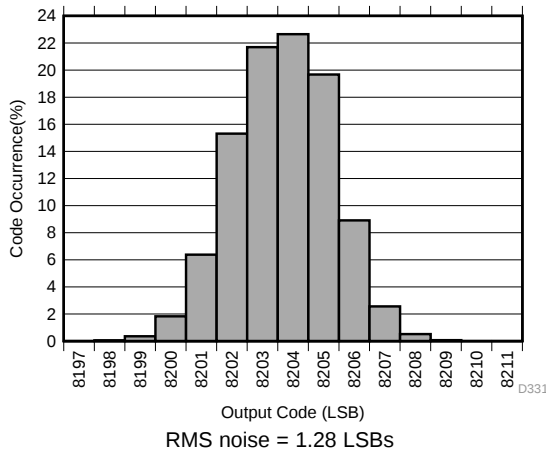


Figure 97. Idle Channel Histogram

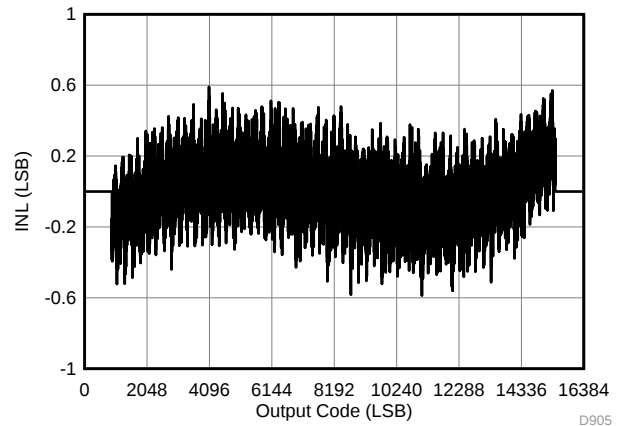


Figure 98. Integral Nonlinearity for 70-MHz Input

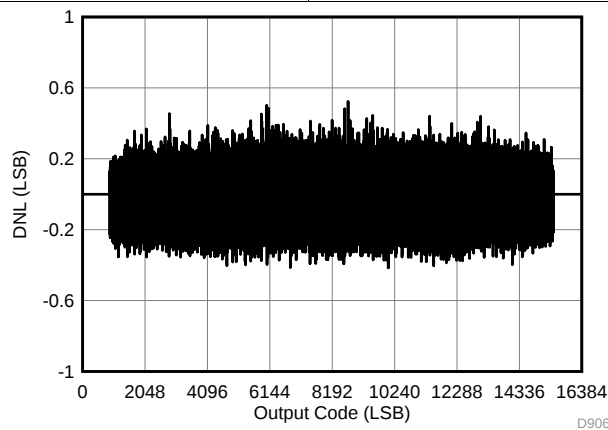
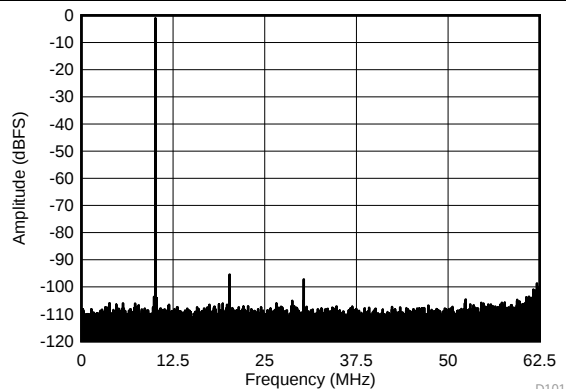


Figure 99. Differential Nonlinearity for 70-MHz Input

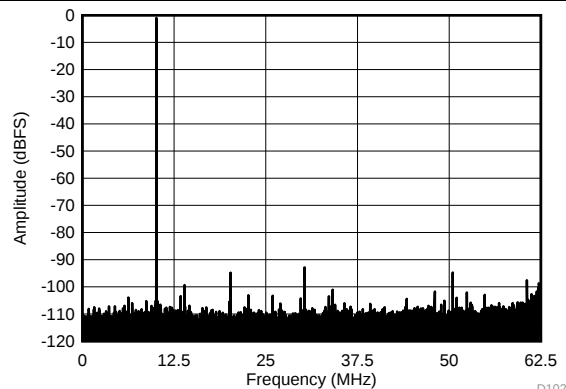
7.18 Typical Characteristics: ADC3444

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2-V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



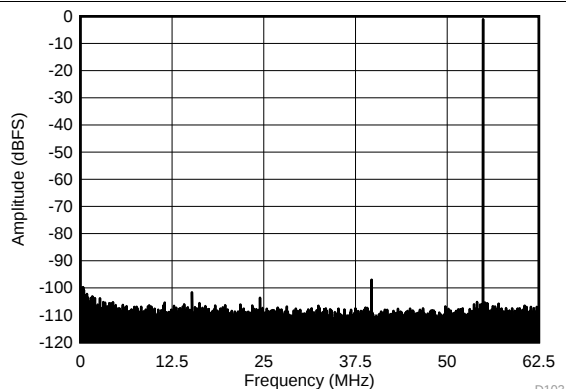
SFDR = 95 dBc, SNR = 72.7 dBFS, SINAD = 72.6 dBFS,
THD = 100 dBc, HD2 = 95 dBc, HD3 = 96 dBc

**Figure 100. FFT for 10-MHz Input Signal
(Chopper On, Dither On)**



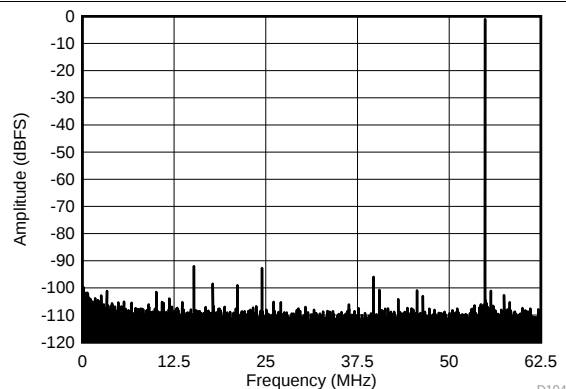
SFDR = 91.8 dBc, SNR = 73.1 dBFS, SINAD = 73 dBFS,
THD = 87 dBc, HD2 = 94 dBc, HD3 = 92 dBc

**Figure 101. FFT for 10-MHz Input Signal
(Chopper On, Dither Off)**



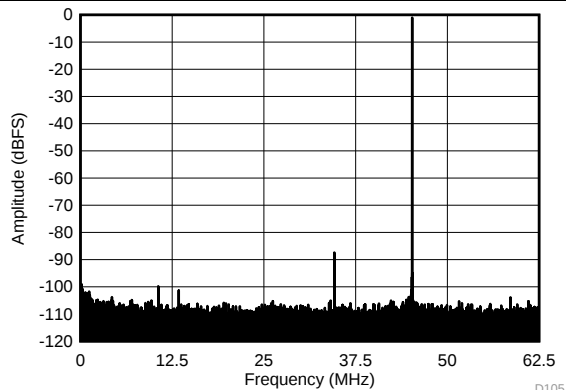
SFDR = 96 dBc, SNR = 72.5 dBFS, SINAD = 72.4 dBFS,
THD = 94 dBc, HD2 = 101 dBc, HD3 = 96 dBc

Figure 102. FFT for 70-MHz Input Signal (Dither On)



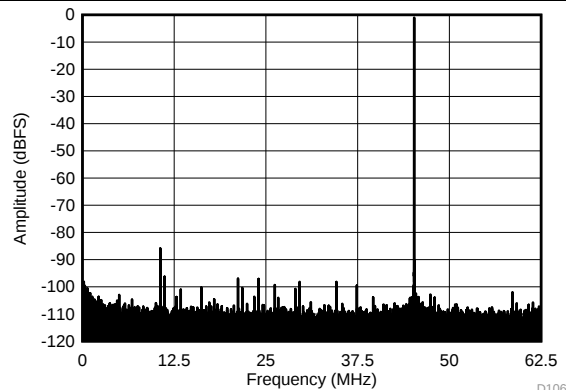
SFDR = 91 dBc, SNR = 73 dBFS, SINAD = 72.8 dBFS,
THD = 87 dBc, HD2 = 91 dBc, HD3 = 95 dBc

Figure 103. FFT for 70-MHz Input Signal (Dither Off)



SFDR = 86 dBc, SNR = 71.7 dBFS, SINAD = 71.6 dBFS,
THD = 93 dBc, HD2 = 86 dBc, HD3 = 99 dBc

Figure 104. FFT for 170-MHz Input Signal (Dither On)



SFDR = 85 dBc, SNR = 72.3 dBFS, SINAD = 72.1 dBFS,
THD = 87 dBc, HD2 = 97 dBc, HD3 = 85 dBc

Figure 105. FFT for 170-MHz Input Signal (Dither Off)

Typical Characteristics: ADC3444 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

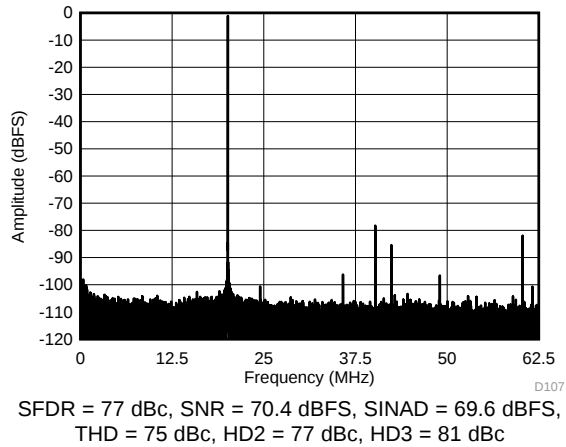


Figure 106. FFT for 270-MHz Input Signal (Dither On)

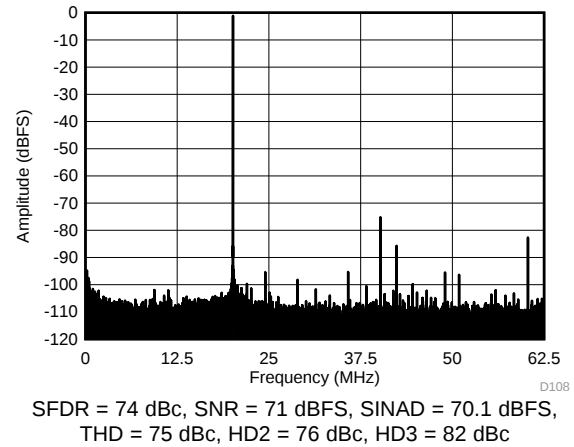


Figure 107. FFT for 270-MHz Input Signal (Dither Off)

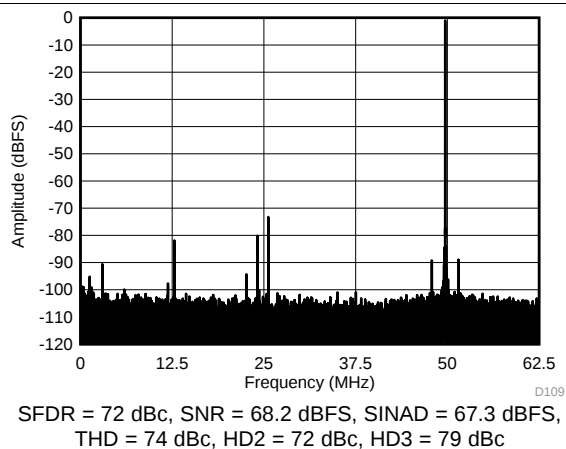


Figure 108. FFT for 450-MHz Input Signal (Dither On)

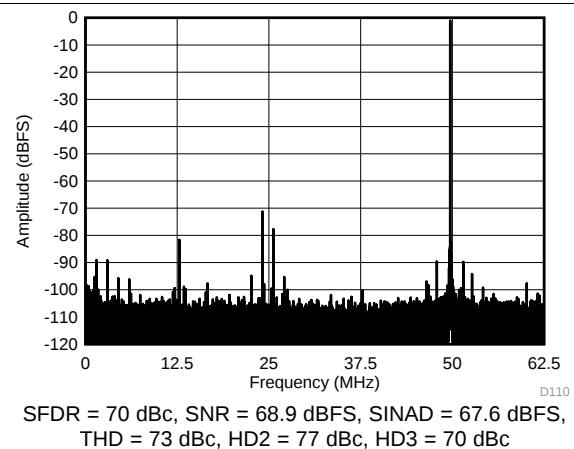
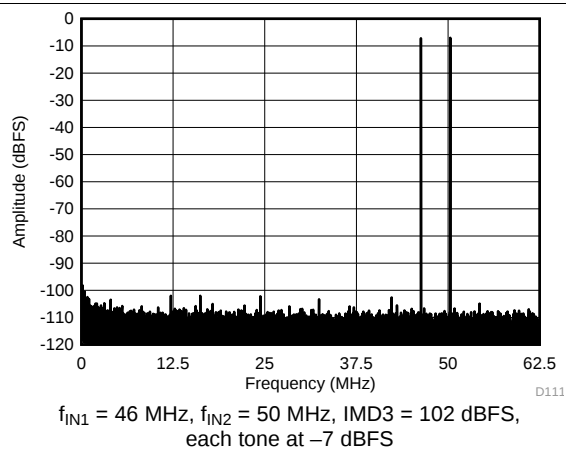
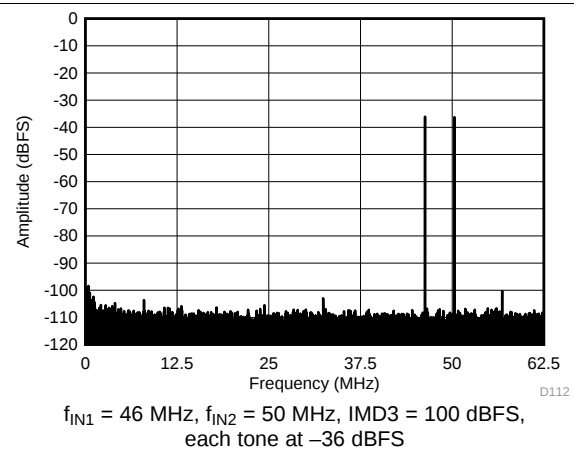


Figure 109. FFT for 450-MHz Input Signal (Dither Off)



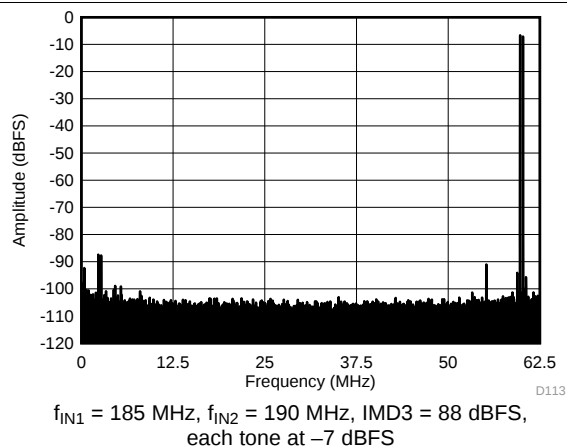
**Figure 110. FFT for Two-Tone Input Signal
(-7 dBFS at 46 MHz and 50 MHz)**



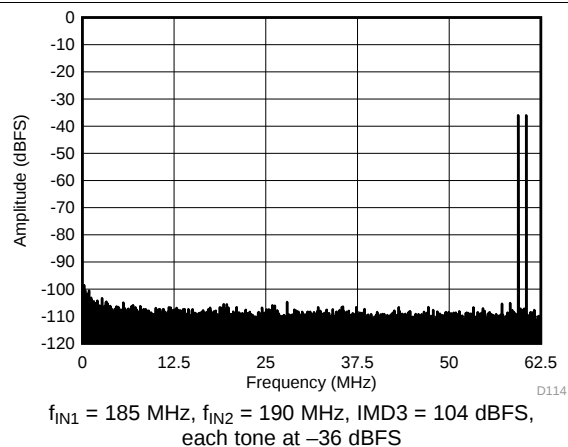
**Figure 111. FFT for Two-Tone Input Signal
(-36 dBFS at 46 MHz and 50 MHz)**

Typical Characteristics: ADC3444 (continued)

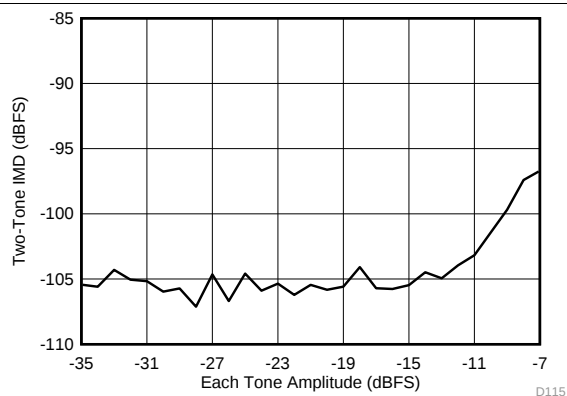
typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)



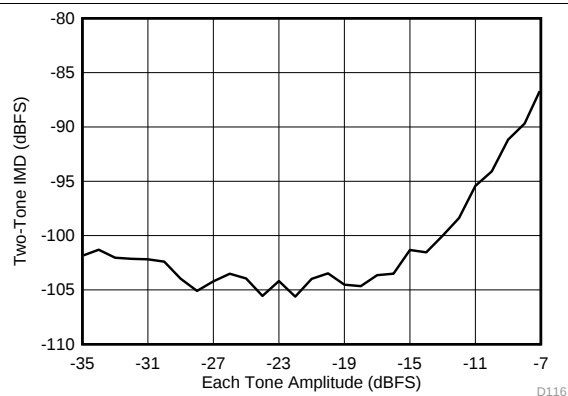
**Figure 112. FFT for Two-Tone Input Signal
(-7 dBFS at 185 MHz and 190 MHz)**



**Figure 113. FFT for Two-Tone Input Signal
(-36 dBFS at 185 MHz and 190 MHz)**



**Figure 114. Intermodulation Distortion vs Input Amplitude
(46 MHz and 50 MHz)**



**Figure 115. Intermodulation Distortion vs Input Amplitude
(185 MHz and 190 MHz)**

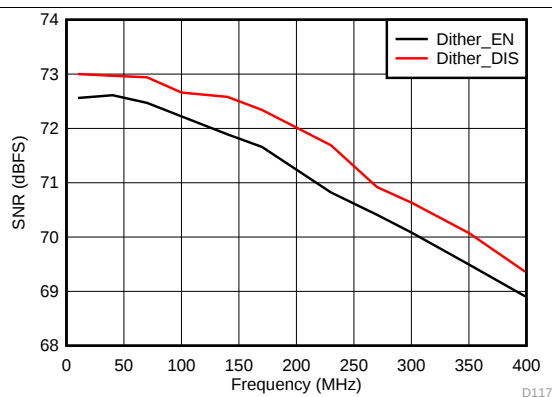
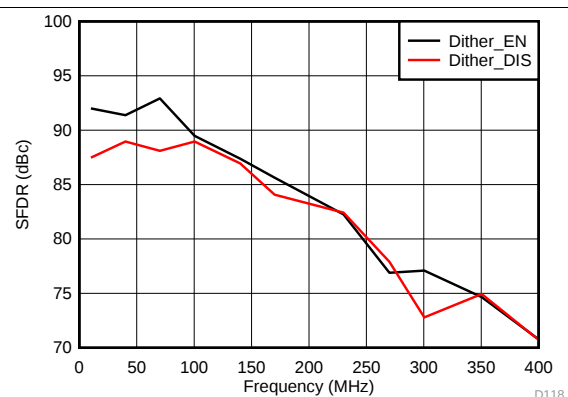


Figure 116. Signal-to-Noise Ratio vs Input Frequency



**Figure 117. Spurious-Free Dynamic Range vs
Input Frequency**

Typical Characteristics: ADC3444 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2 \cdot V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

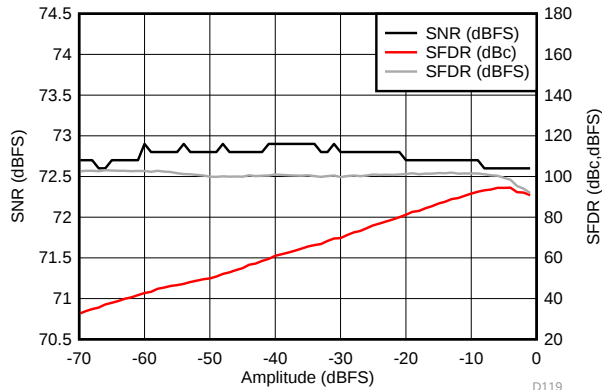


Figure 118. Performance vs Input Amplitude (30 MHz)

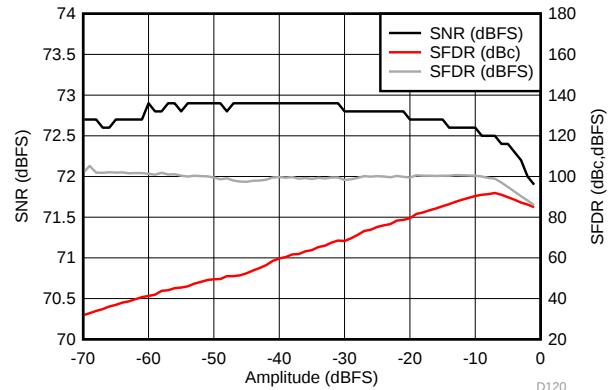


Figure 119. Performance vs Input Amplitude (170 MHz)

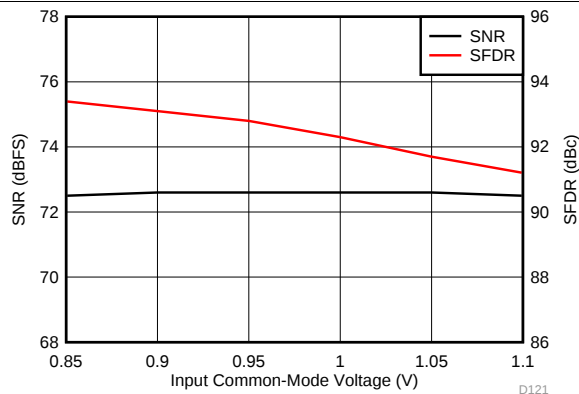


Figure 120. Performance vs Input Common-Mode Voltage (30 MHz)

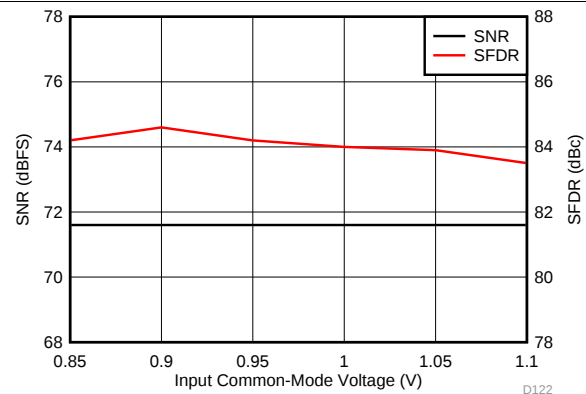


Figure 121. Performance vs Input Common-Mode Voltage (170 MHz)

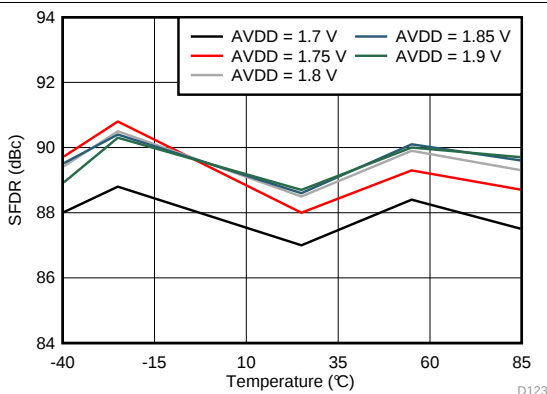


Figure 122. Spurious-Free Dynamic Range vs AVDD Supply and Temperature (170 MHz)

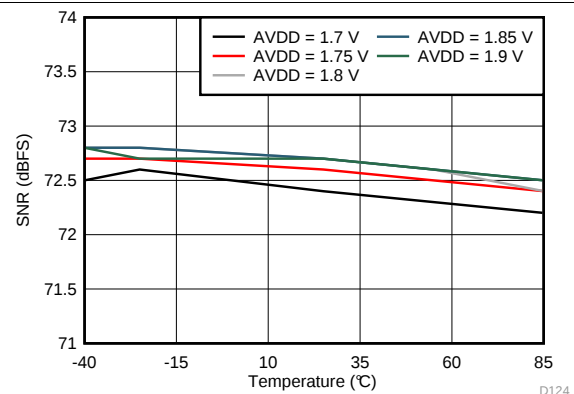


Figure 123. Signal-to-Noise Ratio vs AVDD Supply and Temperature (170 MHz)

Typical Characteristics: ADC3444 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

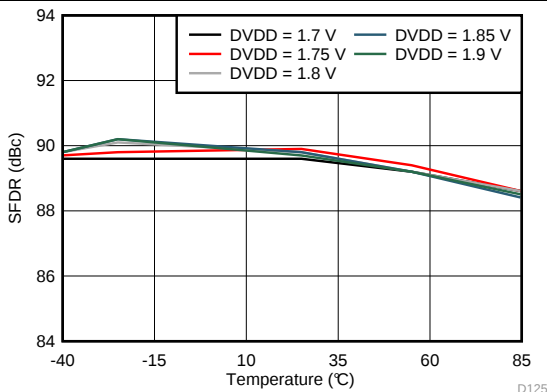


Figure 124. Spurious-Free Dynamic Range vs DVDD Supply and Temperature (170 MHz)

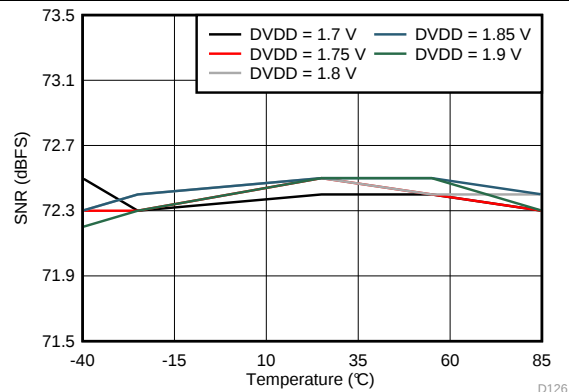


Figure 125. Signal-to-Noise Ratio vs DVDD Supply and Temperature (170 MHz)

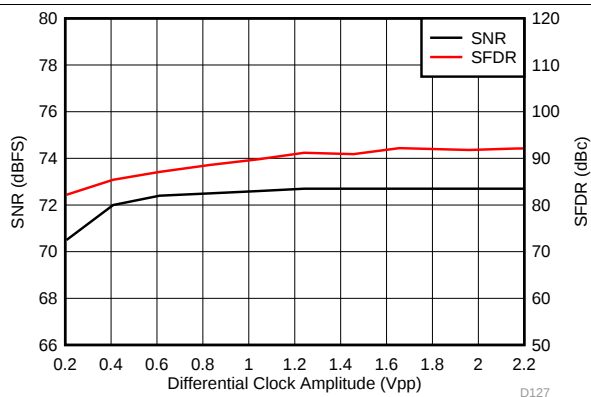


Figure 126. Performance vs Clock Amplitude (40 MHz)

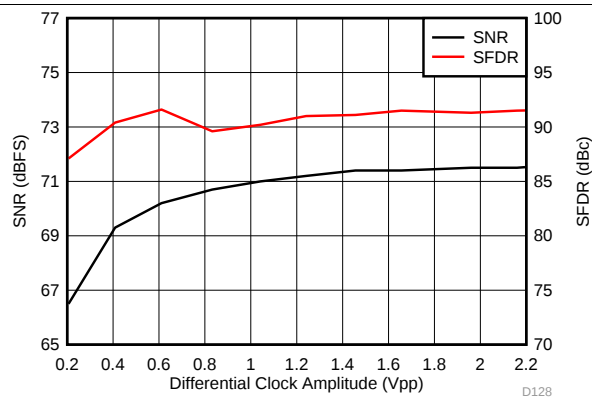


Figure 127. Performance vs Clock Amplitude (150 MHz)

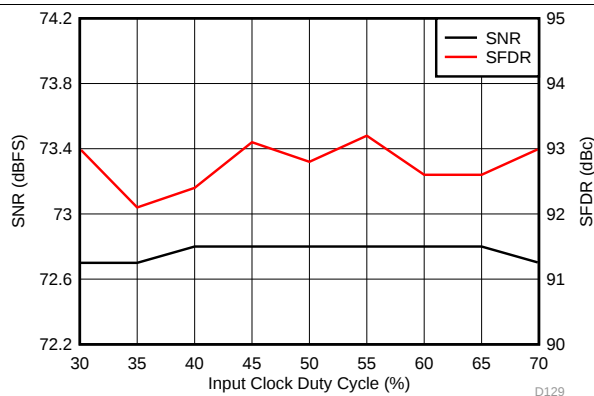


Figure 128. Performance vs Clock Duty Cycle (30 MHz)

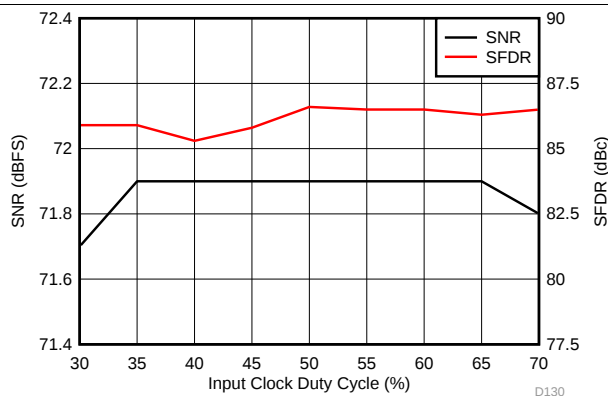


Figure 129. Performance vs Clock Duty Cycle (150 MHz)

Typical Characteristics: ADC3444 (continued)

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

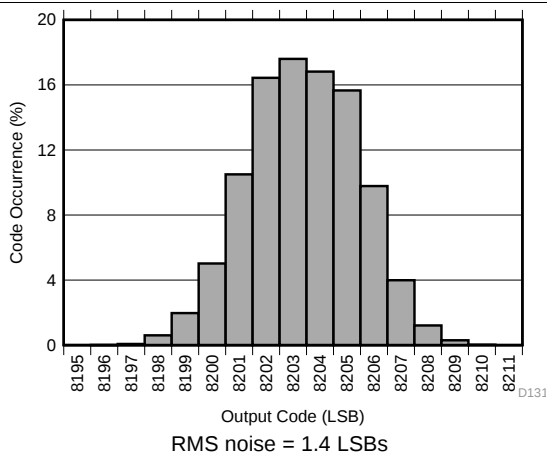


Figure 130. Idle Channel Histogram

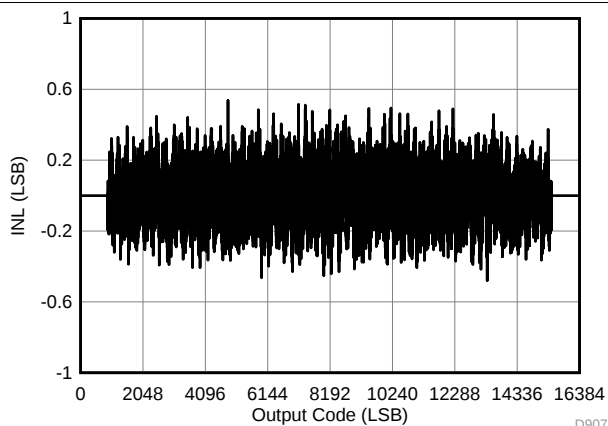


Figure 131. Integral Nonlinearity for 70-MHz Input

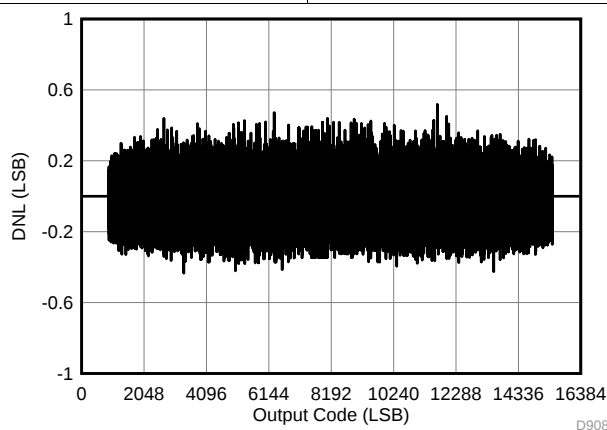


Figure 132. Differential Nonlinearity for 70-MHz Input

7.19 Typical Characteristics: Common

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = 1.8\text{ V}$, $DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when chopper is enabled, and dither on (unless otherwise noted)

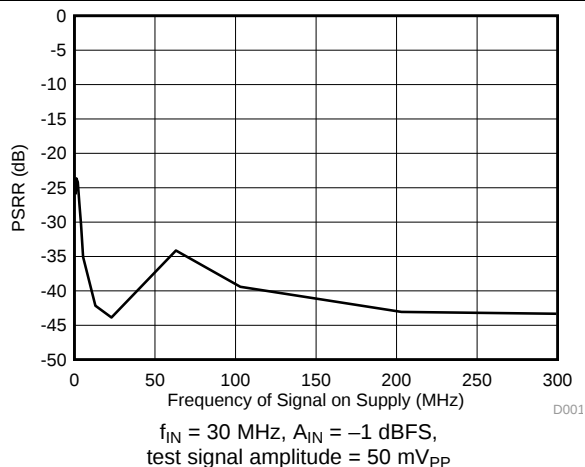


Figure 133. Power-Supply Rejection Ratio vs Test Signal Frequency

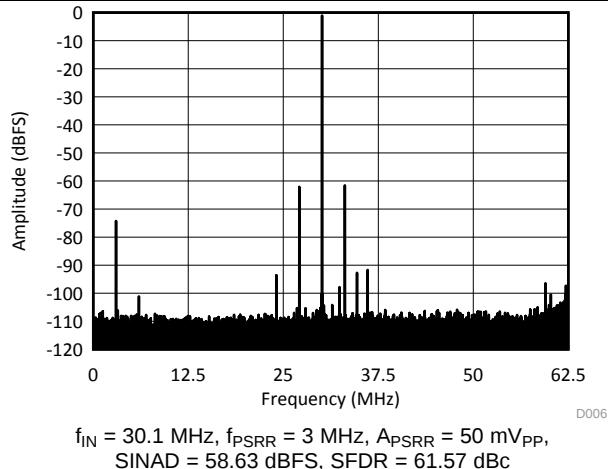


Figure 134. Power-Supply Rejection Ratio Spectrum (Chopper On)

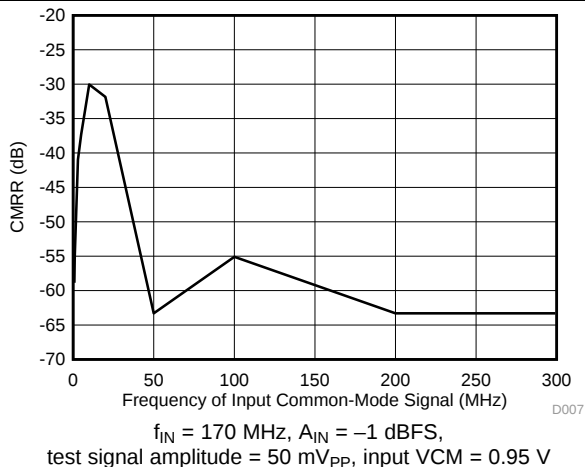


Figure 135. Common-Mode Rejection Ratio vs Test Signal Frequency

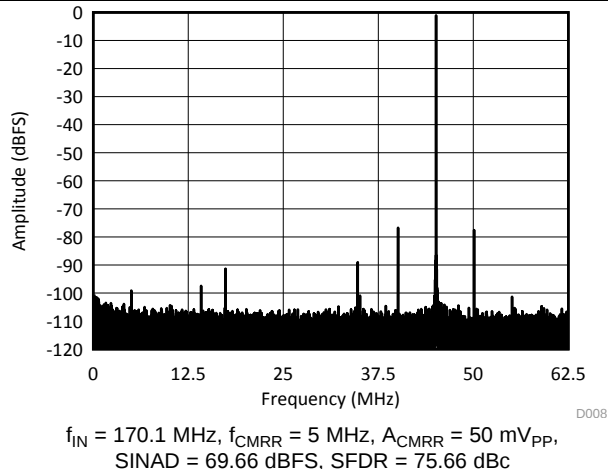


Figure 136. Common-Mode Rejection Ratio Spectrum

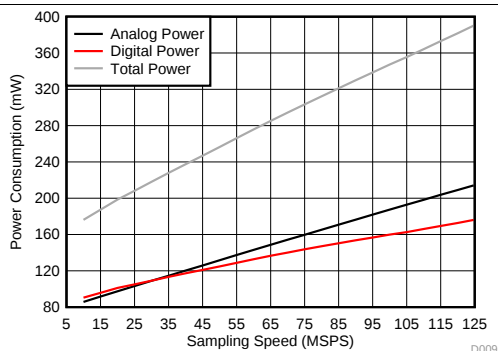


Figure 137. Power vs Sampling Frequency (Two-Wire Mode)

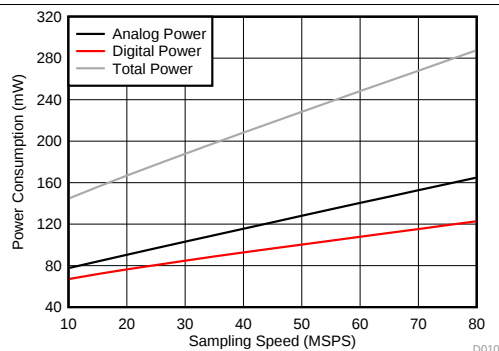


Figure 138. Power vs Sampling Frequency (One-Wire Mode)

7.20 Typical Characteristics: Contour

typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AV_{DD} = 1.8\text{ V}$, $DV_{DD} = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, chopper disabled, SNR reported with a 1-MHz offset from dc when chopper is disabled and from $f_s / 2$ when is chopper enabled, and dither on (unless otherwise noted)

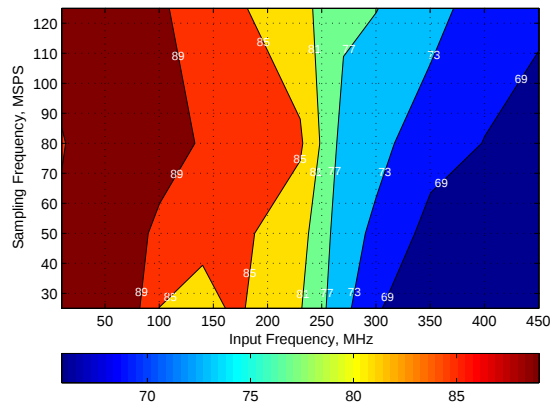


Figure 139. Spurious-Free Dynamic Range (SFDR)

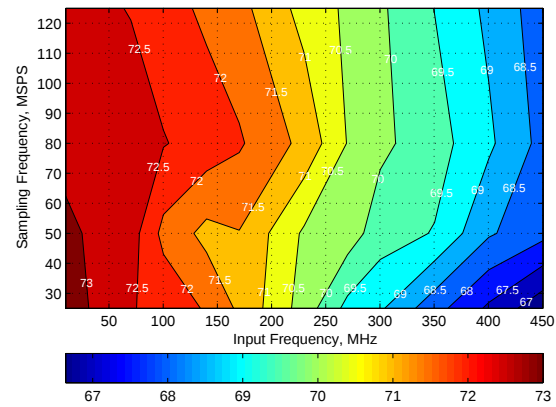


Figure 140. Signal-to-Noise Ratio (SNR)

8 Parameter Measurement Information

8.1 Timing Diagrams

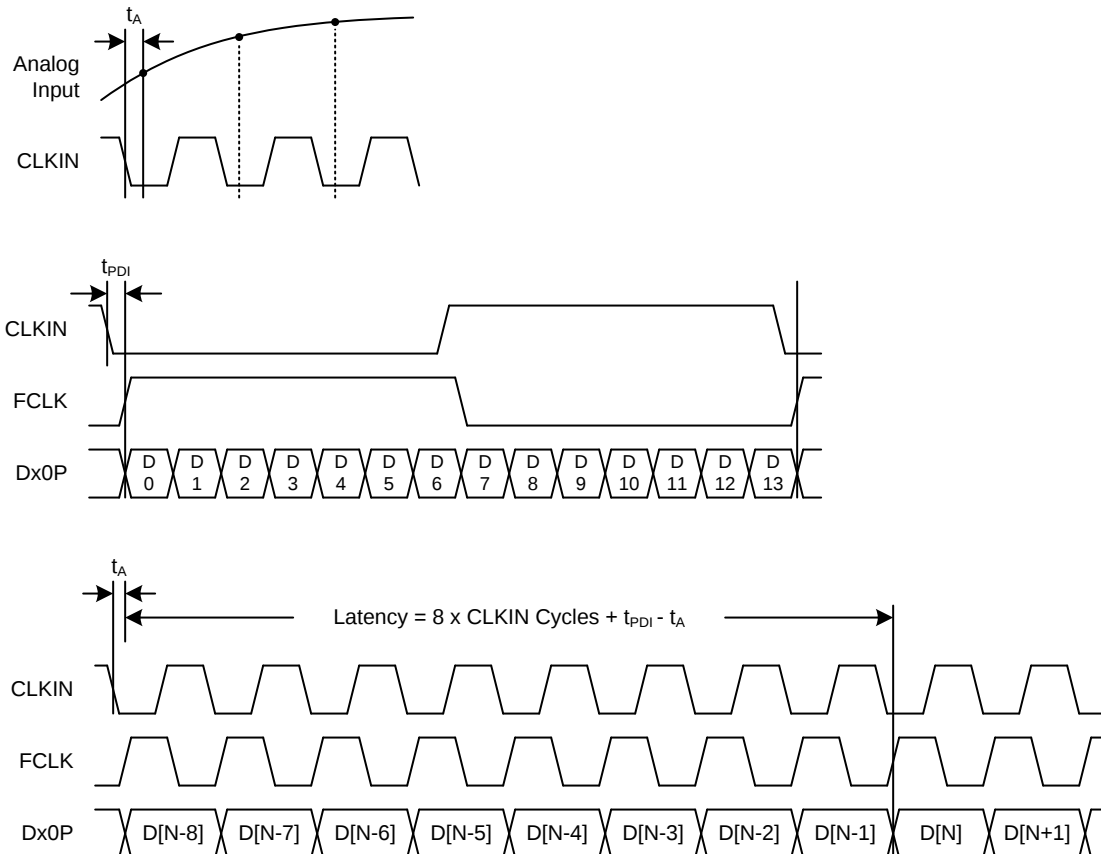
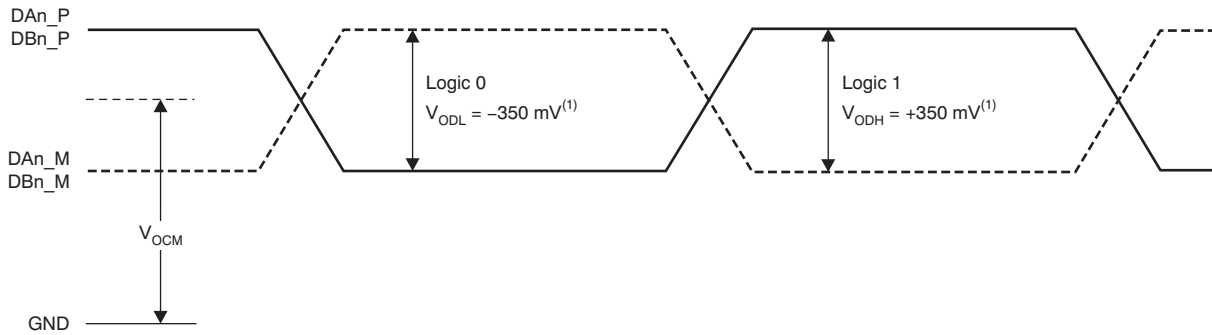


Figure 141. Latency Timing Diagram

Timing Diagrams (continued)



(1) With an external 100-Ω termination.

Figure 142. Serial LVDS Output Voltage Levels

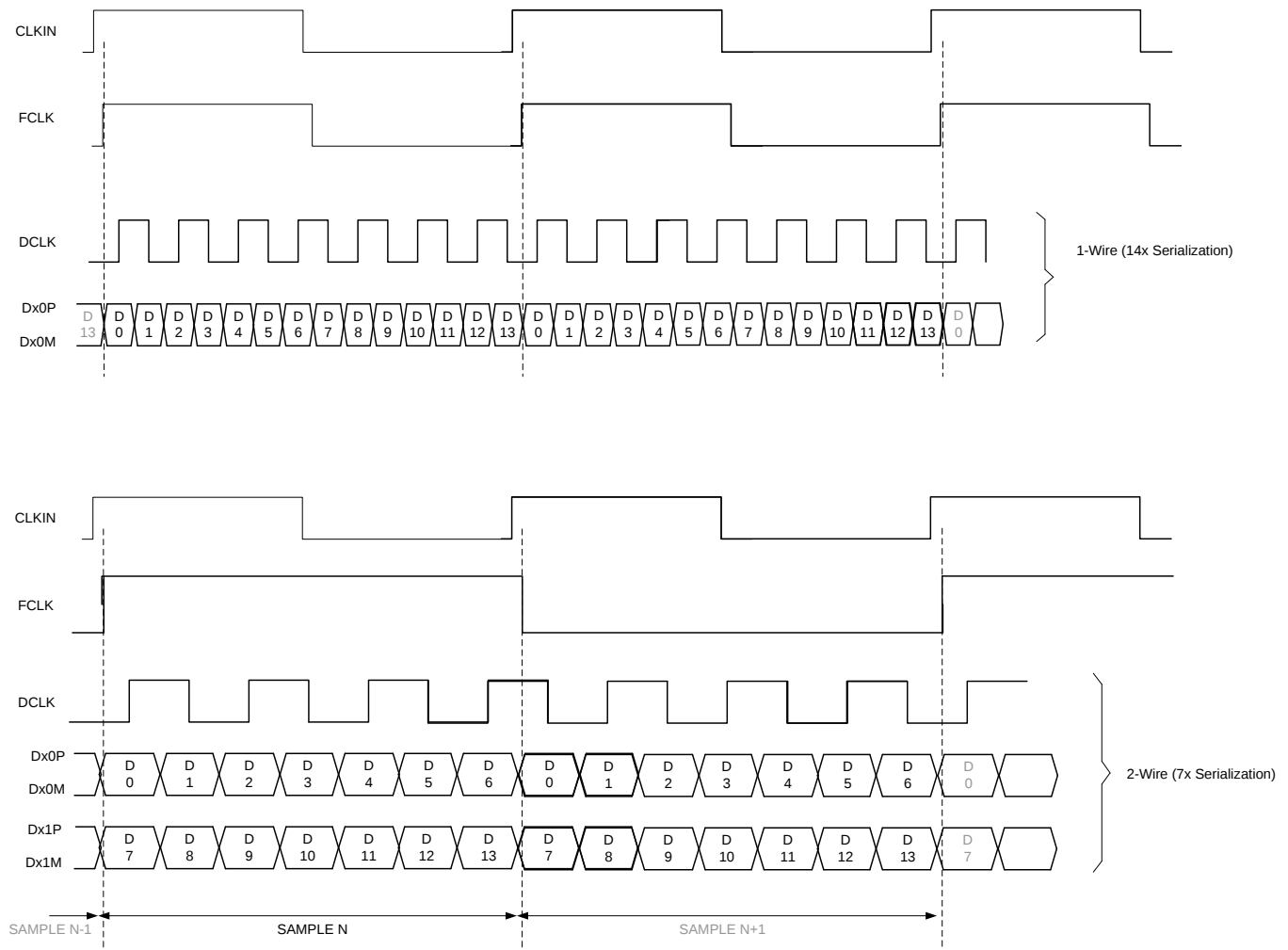


Figure 143. Output Timing Diagram

Timing Diagrams (continued)

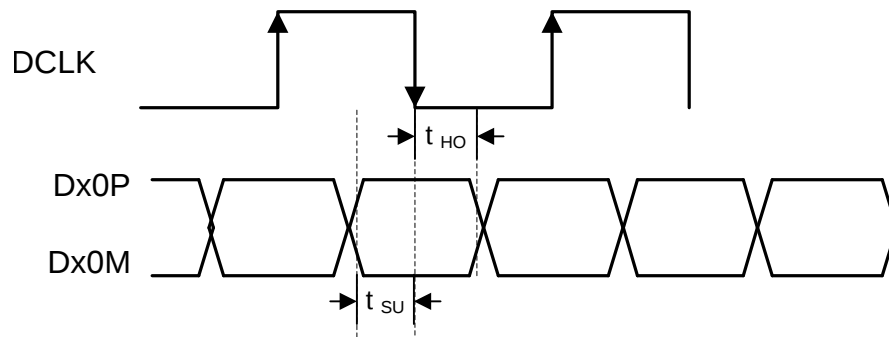


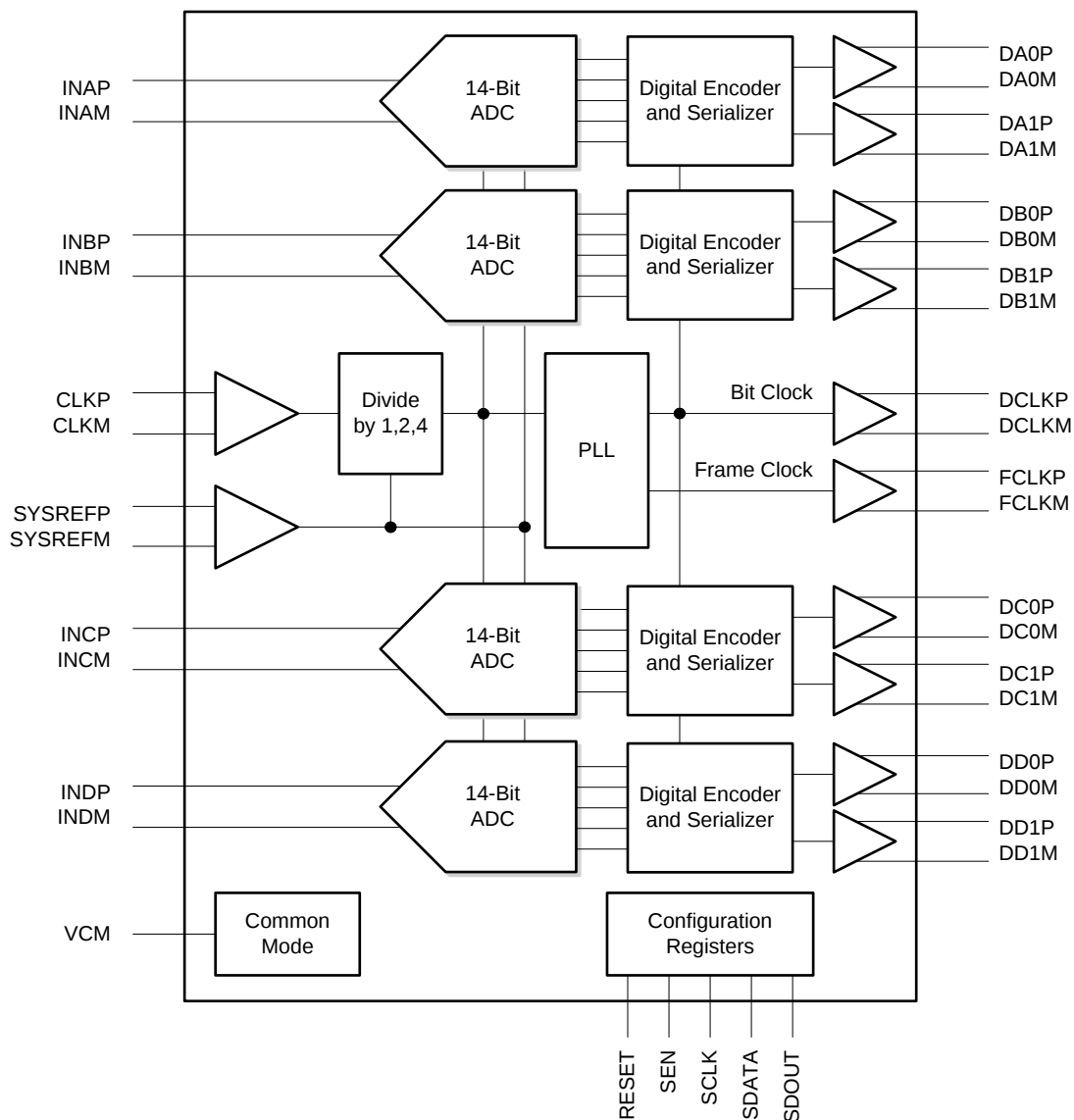
Figure 144. Setup and Hold Time

9 Detailed Description

9.1 Overview

The ADC344x devices are a high-linearity, ultra-low power, quad-channel, 14-bit, 25-MSPS to 125-MSPS, analog-to-digital converter (ADC) family. The devices are designed specifically to support demanding, high input frequency signals with large dynamic range requirements. An input clock divider allows more flexibility for system clock architecture design while the SYSREF input enables complete system synchronization. The ADC344x family supports serial LVDS interface in order to reduce the number of interface lines, thus allowing for high system integration density. The serial LVDS interface is two-wire, where each ADC data are serialized and output over two LVDS pairs. An internal phase-locked loop (PLL) multiplies the incoming ADC sampling clock to derive the bit clock that is used to serialize the 14-bit output data from each channel. In addition to the serial data streams, the frame and bit clocks are also transmitted as LVDS outputs.

9.2 Functional Block Diagram



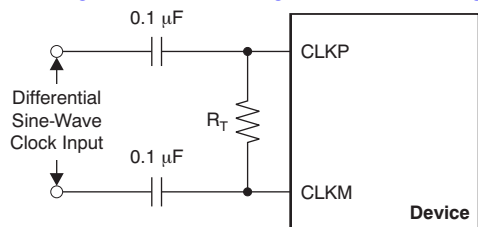
9.3 Feature Description

9.3.1 Analog Inputs

The ADC344x analog signal inputs are designed to be driven differentially. Each input pin (INP, INM) must swing symmetrically between $(V_{CM} + 0.5\text{ V})$ and $(V_{CM} - 0.5\text{ V})$, resulting in a $2\text{-}V_{PP}$ (default) differential input swing. The input sampling circuit has a 3-dB bandwidth that extends up to 540 MHz (50- Ω source driving 50- Ω termination between INP and INM).

9.3.2 Clock Input

The device clock inputs may be driven differentially (sine, LVPECL, or LVDS) or single-ended (LVCMOS), with little or no difference in performance between them. The common-mode voltage of the clock inputs is set to 0.95 V using internal 5-k Ω resistors. The ADC344x self-bias clock inputs may be driven by the transformer-coupled, sine-wave clock source or by the ac-coupled, LVPECL and LVDS clock sources, as shown in Figure 145, Figure 146, and Figure 147. See Figure 148 for details regarding the internal clock buffer.



NOTE: R_T = termination resistor, if necessary.

Figure 145. Differential Sine-Wave Clock Driving Circuit

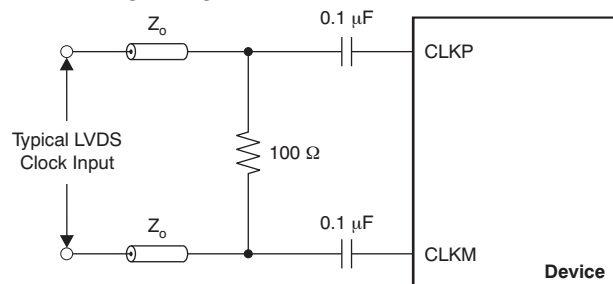


Figure 146. LVDS Clock Driving Circuit

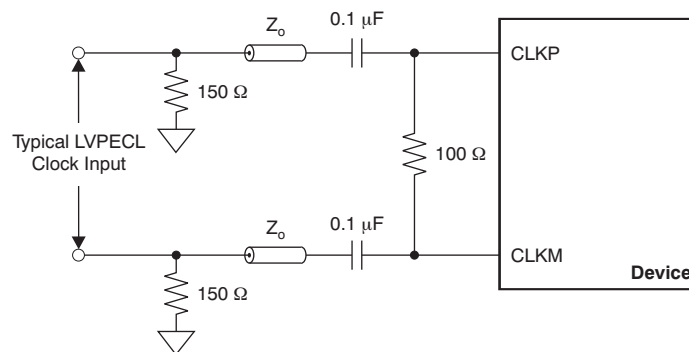
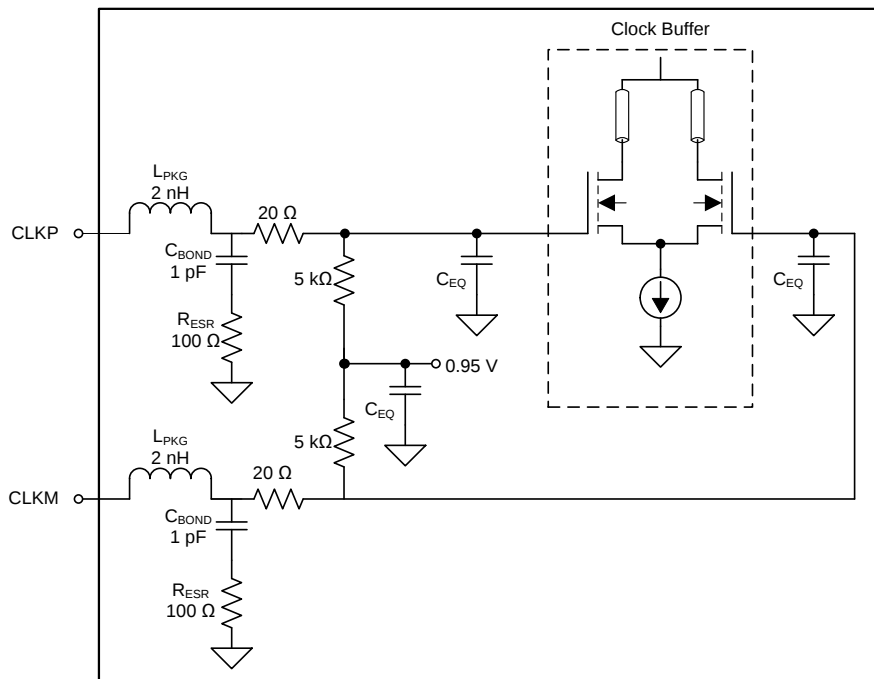


Figure 147. LVPECL Clock Driving Circuit



NOTE: C_{EQ} is 1 pF to 3 pF and is the equivalent input capacitance of the clock buffer.

Figure 148. Internal Clock Buffer

A single-ended CMOS clock may be ac-coupled to the CLKP input, with CLKM connected to ground with a 0.1- μ F capacitor, as shown in Figure 149. However, for best performance the clock inputs must be driven differentially, thereby reducing susceptibility to common-mode noise. For high input frequency sampling, TI recommends using a clock source with low jitter. Band-pass filtering of the clock source may help reduce the effects of jitter. There is no change in performance with a non-50% duty cycle clock input.

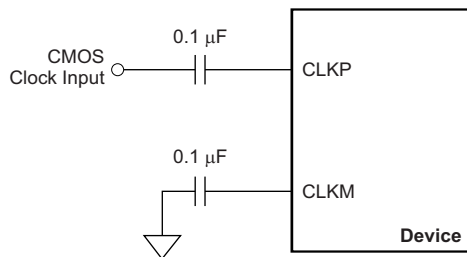


Figure 149. Single-Ended Clock Driving Circuit

9.3.2.1 Using the SYSREF Input

The ADC344x has a SYSREF input pin that can be used when the clock-divider feature is used. A logic low-to-high transition on the SYSREF pin aligns the falling edge of the divided clock with the next falling edge of the input clock, essentially resetting the phase of the divided clock, as shown in [Figure 150](#). When multiple ADC344x devices are onboard and the clock divider option is used, the phase of the divided clock among the devices may not be the same. The phase of the divided clock in each device can be synchronized to the common sampling clock by using the SYSREF pins. SYSREF can be applied as mono-shot or periodic waveform. When applied as periodic waveform, its period must be an integer multiple of the period of the divided clock. When not used, the SYSREFP and SYSREFM pins can be connected to AVDD and GND, respectively. Alternatively, the SYSREF buffer inside the device can be powered down using the PDN SYSREF register bit.

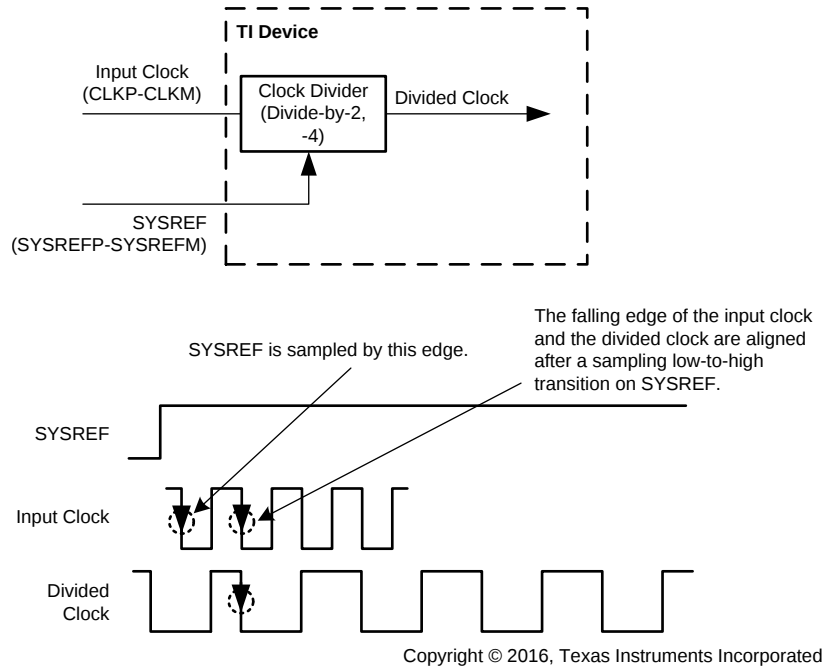


Figure 150. Using SYSREF for Synchronization

9.3.2.2 SNR and Clock Jitter

The signal-to-noise ratio of the ADC is limited by three different factors, as shown in [Equation 1](#). Quantization noise (typically 86 dB for a 14-bit ADC) and thermal noise limit SNR at low input frequencies while the clock jitter sets SNR for higher input frequencies.

$$SNR_{ADC}[dBc] = -20 \cdot \log \sqrt{\left(10^{\frac{SNR_{Quantization\ Noise}}{20}}\right)^2 + \left(10^{\frac{SNR_{Thermal\ Noise}}{20}}\right)^2 + \left(10^{\frac{SNR_{Jitter}}{20}}\right)^2} \quad (1)$$

The SNR limitation resulting from sample clock jitter may be calculated with [Equation 2](#).

$$SNR_{Jitter}[dBc] = -20 \cdot \log(2\pi \cdot f_{in} \cdot T_{Jitter}) \quad (2)$$

The total clock jitter (T_{Jitter}) has two components: the internal aperture jitter (130 fs for the device) which is set by the noise of the clock input buffer and the external clock. T_{Jitter} may be calculated with [Equation 3](#).

$$T_{Jitter} = \sqrt{(T_{Jitter,Ext.Clock_Input})^2 + (T_{Aperture_ADC})^2} \quad (3)$$

External clock jitter may be minimized by using high-quality clock sources and jitter cleaners as well as band-pass filters at the clock input while a faster clock slew rate improves the ADC aperture jitter. The devices have a typical thermal noise of 72.7 dBFS and internal aperture jitter of 130 fs. The SNR, depending on the amount of external jitter for different input frequencies, is shown in Figure 151.

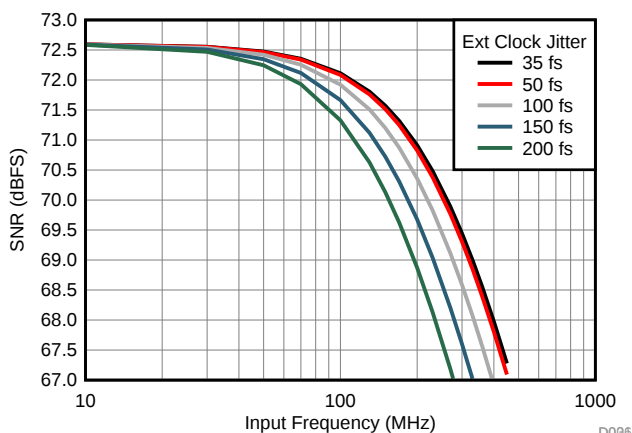


Figure 151. SNR vs Frequency for Different Clock Jitter

9.3.3 Digital Output Interface

The devices offer two different output format options, thus making interfacing to a field-programmable gate array (FPGA) or an application-specific integrated circuit (ASIC) easy. Each option may be easily programmed using the serial interface, as shown in Table 3. The output interface options are:

- One-wire, 1x frame clock, 14x serialization with the DDR bit clock
- Two-wire, 1x frame clock, 7x serialization with the DDR bit clock.

Table 3. Interface Rates

INTERFACE OPTIONS	SERIALIZATION	RECOMMENDED SAMPLING FREQUENCY (MSPS)		BIT CLOCK FREQUENCY (MHz)	FRAME CLOCK FREQUENCY (MHz)	SERIAL DATA RATE (Mbps)
		MINIMUM	MAXIMUM			
1-wire	14x	15 ⁽¹⁾	—	105	15	210
		—	80	560	80	1120
2-wire (default after reset)	7x	20 ⁽¹⁾	—	70	10	140
		—	125	437.5	62.5	875

(1) Use the LOW SPEED ENABLE register bits for low speed operation; see Table 20.

9.3.3.1 One-Wire Interface: 14x Serialization

In this interface option, the device outputs the data of each ADC serially on a single LVDS pair (one-wire). The data are available at the rising and falling edges of the bit clock (DDR bit clock). The ADC outputs a new word at the rising edge of every frame clock, starting with the LSB. The data rate is 14x sample frequency (14x serialization).

9.3.3.2 Two-Wire Interface: 7x Serialization

The two-wire interface is recommended for sampling frequencies above 65 MSPS. The output data rate is 7x sample frequency because seven data bits are output every clock cycle on each differential pair. Each ADC sample is sent over the two wires with the seven MSBs on Dx1P, Dx1M and the seven LSBs on Dx0P, Dx0M, as shown in [Figure 152](#).

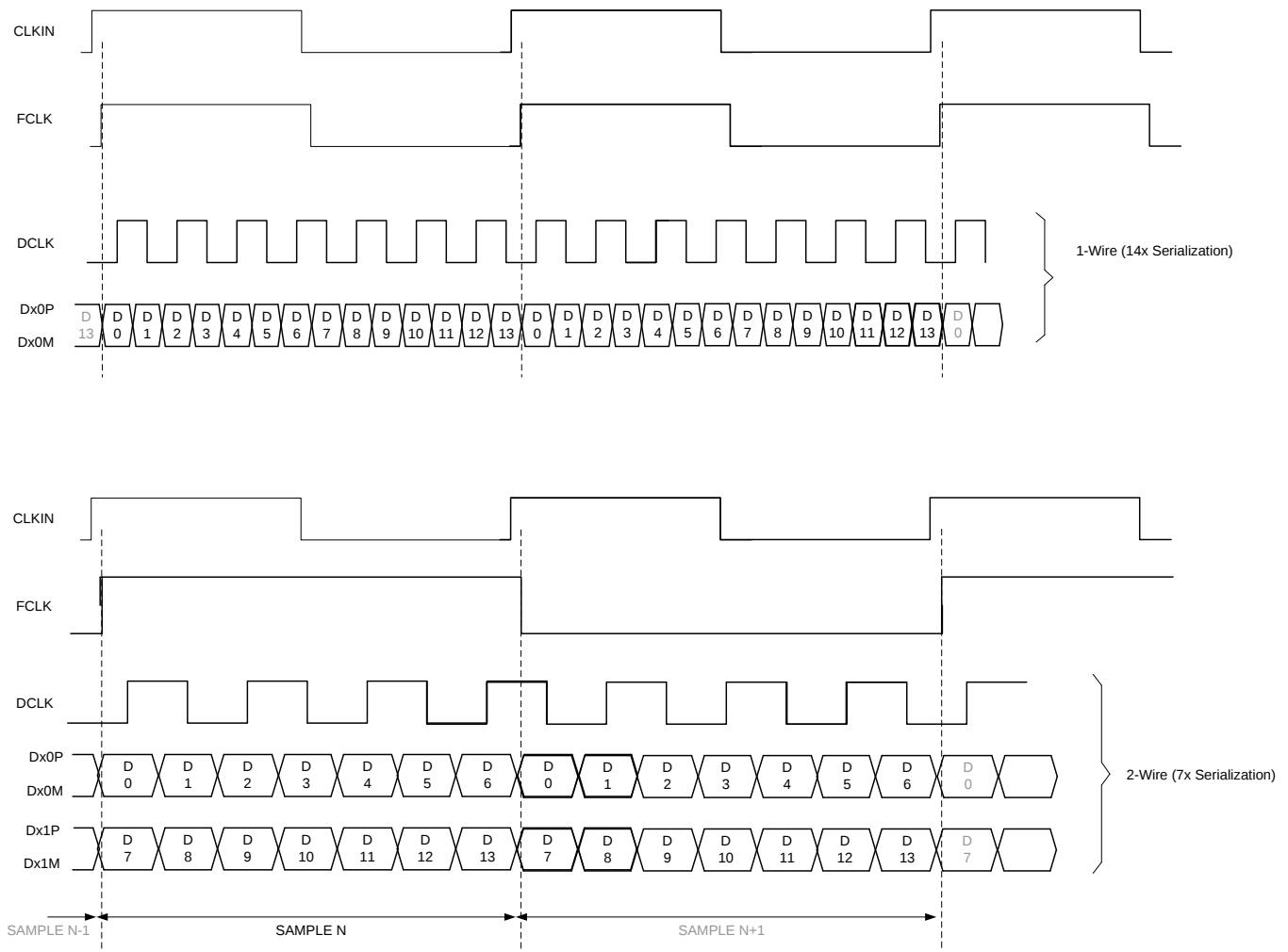


Figure 152. Output Timing Diagram

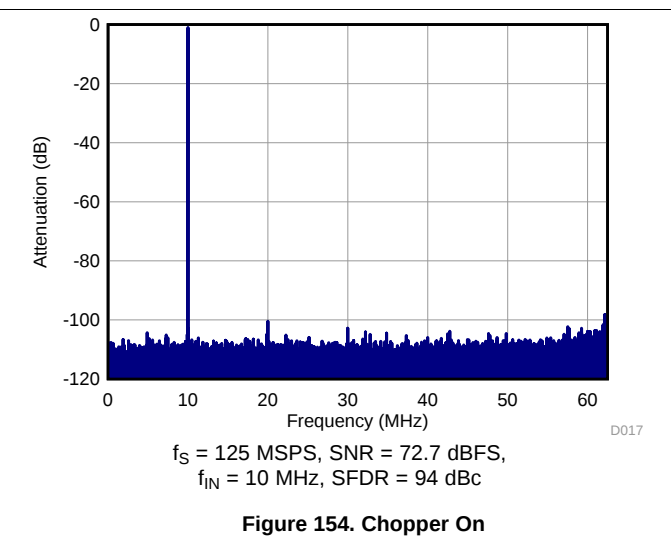
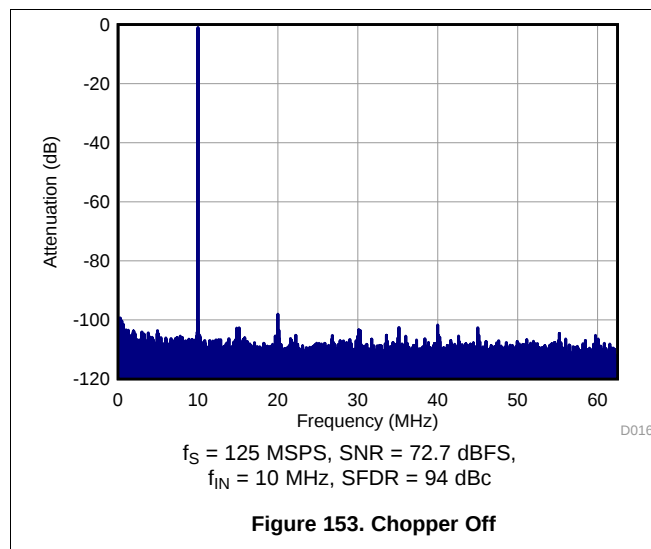
9.4 Device Functional Modes

9.4.1 Input Clock Divider

The devices are equipped with an internal divider on the clock input. The clock divider allows operation with a faster input clock, thus simplifying the system clock distribution design. The clock divider may be bypassed for operation with a 125-MHz clock while the divide-by-2 option supports a maximum input clock of 250 MHz and the divide-by-4 option provides a maximum input clock frequency of 500 MHz.

9.4.2 Chopper Functionality

The devices are equipped with an internal chopper front-end. Enabling the chopper function swaps the ADC noise spectrum by shifting the $1/f$ noise from dc to $f_s / 2$. [Figure 153](#) shows the noise spectrum with the chopper off and [Figure 154](#) shows the noise spectrum with the chopper on. This function is especially useful in applications requiring good ac performance at low input frequencies or in dc-coupled applications. The chopper may be enabled through SPI register writes and is recommended for input frequencies below 30 MHz. The chopper function creates a spur at $f_s / 2$ that must be filtered out digitally.



9.4.3 Power-Down Control

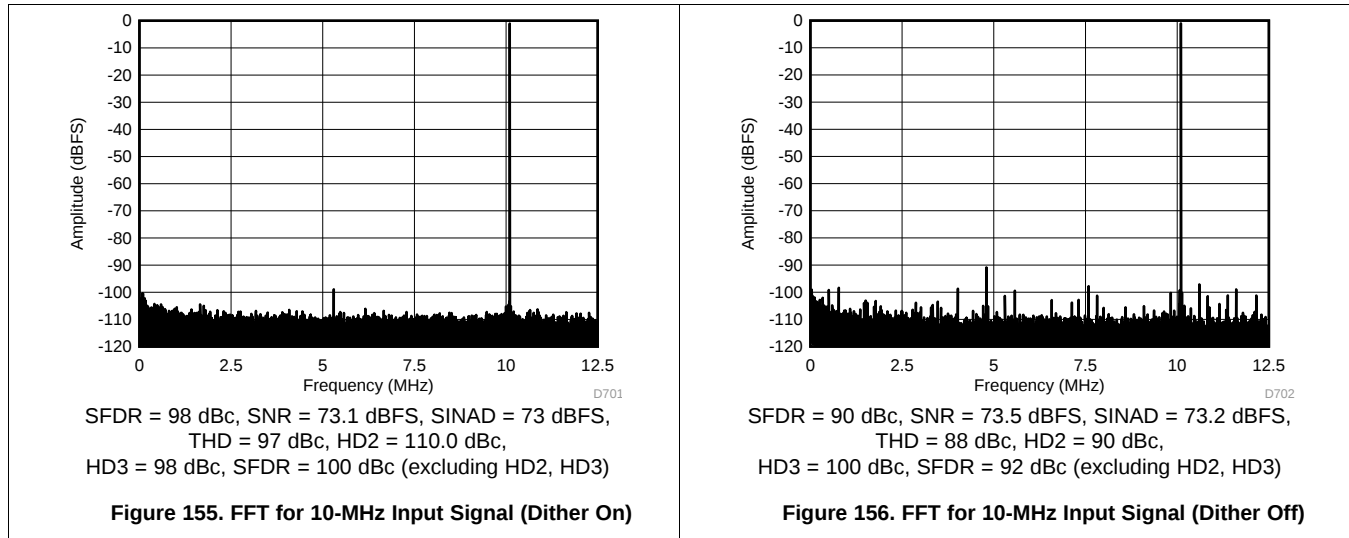
The ADC344x power-down functions may be controlled either through the parallel control pin (PDN) or through an SPI register setting (see [register 15h](#)). The PDN pin may also be configured through SPI to a global power-down or standby functionality, as shown in [Table 4](#).

Table 4. Power-Down Modes

FUNCTION	POWER CONSUMPTION (mW)	WAKE-UP TIME (μ s)
Global power-down	5	85
Standby	45	35

9.4.4 Internal Dither Algorithm

The ADC344x family uses an internal dither algorithm to achieve high SFDR and a clean spectrum. However, the dither algorithm marginally degrades SNR, creating a trade-off between SNR and SFDR. If desired, the dither algorithm may be turned off by using the DIS DITH CHx registers bits. [Figure 155](#) and [Figure 156](#) show the effect of using dither algorithms.



9.4.5 Summary of Performance Mode Registers

[Table 5](#) lists the location, value, and functions of performance mode registers in the device.

Table 5. Performance Modes

MODE	LOCATION	FUNCTION
Special modes	Registers 139 (bit 3), 239 (bit 3), 439 (bit 3), and 539 (bit 3)	Always write 1 for best performance.
Disable dither	Registers 1 (bits 7-0), 134 (bits 5 and 3), 234 (bits 5 and 3), 434 (bits 5 and 3), and 534 (bits 5 and 3)	Disables the dither to improve SNR.
Disable chopper	Registers 122 (bit 1), 222 (bit 1), 422 (bit 1), and 522 (bit 1)	Disables the chopper (shifts the 1/f noise floor at dc).
High IF modes	Registers 11Dh (bit 1), 21Dh (bit 1), 41Dh (bit 1), 51Dh (bit 1), 308h (bits 7-6) and 608h (bits 7-6)	Improves HD3 by a couple of dB for IF > 100 MHz

9.5 Programming

The ADC344x device may be configured using a serial programming interface, as described in this section.

9.5.1 Serial Interface

The device has a set of internal registers that may be accessed by the serial interface formed by the SEN (serial interface enable), SCLK (serial interface clock), SDATA (serial interface data), and SDOUT (serial interface data output) pins. Serially shifting bits into the device is enabled when SEN is low. Serial data SDATA are latched at every SCLK rising edge when SEN is active (low). The serial data are loaded into the register at every 24th SCLK rising edge when SEN is low. When the word length exceeds a multiple of 24 bits, the excess bits are ignored. Data may be loaded in multiples of 24-bit words within a single active SEN pulse. The interface may function with SCLK frequencies from 20 MHz down to very low speeds (of a few hertz) and also with a non-50% SCLK duty cycle.

Programming (continued)

9.5.1.1 Register Initialization

After power-up, the internal registers must be initialized to their default values through a hardware reset by applying a high pulse on the RESET pin (of durations greater than 10 ns), as shown in Figure 157. If required, the serial interface registers may be cleared during operation either:

1. Through a hardware reset, or
2. By applying a software reset. When using the serial interface, set the RESET bit (D0 in register address 06h) to high. This setting initializes the internal registers to the default values and then self-resets the RESET bit low. In this case, the RESET pin is kept low.

9.5.1.1.1 Serial Register Write

The device internal register may be programmed with these steps:

1. Drive the SEN pin low,
2. Set the R/W bit to 0 (bit A15 of the 16-bit address),
3. Set bit A14 in the address field to 1,
4. Initiate a serial interface cycle by specifying the address of the register (A13 to A0) whose content must be written, and
5. Write the 8-bit data that are latched in on the SCLK rising edge.

Figure 157 and Table 6 show the timing requirements for the serial register write operation.

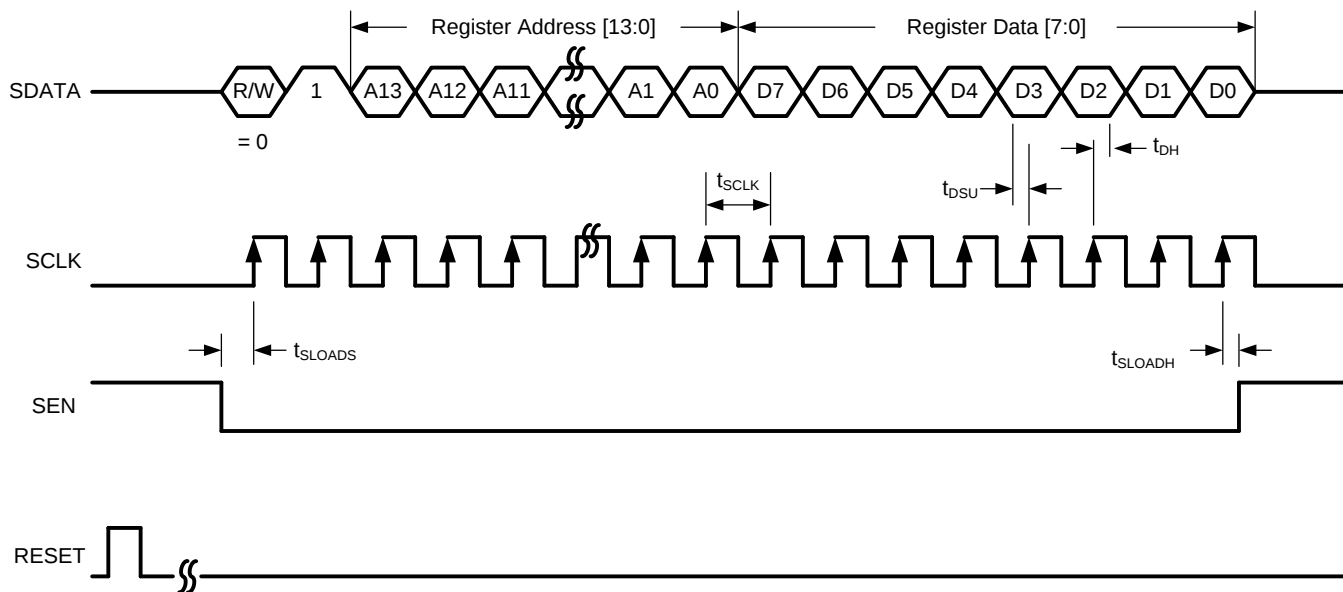


Figure 157. Serial Register Write Timing Diagram

Table 6. Serial Interface Timing⁽¹⁾

		MIN	TYP	MAX	UNIT
f_{SCLK}	SCLK frequency (equal to $1 / t_{SCLK}$)	> DC		20	MHz
t_{LOADS}	SEN to SCLK setup time	25			ns
t_{LOADH}	SCLK to SEN hold time	25			ns
t_{DSU}	SDIO setup time	25			ns
t_{DH}	SDIO hold time	25			ns

(1) Typical values are at 25°C, full temperature range is from $T_{MIN} = -40^{\circ}\text{C}$ to $T_{MAX} = 85^{\circ}\text{C}$, and $AVDD = DVDD = 1.8\text{ V}$, unless otherwise noted.

9.5.1.1.2 Serial Register Readout

The device includes a mode where the contents of the internal registers may be read back using the SDOUT pin. This readback mode may be useful as a diagnostic check to verify the serial interface communication between the external controller and the ADC. The procedure to read the contents of the serial registers is as follows:

1. Drive the SEN pin low.
2. Set the R/W bit (A15) to 1. This setting disables any further writes to the registers.
3. Set bit A14 in the address field to 1.
4. Initiate a serial interface cycle specifying the address of the register (A13 to A0) whose content must be read.
5. The device outputs the contents (D7 to D0) of the selected register on the SDOUT pin.
6. The external controller may latch the contents at the SCLK rising edge.
7. To enable register writes, reset the R/W register bit to 0.

When READOUT is disabled, the SDOUT pin is in a high-impedance mode. If serial readout is not used, the SDOUT pin must float. [Figure 158](#) shows a timing diagram of the serial register read operation. Data appear on the SDOUT pin at the SCLK falling edge with an approximate delay (t_{SD_DELAY}) of 20 ns, as shown in [Figure 159](#).

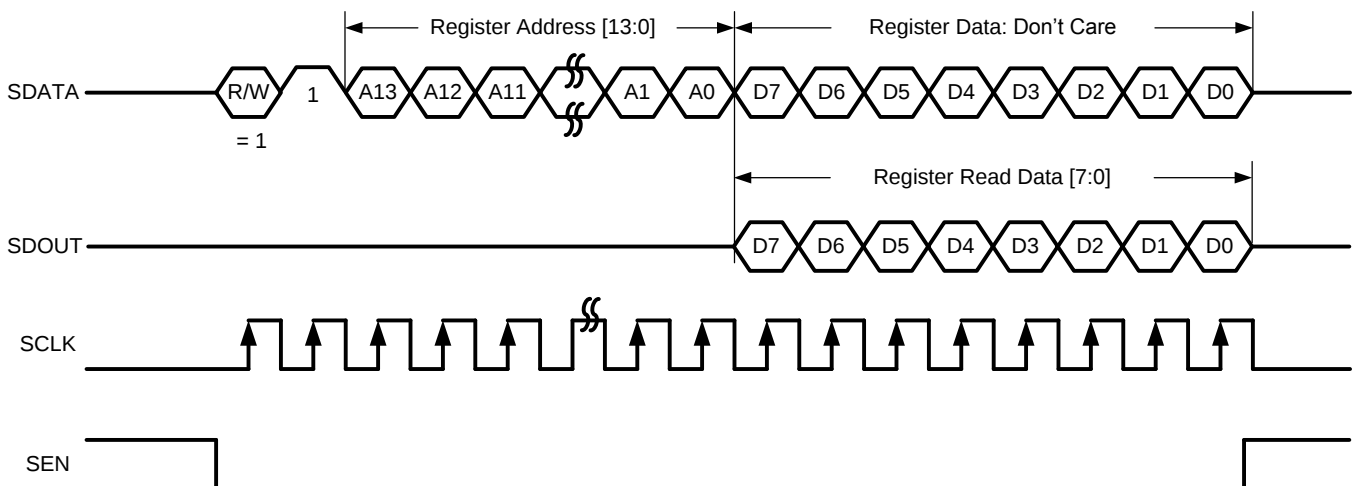


Figure 158. Serial Register Read Timing Diagram

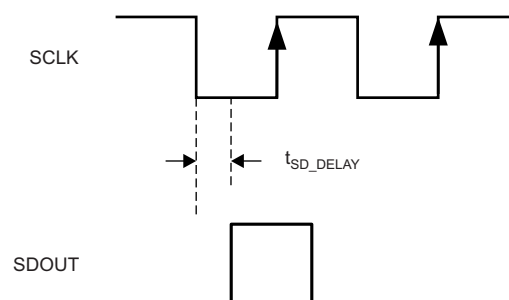


Figure 159. SDOUT Timing Diagram

9.5.2 ADC3441 Power-Up Requirements

Power-up begins with the application of AVDD and DVDD. The exact sequencing and ramp rate of AVDD and DVDD are not important as long as the parameters in [Table 7](#) are met.

After power-up, the RESET pin must be pulsed high to reset the internal registers to the default values. [Figure 160](#) and [Table 7](#) show a power-up sequence.

During operation, the device registers can be restored to the default values by either pulsing the RESET pin high or by issuing a software reset via the SPI interface. A software reset can be issued by writing bit 0 of register 06h high. This bit is self-clearing.

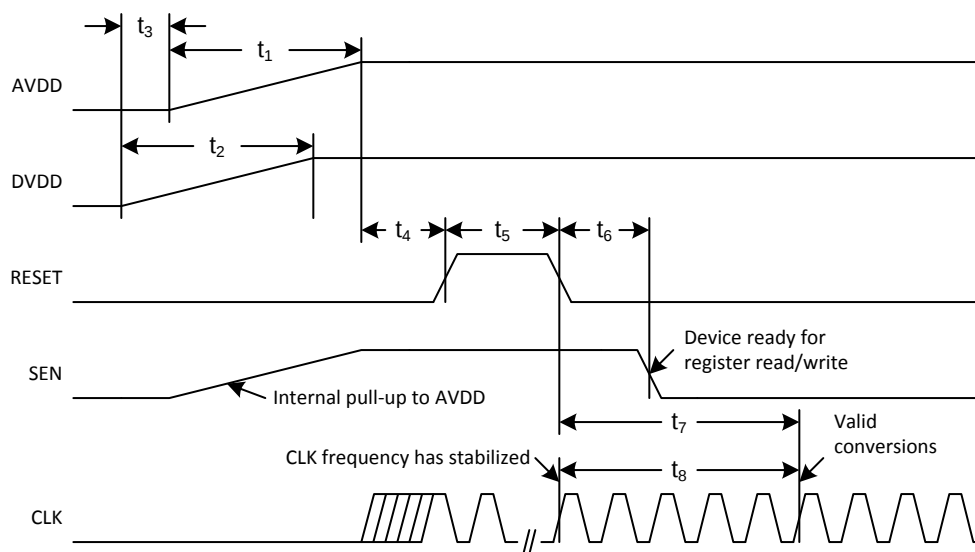


Figure 160. Power-Up Timing

Table 7. Power-Up Timing Table

		MIN	NOM	MAX	UNIT
t ₁	AVDD supply power-up ramp time			10	ms
t ₂	DVDD supply power-up ramp time			10	ms
t ₃	AVDD to DVDD power-up delay	-10		10	ms
t ₄	Device power-up to RESET assertion	1			ms
t ₅	RESET assertion duration	10			ns
t ₆	RESET deassertion to SEN assertion	10			μs
t ₇	RESET deassertion to valid conversions	150			μs
t ₈	CLK stable frequency to valid conversions	150			μs

After the power supplies are valid, enable the sample clock. The sampling clock can be enabled before or after reset, but conversions are not valid until at least a minimum time after reset and the time that the sample clock reaches a stable frequency, as shown in [Table 7](#).

ADC3441, ADC3442, ADC3443, ADC3444

ZHCSE80B – JULY 2014 – REVISED APRIL 2017

www.ti.com.cn

Before using samples from the device, a minimum register write sequence must be applied, as described in [Table 8](#). Apply this register write sequence after any further application of the hardware or software reset.

Table 8. Required Register Writes after Power-up or Reset

ADDRESS	DATA	NOTE
139h	08h	Channel A - best performance default
439h	08h	Channel B - best performance default
539h	08h	Channel C - best performance default
239h	08h	Channel D - best performance default
137h	40h	ADC core latch reset
437h	40h	
537h	40h	
237h	40h	
137h	00h	
437h	00h	
537h	00h	
237h	00h	

These register writes configure the optimal settings for ADC performance and apply a reset to the internal latches inside the ADC core that are not part of the device reset function. After the register writes of [Table 8](#) are written, any use-case-specific registers must be applied before using the conversion values.

9.6 Register Maps

Table 9. Register Map Summary

REGISTER ADDRESS, A[13:0] (Hex)	REGISTER DATA							
	7	6	5	4	3	2	1	0
Register 01h	DIS DITH CHA		DIS DITH CHB		DIS DITH CHC		DIS DITH CHD	
Register 03h	0	0	0	0	0	0	0	ODD EVEN
Register 04h	0	0	0	0	0	0	0	FLIP WIRE
Register 05h	0	0	0	0	0	0	0	1W-2W
Register 06h	0	0	0	0	0	0	TEST PATTERN EN	RESET
Register 07h	0	0	0	0	0	0	0	OVR ON LSB
Register 09h	0	0	0	0	0	0	ALIGN TEST PATTERN	DATA FORMAT
Register 0Ah	CHA TEST PATTERN				CHB TEST PATTERN			
Register 0Bh	CHC TEST PATTERN				CHD TEST PATTERN			
Register 13h	0	0	0	0	0	0	LOW SPEED ENABLE	
Register 0Eh	CUSTOM PATTERN[13:6]							
Register 0Fh	CUSTOM PATTERN[5:0]						0	0
Register 15h	CHA PDN	CHB PDN	CHC PDN	CHD PDN	STANDBY	GLOBAL PDN	0	CONFIG PDN PIN
Register 25h	LVDS SWING							
Register 27h	CLK DIV		0	0	0	0	0	0
Register 11Dh	0	0	0	0	0	0	HIGH IF MODE0	0
Register 122h	0	0	0	0	0	0	DIS CHOP CHA	0
Register 134h	0	0	DIS DITH CHA	0	DIS DITH CHA	0	0	0
Register 139h	0	0	0	0	SP1 CHA	0	0	0
Register 21Dh	0	0	0	0	0	0	HIGH IF MODE1	0
Register 222h	0	0	0	0	0	0	DIS CHOP CHD	0
Register 234h	0	0	DIS DITH CHD	0	DIS DITH CHD	0	0	0
Register 239h	0	0	0	0	SP1 CHD	0	0	0
Register 308	HIGH IF MODE <5:4>		0	0	0	0	0	0
Register 41Dh	0	0	0	0	0	0	HIGH IF MODE2	0
Register 422h	0	0	0	0	0	0	DIS CHOP CHB	0
Register 434h	0	0	DIS DITH CHB	0	DIS DITH CHB	0	0	0
Register 439h	0	0	0	0	SP1 CHB	0	0	0
Register 51Dh	0	0	0	0	0	0	HIGH IF MODE3	0
Register 522h	0	0	0	0	0	0	DIS CHOP CHC	0
Register 534h	0	0	DIS DITH CHC	0	DIS DITH CHC	0	0	0
Register 539h	0	0	0	0	SP1 CHC	0	0	0
Register 608h	HIGH IF MODE <7:6>		0	0	0	0	0	0
Register 70Ah	0	0	0	0	0	0	0	PDN SYSREF

9.6.1 Serial Register Description

9.6.1.1 Register 01h (address = 01h)

Figure 161. Register 01h

7	6	5	4	3	2	1	0
DIS DITH CHA		DIS DITH CHB		DIS DITH CHC		DIS DITH CHD	
R/W-0h		R/W-0h		R/W-0h		R/W-0h	

LEGEND: R/W = Read/Write; -n = value after reset

Table 10. Register 01h Field Descriptions

Bit	Field	Type	Reset	Description
7-6	DIS DITH CHA	R/W	0h	These bits enable or disable the on-chip dither. Control this bit along with bits 5 and 3 of register 134h. 00 = Default 11 = Dither is disabled for channel A. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
5-4	DIS DITH CHB	R/W	0h	These bits enable or disable the on-chip dither. Control this bit along with bits 5 and 3 of register 434h. 00 = Default 11 = Dither is disabled for channel B. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
3-2	DIS DITH CHC	R/W	0h	These bits enable or disable the on-chip dither. Control this bit along with bits 5 and 3 of register 534h. 00 = Default 11 = Dither is disabled for channel B. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
1-0	DIS DITH CHD	R/W	0h	These bits enable or disable the on-chip dither. Control this bit along with bits 5 and 3 of register 234h. 00 = Default 11 = Dither is disabled for channel B. In this mode, SNR typically improves by 0.5 dB at 70 MHz.

9.6.1.2 Register 03h (address = 03h)

Figure 162. Register 03h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	ODD EVEN
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 11. Register 03h Field Descriptions

Bit	Field	Type	Reset	Description
7-1	0	W	0h	Must write 0.
0	ODD EVEN	R/W	0h	This bit selects the bit sequence on the output wires (in 2-wire mode only). 0 = Bits 0, 1, 2, and so forth appear on wire-0; bits 7, 8, 9, and so forth appear on wire-1. 1 = Bits 0, 2, 4, and so forth appear on wire-0; bits 1, 3, 5, and so forth appear on wire-1.

9.6.1.3 Register 04h (address = 04h)

Figure 163. Register 04h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	FLIP WIRE
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 12. Register 04h Field Descriptions

Bit	Field	Type	Reset	Description
7-1	0	W	0h	Must write 0.
0	FLIP WIRE	R/W	0h	This bit flips the data on the output wires. Valid only in two wire configuration. 0 = Default 1 = Data on output wires is flipped. Pin D0x becomes D1x, and vice versa.

9.6.1.4 Register 05h (address = 05h)

Figure 164. Register 05h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	1W-2W
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 13. Register 05h Field Descriptions

Bit	Field	Type	Reset	Description
7-1	0	W	0h	Must write 0.
0	1W-2W	R/W	0h	This bit transmits output data on either one or two wires. 0 = Output data are transmitted on two wires (Dx0P, Dx0M and Dx1P, Dx1M) 1 = Output data are transmitted on one wire (Dx0P, Dx0M). In this mode, the recommended f_s is less than 80 MSPS.

9.6.1.5 Register 06h (address = 06h)

Figure 165. Register 06h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	TEST PATTERN EN	RESET
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 14. Register 06h Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	TEST PATTERN EN	R/W	0h	Enables test pattern selection for the digital outputs. 0 = Normal output 1 = Test pattern output enabled
0	RESET	R/W	0h	Software reset applied. This bit resets all internal registers to the default values and self-clears to 0.

9.6.1.6 Register 07h (address = 07h)

Figure 166. Register 07h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	OVR ON LSB
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 15. Register 07h Field Descriptions

Bit	Field	Type	Reset	Description
7-1	0	W	0h	Must write 0.
0	OVR ON LSB	R/W	0h	OVR information on the LSB bits. 0 = Output data bit 0 functions as the LSB of the 14-bit data 1 = Output data bit 0 carries the overrange (OVR) information.

9.6.1.7 Register 09h (address = 09h)

Figure 167. Register 09h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	ALIGN TEST PATTERN	DATA FORMAT
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 16. Register 09h Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	ALIGN TEST PATTERN	R/W	0h	This bit aligns the test patterns across the outputs of both channels. 0 = Test patterns of both channels are free running 1 = Test patterns of both channels are aligned
0	DATA FORMAT	R/W	0h	Digital output data format. 0 = Twos complement 1 = Offset binary

9.6.1.8 Register 0Ah (address = 0Ah)

Figure 168. Register 0Ah

7	6	5	4	3	2	1	0
CHA TEST PATTERN				CHB TEST PATTERN			
R/W-0h				R/W-0h			

LEGEND: R/W = Read/Write; -n = value after reset

Table 17. Register 0Ah Field Descriptions

Bit	Field	Type	Reset	Description
7-4	CHA TEST PATTERN	R/W	0h	These bits control the test pattern for channel A after the TEST PATTERN EN bit is set. 0000 = Normal operation 0001 = All 0's 0010 = All 1's 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 16383 0101 = Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits 0110 = Deskew pattern: data are 2AAAh 1000 = PRBS pattern: data are a sequence of pseudo random numbers 1001 = 8-point sine-wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: 0, 2399, 8192, 13984, 16383, 13984, 8192, 2399. Others = Do not use
3-0	CHB TEST PATTERN	R/W	0h	These bits control the test pattern for channel B after the TEST PATTERN EN bit is set. 0000 = Normal operation 0001 = All 0's 0010 = All 1's 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 16383 0101 = Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits 0110 = Deskew pattern: data are 2AAAh 1000 = PRBS pattern: data are a sequence of pseudo random numbers 1001 = 8-point sine-wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: 0, 2399, 8192, 13984, 16383, 13984, 8192, 2399. Others = Do not use

9.6.1.9 Register 0Bh (address = 0Bh)

Figure 169. Register 0Bh

7	6	5	4	3	2	1	0
CHC TEST PATTERN				CHD TEST PATTERN			
R/W-0h				R/W-0h			

LEGEND: R/W = Read/Write; -n = value after reset

Table 18. Register 0Bh Field Descriptions

Bit	Field	Type	Reset	Description
7-4	CHC TEST PATTERN	R/W	0h	These bits control the test pattern for channel C after the TEST PATTERN EN bit is set. 0000 = Normal operation 0001 = All 0's 0010 = All 1's 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 16383 0101 = Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits 0110 = Deskew pattern: data are 2AAAh 1000 = PRBS pattern: data are a sequence of pseudo random numbers 1001 = 8-point sine-wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: 0, 2399, 8192, 13984, 16383, 13984, 8192, 2399. Others = Do not use
3-0	CHD TEST PATTERN	R/W	0h	These bits control the test pattern for channel D after the TEST PATTERN EN bit is set. 0000 = Normal operation 0001 = All 0's 0010 = All 1's 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 16383 0101 = Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits 0110 = Deskew pattern: data are 2AAAh 1000 = PRBS pattern: data are a sequence of pseudo random numbers 1001 = 8-point sine-wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: 0, 2399, 8192, 13984, 16383, 13984, 8192, 2399. Others = Do not use

9.6.1.10 Register 13h (address = 13h)

Figure 170. Register 13h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	LOW SPEED ENABLE	
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 19. Register 13h Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1-0	LOW SPEED ENABLE	R/W	0h	Enables low speed operation in 1-wire and 2-wire mode. Depending upon sampling frequency, write this bit as per Table 20 .

Table 20. LOW SPEED ENABLE Register Settings Across f_s

f_s , MSPS		REGISTER BIT LOW SPEED ENABLE	
MIN	MAX	1-WIRE MODE	2-WIRE MODE
25	125	00	00
20	25	00	10
15	20	10	Not supported

9.6.1.11 Register 0Eh (address = 0Eh)

Figure 171. Register 0Eh

7	6	5	4	3	2	1	0
CUSTOM PATTERN[13:6]							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

Table 21. Register 0Eh Field Descriptions

Bit	Field	Type	Reset	Description
7-0	CUSTOM PATTERN[13:6]	R/W	0h	These bits set the 14-bit custom pattern (bits 13-6) for all channels.

9.6.1.12 Register 0Fh (address = 0Fh)

Figure 172. Register 0Fh

7	6	5	4	3	2	1	0
CUSTOM PATTERN[5:0]						0	0
R/W-0h						W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 22. Register 0Fh Field Descriptions

Bit	Field	Type	Reset	Description
7-2	CUSTOM PATTERN[5:0]	R/W	0h	These bits set the 14-bit custom pattern (bits 5-0) for all channels.
1-0	0	W	0h	Must write 0.

9.6.1.13 Register 15h (address = 15h)
Figure 173. Register 15h

7	6	5	4	3	2	1	0
CHA PDN	CHB PDN	CHC PDN	CHD PDN	STANDBY	GLOBAL PDN	0	CONFIG PDN PIN
W-0h	R/W-0h	R/W-0h	W-0h	R/W-0h	R/W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 23. Register 15h Field Descriptions

Bit	Field	Type	Reset	Description
7	CHA PDN	W	0h	0 = Normal operation 1 = Power-down channel A
6	CHB PDN	R/W	0h	0 = Normal operation 1 = Power-down channel B
5	CHC PDN	R/W	0h	0 = Normal operation 1 = Power-down channel C
4	CHD PDN	W	0h	0 = Normal operation 1 = Power-down channel D
3	STANDBY	R/W	0h	ADCs of both channels enter standby. 0 = Normal operation 1 = Standby
2	GLOBAL PDN	R/W	0h	0 = Normal operation 1 = Global power-down
1	0	W	0h	Must write 0.
0	CONFIG PDN PIN	R/W	0h	This bit configures the PDN pin as either a global power-down or standby pin. 0 = Logic high voltage on PDN pin sends the device into global power-down 1 = Logic high voltage on PDN pin sends the device into standby

9.6.1.14 Register 25h (address = 25h)
Figure 174. Register 25h

7	6	5	4	3	2	1	0
LVDS SWING							
R/W-0h							

LEGEND: R/W = Read/Write; -n = value after reset

Table 24. Register 25h Field Descriptions

Bit	Field	Type	Reset	Description
7-0	LVDS SWING	R/W	0h	These bits control the swing of the LVDS outputs (including the data output, bit clock, and frame clock).

9.6.1.15 Register 27h (address = 27h)

Figure 175. Register 27h

7	6	5	4	3	2	1	0
CLK DIV	0	0	0	0	0	0	0
R/W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 25. Register 27h Field Descriptions

Bit	Field	Type	Reset	Description
7-6	CLK DIV	R/W	0h	Internal clock divider for the input sampling clock. 00 = Divide-by-1 01 = Divide-by-1 10 = Divide-by-2 11 = Divide-by-4
5-0	0	W	0h	Must write 0.

9.6.1.16 Register 11Dh (address = 11Dh)

Figure 176. Register 11Dh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	HIGH IF MODE0	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 26. Register 11Dh Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	HIGH IF MODE0			Set the HIGH IF MODE[7:0] bits together to 1111. Improves HD3 by a couple of dB for IF > 100 MHz.
0	0	W	0h	Must write 0.

9.6.1.17 Register 122h (address = 122h)

Figure 177. Register 122h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	DIS CHOP CHA	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 27. Register 122h Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	DIS CHOP CHA	R/W	0h	Disables the chopper. Set this bit to shift 1/f noise floor at dc. 0 = 1/f noise floor is centered at $f_s / 2$ (default) 1 = Chopper mechanism is disabled; 1/f noise floor is centered at dc
0	0	W	0h	Must write 0.

9.6.1.18 Register 134h (address = 134h)

Figure 178. Register 134h

7	6	5	4	3	2	1	0
0	0	DIS DITH CHA	0	DIS DITH CHA	0	0	0
W-0h	W-0h	R/W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 28. Register 134h Field Descriptions

Bit	Field	Type	Reset	Description
7-6	0	W	0h	Must write 0.
5	DIS DITH CHA	R/W	0h	Set this bit with bits 7 and 6 of register 01h. 00 = Default 11 = Dither is disabled for channel A. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
4	0	W	0h	Must write 0.
3	DIS DITH CHA	R/W	0h	Set this bit with bits 7 and 6 of register 01h. 00 = Default 11 = Dither is disabled for channel A. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
2-0	0	W	0h	Must write 0.

9.6.1.19 Register 139h (address = 139h)

Figure 179. Register 139h

7	6	5	4	3	2	1	0
0	0	0	0	SP1 CHA	0	0	0
W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 29. Register 139h Field Descriptions

Bit	Field	Type	Reset	Description
7-4	0	W	0h	Must write 0.
3	SP1 CHA	R/W	0h	Special mode for best performance on channel A. Always write 1 after reset.
2-0	0	W	0h	Must write 0.

9.6.1.20 Register 21Dh (address = 21Dh)

Figure 180. Register 21Dh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	HIGH IF MODE1	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 30. Register 21Dh Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	HIGH IF MODE1			Set the HIGH IF MODE[7:0] bits together to 1111. Improves HD3 by a couple of dB for IF > 100 MHz.
0	0	W	0h	Must write 0.

9.6.1.21 Register 222h (address = 222h)

Figure 181. Register 222h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	DIS CHOP CHD	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 31. Register 222h Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	DIS CHOP CHD	R/W	0h	Disables the chopper. Set this bit to shift 1/f noise floor at dc. 0 = 1/f noise floor is centered at $f_s / 2$ (default) 1 = Chopper mechanism is disabled; 1/f noise floor is centered at dc
0	0	W	0h	Must write 0.

9.6.1.22 Register 234h (address = 234h)

Figure 182. Register 234h

7	6	5	4	3	2	1	0
0	0	DIS DITH CHD	0	DIS DITH CHD	0	0	0
W-0h	W-0h	R/W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 32. Register 234h Field Descriptions

Bit	Field	Type	Reset	Description
7-6	0	W	0h	Must write 0.
5	DIS DITH CHD	R/W	0h	Set this bit with bits 1 and 0 of register 01h. 00 = Default 11 = Dither is disabled for channel D. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
4	0	W	0h	Must write 0.
3	DIS DITH CHD	R/W	0h	Set this bit with bits 1 and 0 of register 01h. 00 = Default 11 = Dither is disabled for channel D. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
2-0	0	W	0h	Must write 0.

9.6.1.23 Register 239h (address = 239h)

Figure 183. Register 239h

7	6	5	4	3	2	1	0
0	0	0	0	SP1 CHD	0	0	0
W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 33. Register 239h Field Descriptions

Bit	Field	Type	Reset	Description
7-4	0	W	0h	Must write 0.
3	SP1 CHD	R/W	0h	Special mode for best performance on channel D. Always write 1 after reset.
2-0	0	W	0h	Must write 0.

9.6.1.24 Register 308h (address = 308h)

Figure 184. Register 308h

7	6	5	4	3	2	1	0
HIGH IF MODE<5:4>	0	0	0	0	0	0	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 34. Register 308h Field Descriptions

Bit	Field	Type	Reset	Description
7-6	HIGH IF MODE<5:4>	W	0h	Set the HIGH IF MODE[7:0] bits together to FFh. Improves HD3 by a couple of dB for IF > 100 MHz.
5-0	0	W	0h	Must write 0.

9.6.1.25 Register 41Dh (address = 41Dh)

Figure 185. Register 41Dh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	HIGH IF MODE2	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 35. Register 41Dh Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	HIGH IF MODE2			Set the HIGH IF MODE[7:0] bits together to FFh. Improves HD3 by a couple of dB for IF > 100 MHz.
0	0	W	0h	Must write 0.

9.6.1.26 Register 422h (address = 422h)

Figure 186. Register 422h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	DIS CHOP CHB	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 36. Register 422h Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	DIS CHOP CHB	R/W	0h	Disables the chopper. Set this bit to shift 1/f noise floor at dc. 0 = 1/f noise floor is centered at $f_S / 2$ (default) 1 = Chopper mechanism is disabled; 1/f noise floor is centered at dc
0	0	W	0h	Must write 0.

9.6.1.27 Register 434h (address = 434h)

Figure 187. Register 434h

7	6	5	4	3	2	1	0
0	0	DIS DITH CHB	0	DIS DITH CHB	0	0	0
W-0h	W-0h	R/W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 37. Register 434h Field Descriptions

Bit	Field	Type	Reset	Description
7-6	0	W	0h	Must write 0.
5	DIS DITH CHB	R/W	0h	Set this bit with bits 5 and 4 of register 01h. 00 = Default 11 = Dither is disabled for channel B. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
4	0	W	0h	Must write 0.
3	DIS DITH CHB	R/W	0h	Set this bit with bits 5 and 4 of register 01h. 00 = Default 11 = Dither is disabled for channel B. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
2-0	0	W	0h	Must write 0.

9.6.1.28 Register 439h (address = 439h)

Figure 188. Register 439h

7	6	5	4	3	2	1	0
0	0	0	0	SP1 CHB	0	0	0
W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 38. Register 439h Field Descriptions

Bit	Field	Type	Reset	Description
7-4	0	W	0h	Must write 0.
3	SP1 CHB	R/W	0h	Special mode for best performance on channel B. Always write 1 after reset.
2-0	0	W	0h	Must write 0.

9.6.1.29 Register 51Dh (address = 51Dh)
Figure 189. Register 51Dh

7	6	5	4	3	2	1	0
0	0	0	0	0	0	HIGH IF MODE3	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 39. Register 51Dh Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	HIGH IF MODE3			Set the HIGH IF MODE[7:0] bits together to FFh. Improves HD3 by a couple of dB for IF > 100 MHz.
0	0	W	0h	Must write 0.

9.6.1.30 Register 522h (address = 522h)
Figure 190. Register 522h

7	6	5	4	3	2	1	0
0	0	0	0	0	0	DIS CHOP CHC	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 40. Register 522h Field Descriptions

Bit	Field	Type	Reset	Description
7-2	0	W	0h	Must write 0.
1	DIS CHOP CHC	R/W	0h	Disables the chopper. Set this bit to shift 1/f noise floor at dc. 0 = 1/f noise floor is centered at $f_s / 2$ (default) 1 = Chopper mechanism is disabled; 1/f noise floor is centered at dc
0	0	W	0h	Must write 0.

9.6.1.31 Register 534h (address = 534h)
Figure 191. Register 534h

7	6	5	4	3	2	1	0
0	0	DIS DITH CHC	0	DIS DITH CHC	0	0	0
W-0h	W-0h	R/W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 41. Register 534h Field Descriptions

Bit	Field	Type	Reset	Description
7-6	0	W	0h	Must write 0.
5	DIS DITH CHC	R/W	0h	Set this bit with bits 3 and 2 of register 01h. 00 = Default 11 = Dither is disabled for channel C. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
4	0	W	0h	Must write 0.
3	DIS DITH CHC	R/W	0h	Set this bit with bits 3 and 2 of register 01h. 00 = Default 11 = Dither is disabled for channel C. In this mode, SNR typically improves by 0.5 dB at 70 MHz.
2-0	0	W	0h	Must write 0.

9.6.1.32 Register 539h (address = 539h)

Figure 192. Register 539h

7	6	5	4	3	2	1	0
0	0	0	0	SP1 CHC	0	0	0
W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h	W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 42. Register 539h Field Descriptions

Bit	Field	Type	Reset	Description
7-4	0	W	0h	Must write 0.
3	SP1 CHC	R/W	0h	Special mode for best performance on channel C. Always write 1 after reset.
2-0	0	W	0h	Must write 0.

9.6.1.33 Register 608h (address = 608h)

Figure 193. Register 608h

7	6	5	4	3	2	1	0
HIGH IF MODE<7:6>	0	0	0	0	0	0	0
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h	W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 43. Register 608h Field Descriptions

Bit	Field	Type	Reset	Description
7-6	HIGH IF MODE<7:6>			Set the HIGH IF MODE[7:0] bits together to FFh. Improves HD3 by a couple of dB for IF > 100 MHz.
5-0	0	W	0h	Must write 0.

9.6.1.34 Register 70Ah (address = 70Ah)

Figure 194. Register 70Ah

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	PDN SYSREF
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	R/W-0h

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 44. Register 70Ah Field Descriptions

Bit	Field	Type	Reset	Description
7-1	0	W	0h	Must write 0.
0	PDN SYSREF	R/W	0h	If the SYSREF pins are not used in the system, the SYSREF buffer must be powered down by setting this bit. 0 = Normal operation 1 = Powers down the SYSREF buffer

10 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

10.1 Application Information

Typical applications involving transformer-coupled circuits are discussed in this section. Transformers (such as ADT1-1WT or WBC1-1) may be used up to 250 MHz to achieve good phase and amplitude balances at ADC inputs. While designing the dc driving circuits, the ADC input impedance must be considered. [Figure 195](#) and [Figure 196](#) show the impedance ($Z_{in} = R_{in} \parallel C_{in}$) across the ADC input pins.

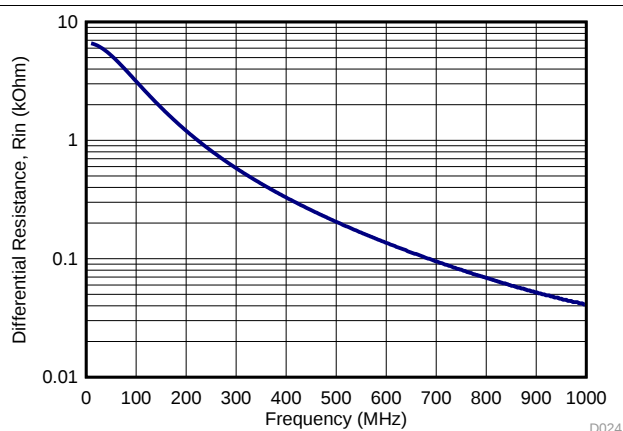


Figure 195. Differential Input Resistance, R_{IN}

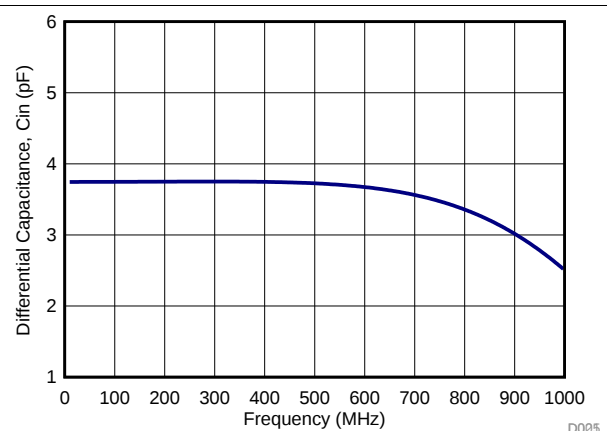


Figure 196. Differential Input Capacitance, C_{IN}

10.2 Typical Applications

10.2.1 Driving Circuit Design: Low Input Frequencies

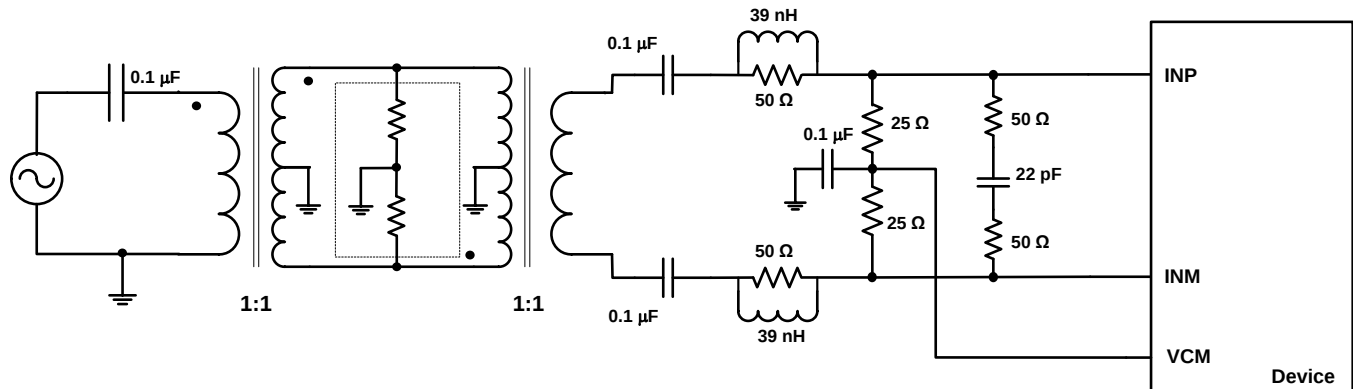


Figure 197. Driving Circuit for Low Input Frequencies

10.2.1.1 Design Requirements

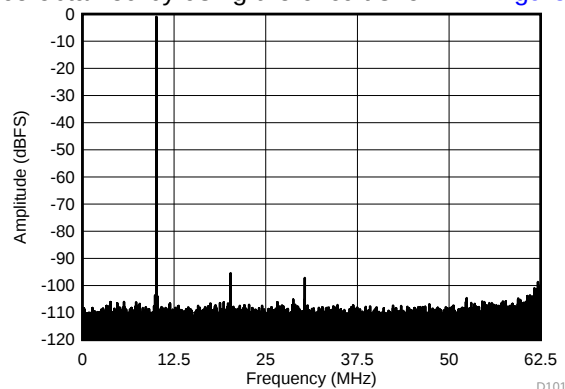
For optimum performance, the analog inputs must be driven differentially. An optional 5-Ω to 15-Ω resistor in series with each input pin may be kept to damp out ringing caused by package parasitic. The drive circuit may have to be designed to minimize the impact of kick-back noise generated by sampling switches opening and closing inside the ADC, as well as ensuring low insertion loss over the desired frequency range and matched impedance to the source.

10.2.1.2 Detailed Design Procedure

A typical application involving using two back-to-back coupled transformers is shown in [Figure 197](#). The circuit is optimized for low input frequencies. An external R-C-R filter using 50-Ω resistors and a 22-pF capacitor is used with the series inductor (39 nH), this combination helps absorb the sampling glitches. To improve phase and amplitude balance of first transformer, the termination resistors can be split between two transformers. For example, 25-Ω to 25-Ω termination across the secondary winding of the second transformer can be changed to 50-Ω to 50-Ω termination and another 50-Ω to 50-Ω resistor can be placed inside the dashed box between the transformers in [Figure 197](#).

10.2.1.3 Application Curve

[Figure 198](#) shows the performance obtained by using the circuit shown in [Figure 197](#).



SFDR = 95 dBc, SNR = 72.7 dBFS, SINAD = 72.6 dBFS,
THD = 100 dBc, HD2 = 95 dBc, HD3 = 96 dBc

**Figure 198. FFT for 10-MHz Input Signal
(Chopper On, Dither On)**

Typical Applications (continued)

10.2.2 Driving Circuit Design: Input Frequencies Between 100 MHz to 230 MHz

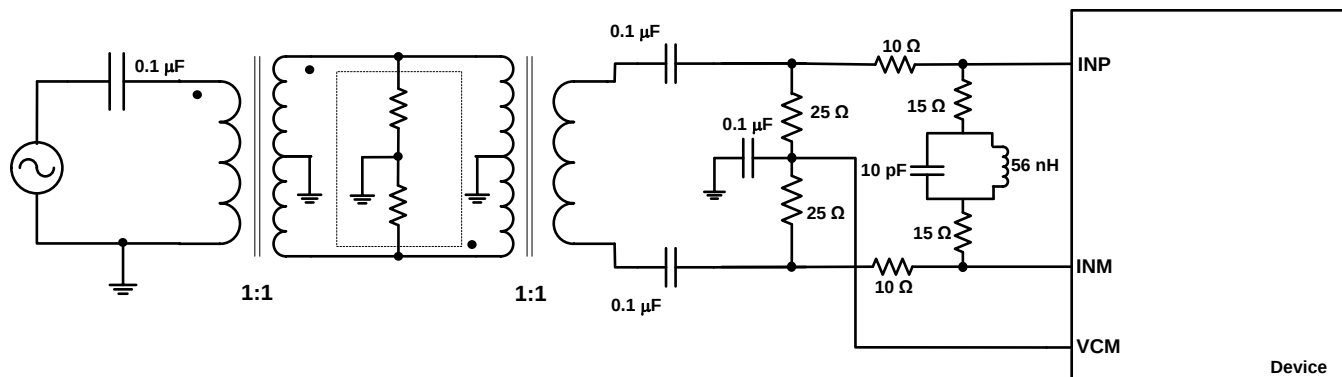


Figure 199. Driving Circuit for Mid-Range Input Frequencies ($100 \text{ MHz} < f_{\text{IN}} < 230 \text{ MHz}$)

10.2.2.1 Design Requirements

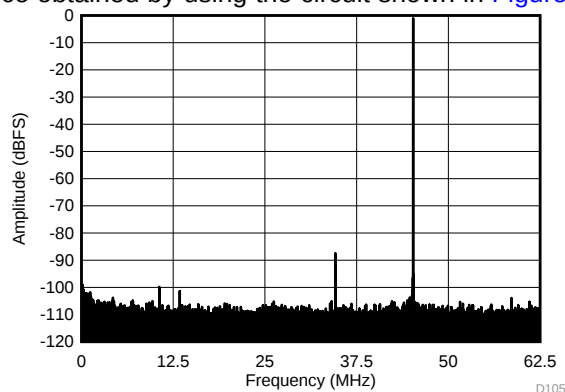
See the [Design Requirements](#) section for further details.

10.2.2.2 Detailed Design Procedure

When input frequencies are between 100 MHz to 230 MHz, an R-LC-R circuit may be used to optimize performance, as shown in [Figure 199](#).

10.2.2.3 Application Curve

[Figure 200](#) shows the performance obtained by using the circuit shown in [Figure 199](#).



SFDR = 86 dBc, SNR = 71.7 dBFS, SINAD = 71.6 dBFS,
THD = 93 dBc, HD2 = 86 dBc, HD3 = 99 dBc

Figure 200. FFT for 170-MHz Input Signal (Chopper Off, Dither On)

Typical Applications (continued)

10.2.3 Driving Circuit Design: Input Frequencies Greater than 230 MHz

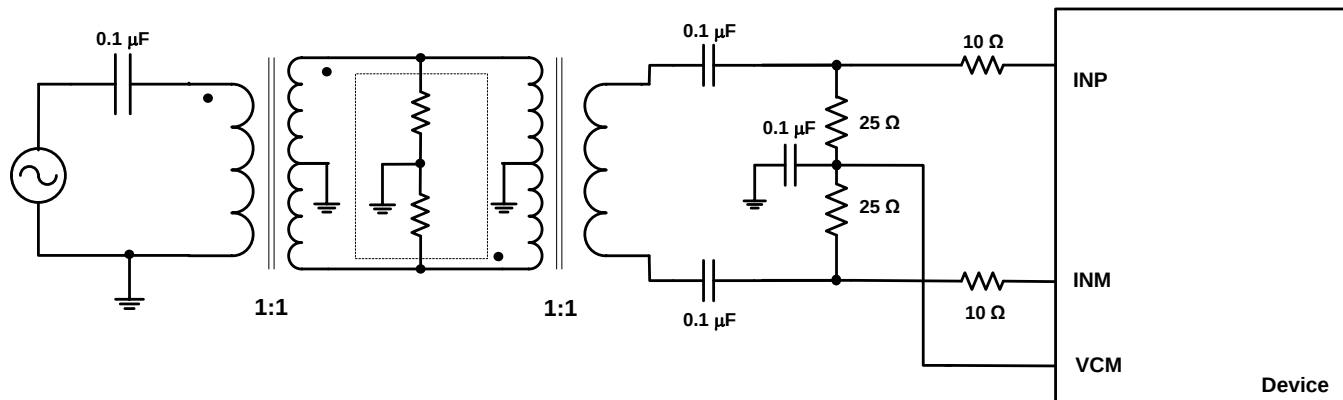


Figure 201. Driving Circuit for High Input Frequencies ($f_{IN} > 230$ MHz)

10.2.3.1 Design Requirements

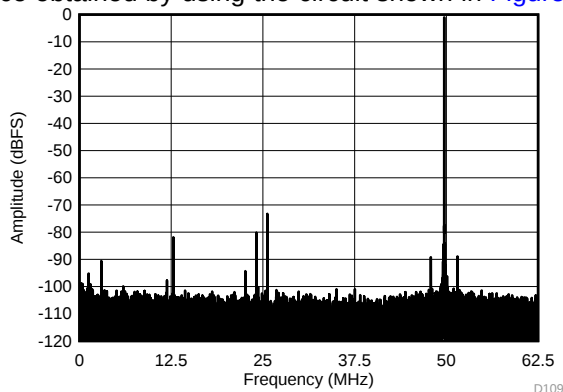
See the [Design Requirements](#) section for further details.

10.2.3.2 Detailed Design Procedure

For high input frequencies (> 230 MHz), using the R-C-R or R-LC-R circuit does not show significant improvement in performance. However, a series resistance of $10\ \Omega$ may be used as shown in [Figure 201](#).

10.2.3.3 Application Curve

[Figure 202](#) shows the performance obtained by using the circuit shown in [Figure 201](#).



SFDR = 72 dBc, SNR = 68.2 dBFS, SINAD = 67.3 dBFS,
THD = 74 dBc, HD2 = 72 dBc, HD3 = 79 dBc

Figure 202. FFT for 450-MHz Input Signal (Chopper Off, Dither On)

11 Power Supply Recommendations

The device requires a 1.8-V nominal supply for AVDD and DVDD. There are no specific sequence power-supply requirements during device power-up. AVDD and DVDD may power up in any order. See [Figure 160](#) for other power-up requirements.

12 Layout

12.1 Layout Guidelines

The ADC344x EVM layout may be used as a reference layout to obtain the best performance. A layout diagram of the EVM top layer is provided in [Figure 203](#). Some important points to remember during laying out the board are:

1. Analog inputs are located on opposite sides of the device pin out to ensure minimum crosstalk on the package level. To minimize crosstalk onboard, the analog inputs must exit the pin out in opposite directions, as shown in the reference layout of [Figure 203](#) as much as possible.
2. In the device pin out, the sampling clock is located on a side perpendicular to the analog inputs in order to minimize coupling between them. This configuration is also maintained on the reference layout of [Figure 203](#) as much as possible.
3. Keep digital outputs away from the analog inputs. When these digital outputs exit the pin out, the digital output traces must not be kept parallel to the analog input traces because this configuration may result in coupling from digital outputs to analog inputs and degrade performance. All digital output traces to the receiver [such as a field-programmable gate array (FPGA) or an application-specific integrated circuit (ASIC)] must be matched in length to avoid skew among outputs.
4. At each power-supply pin (AVDD and DVDD), keep a 0.1- μ F decoupling capacitor close to the device. A separate decoupling capacitor group consisting of a parallel combination of 10- μ F, 1- μ F, and 0.1- μ F capacitors may be kept close to the supply source.

12.2 Layout Example

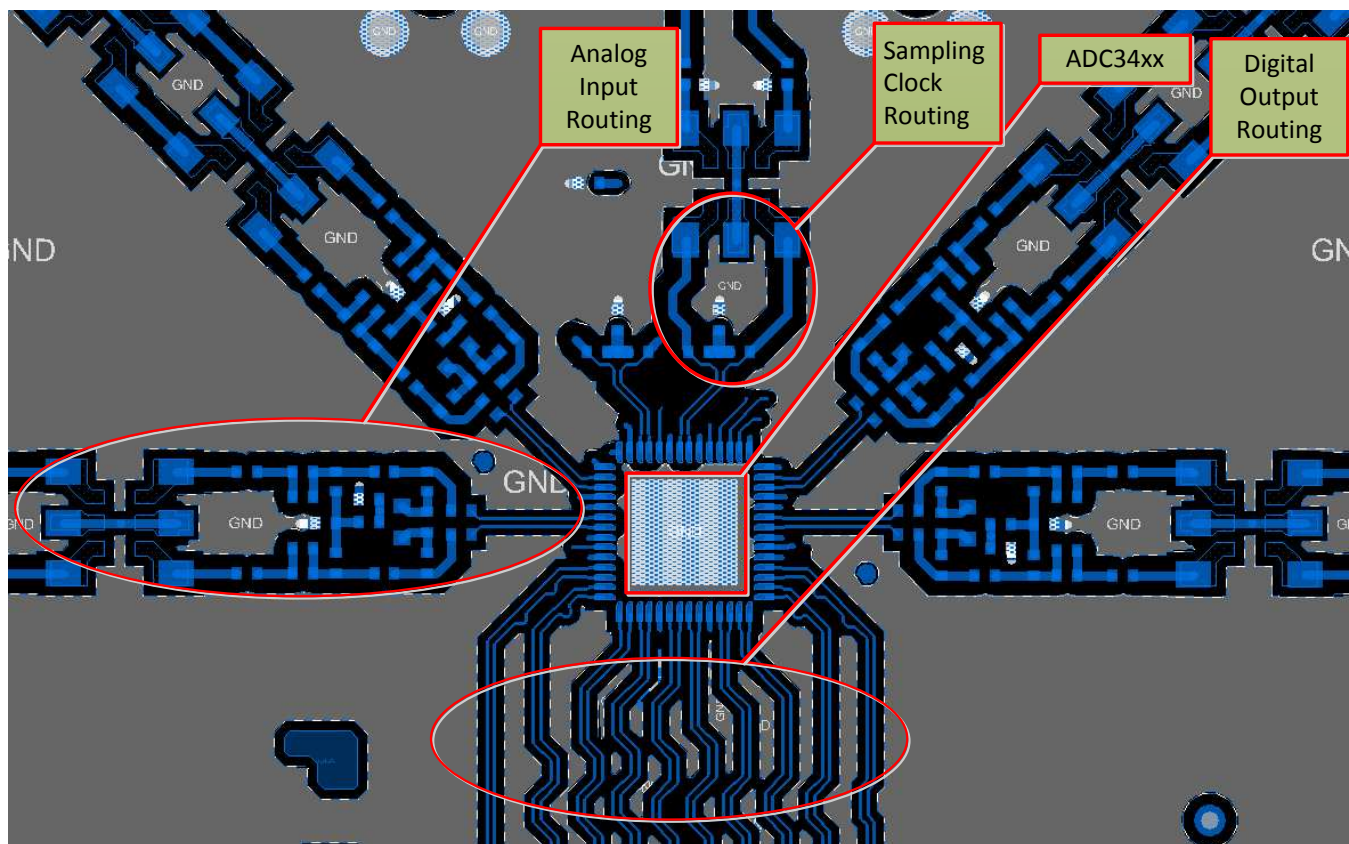


Figure 203. Typical Layout of the ADC344x Board

13 器件和文档支持

13.1 相关链接

下面的表格列出了快速访问链接。范围包括技术文档、支持与社区资源、工具和软件，并且可通过快速访问立刻订购。

表 45. 相关链接

器件	产品文件夹	立即订购	技术文档	工具与软件	支持与社区
ADC3441	请单击此处	请单击此处	请单击此处	请单击此处	请单击此处
ADC3442	请单击此处	请单击此处	请单击此处	请单击此处	请单击此处
ADC3443	请单击此处	请单击此处	请单击此处	请单击此处	请单击此处
ADC3444	请单击此处	请单击此处	请单击此处	请单击此处	请单击此处

13.2 接收文档更新通知

如需接收文档更新通知，请访问 www.ti.com.cn 网站上的器件产品文件夹。点击右上角的提醒我 (Alert me) 注册后，即可每周定期收到已更改的产品信息。有关更改的详细信息，请查阅已修订文档中包含的修订历史记录。

13.3 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

13.4 商标

PowerPAD, E2E are trademarks of Texas Instruments.
All other trademarks are the property of their respective owners.

13.5 静电放电警告



ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

13.6 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

14 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
ADC3441IRTQR	ACTIVE	QFN	RTQ	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ3441	Samples
ADC3441IRTQT	ACTIVE	QFN	RTQ	56	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ3441	Samples
ADC3442IRTQR	ACTIVE	QFN	RTQ	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ3442	Samples
ADC3442IRTQT	ACTIVE	QFN	RTQ	56	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ3442	Samples
ADC3443IRTQR	ACTIVE	QFN	RTQ	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ3443	Samples
ADC3443IRTQT	ACTIVE	QFN	RTQ	56	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ3443	Samples
ADC3444IRTQR	ACTIVE	QFN	RTQ	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ3444	Samples
ADC3444IRTQT	ACTIVE	QFN	RTQ	56	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	AZ3444	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

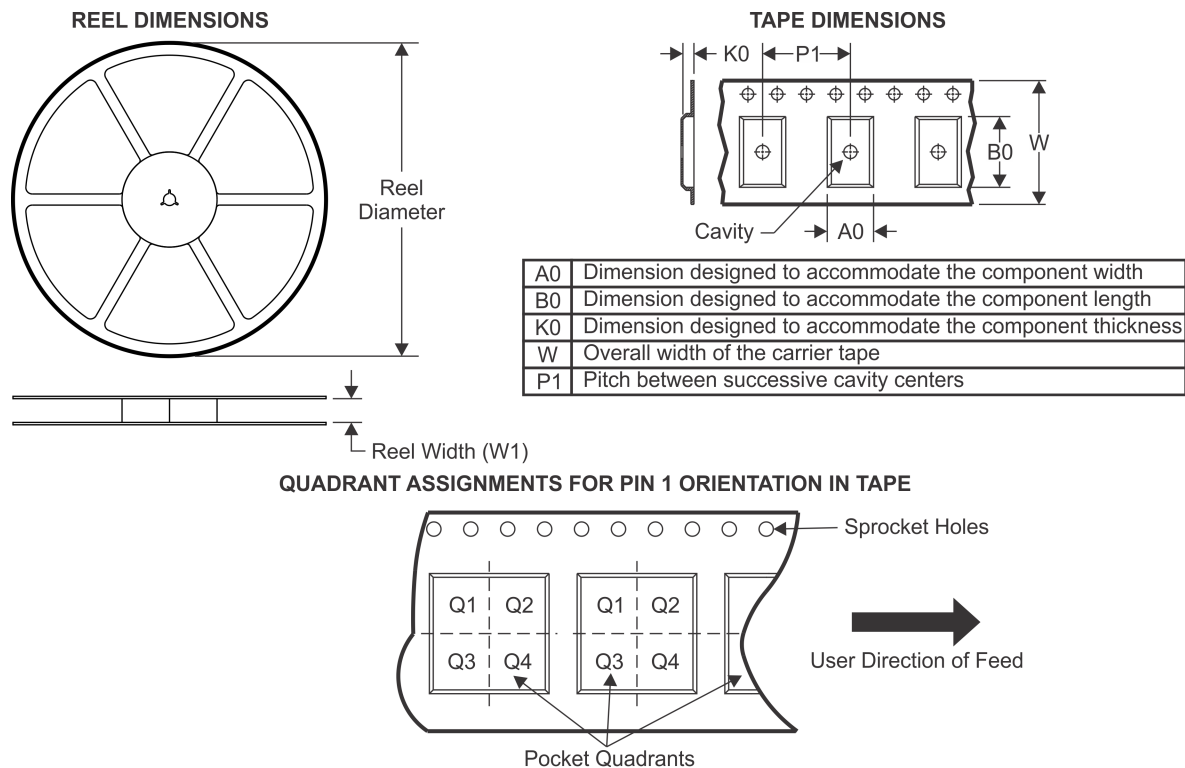
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

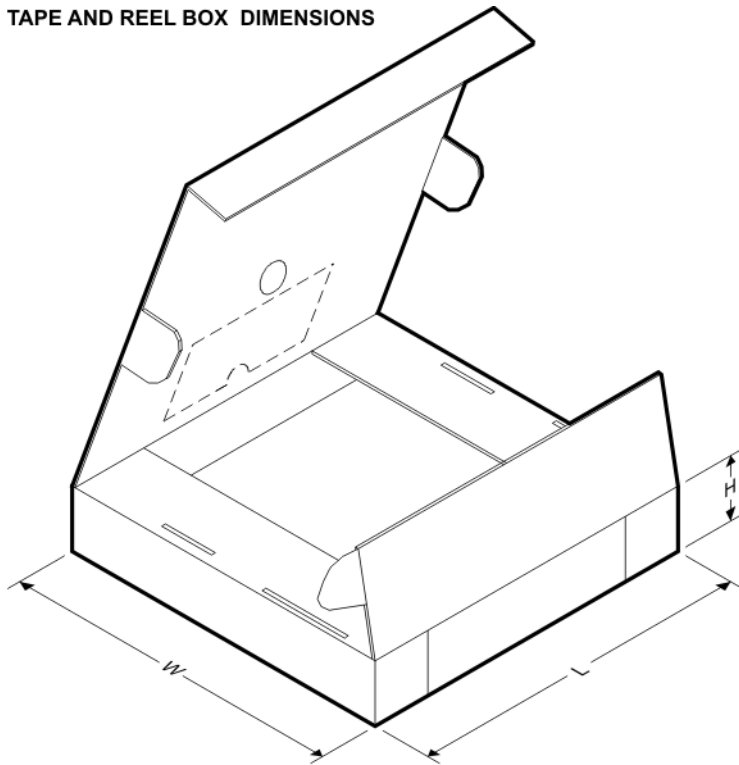
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ADC3441IRTQR	QFN	RTQ	56	2000	330.0	16.4	8.3	8.3	2.25	12.0	16.0	Q2
ADC3441IRTQT	QFN	RTQ	56	250	180.0	16.4	8.3	8.3	2.25	12.0	16.0	Q2
ADC3442IRTQR	QFN	RTQ	56	2000	330.0	16.4	8.3	8.3	2.25	12.0	16.0	Q2
ADC3442IRTQT	QFN	RTQ	56	250	180.0	16.4	8.3	8.3	2.25	12.0	16.0	Q2
ADC3443IRTQR	QFN	RTQ	56	2000	330.0	16.4	8.3	8.3	2.25	12.0	16.0	Q2
ADC3443IRTQT	QFN	RTQ	56	250	180.0	16.4	8.3	8.3	2.25	12.0	16.0	Q2
ADC3444IRTQR	QFN	RTQ	56	2000	330.0	16.4	8.3	8.3	2.25	12.0	16.0	Q2
ADC3444IRTQT	QFN	RTQ	56	250	180.0	16.4	8.3	8.3	2.25	12.0	16.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ADC3441IRTQR	QFN	RTQ	56	2000	350.0	350.0	43.0
ADC3441IRTQT	QFN	RTQ	56	250	213.0	191.0	55.0
ADC3442IRTQR	QFN	RTQ	56	2000	350.0	350.0	43.0
ADC3442IRTQT	QFN	RTQ	56	250	213.0	191.0	55.0
ADC3443IRTQR	QFN	RTQ	56	2000	350.0	350.0	43.0
ADC3443IRTQT	QFN	RTQ	56	250	213.0	191.0	55.0
ADC3444IRTQR	QFN	RTQ	56	2000	350.0	350.0	43.0
ADC3444IRTQT	QFN	RTQ	56	250	213.0	191.0	55.0

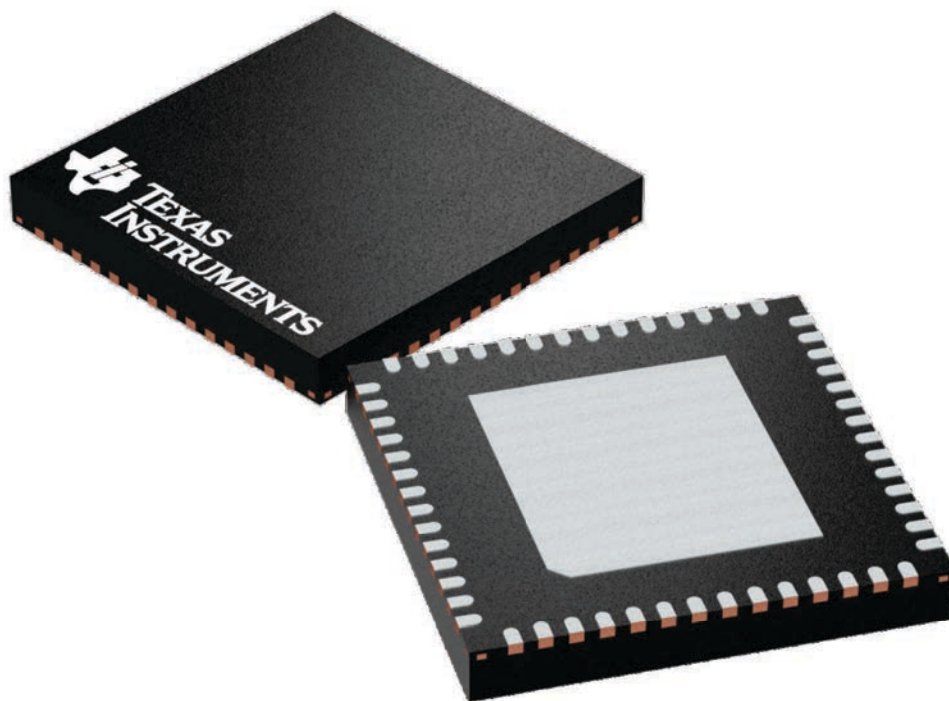
GENERIC PACKAGE VIEW

RTQ 56

VQFN - 1 mm max height

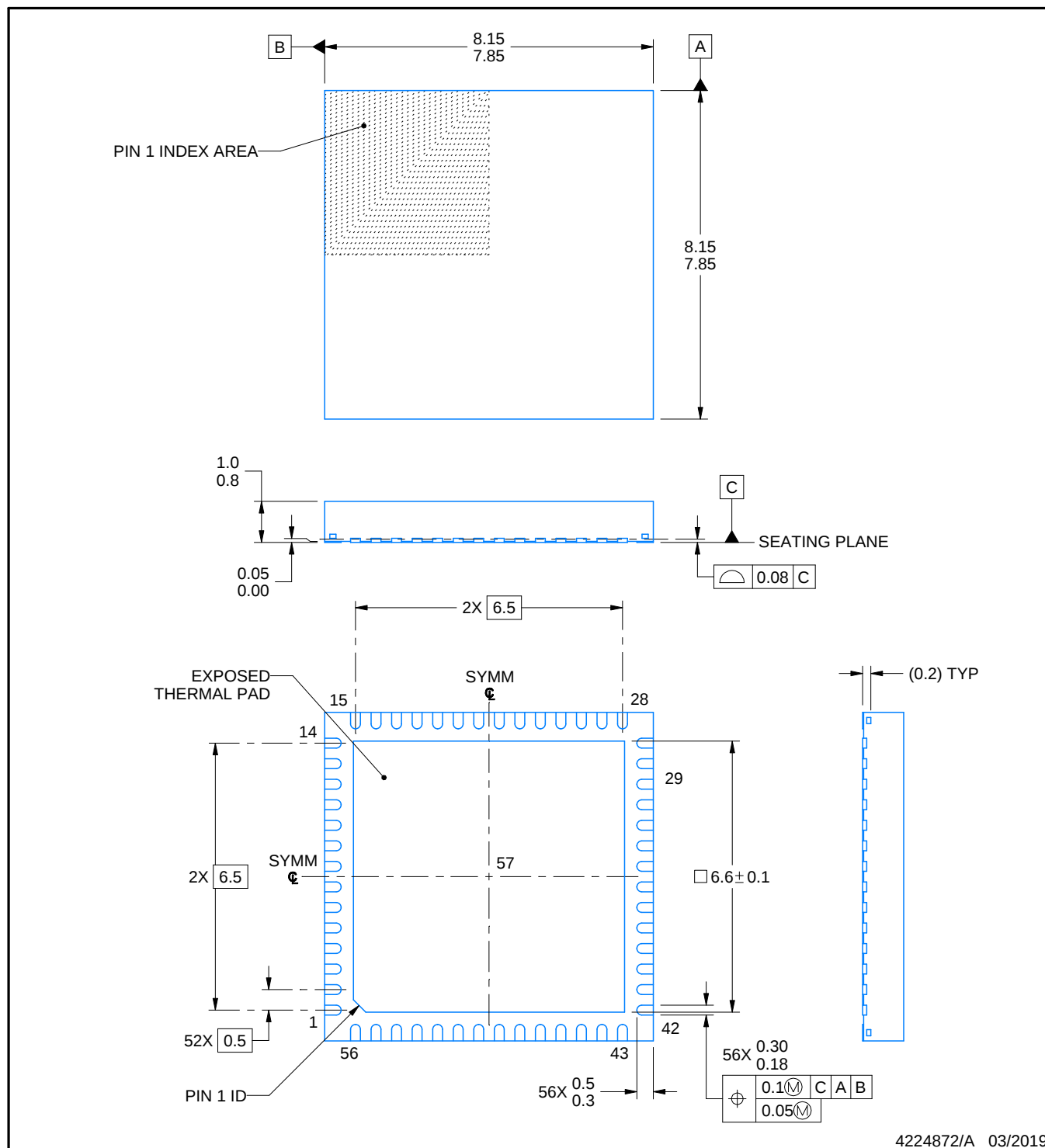
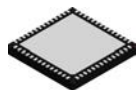
8 x 8, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

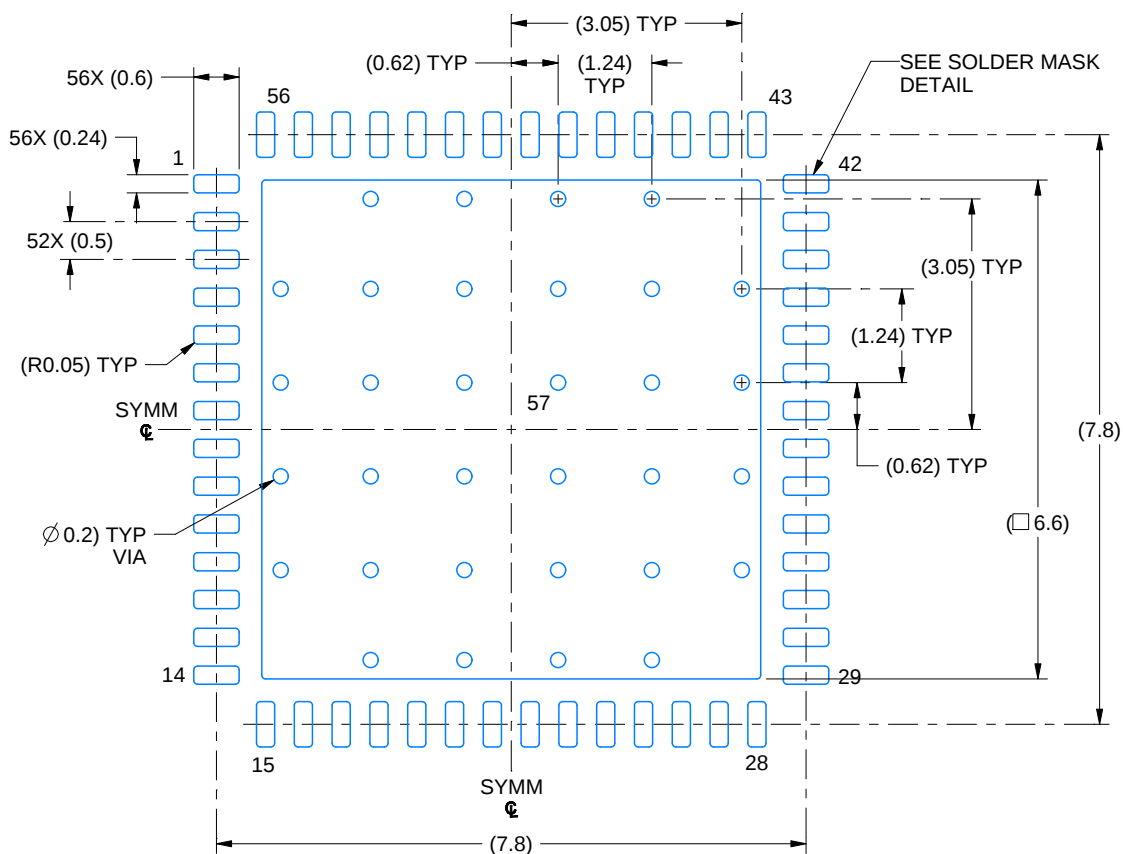
4224653/A



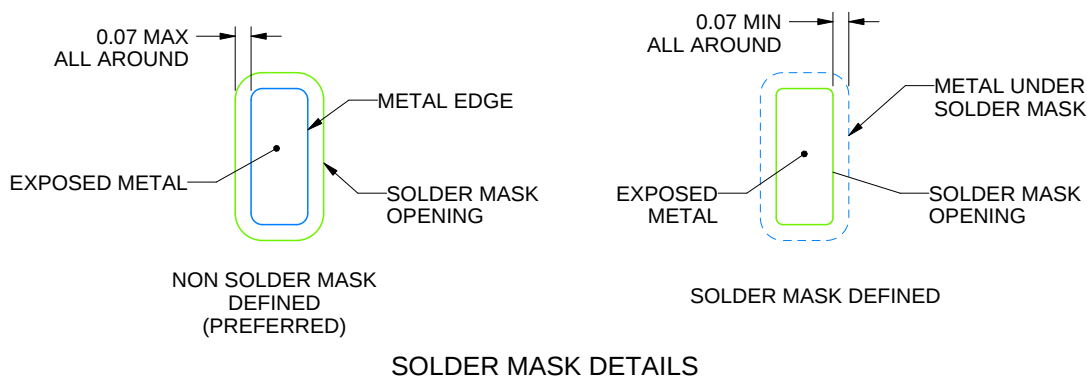
4224872/A 03/2019

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



4224872/A 03/2019

NOTES: (continued)

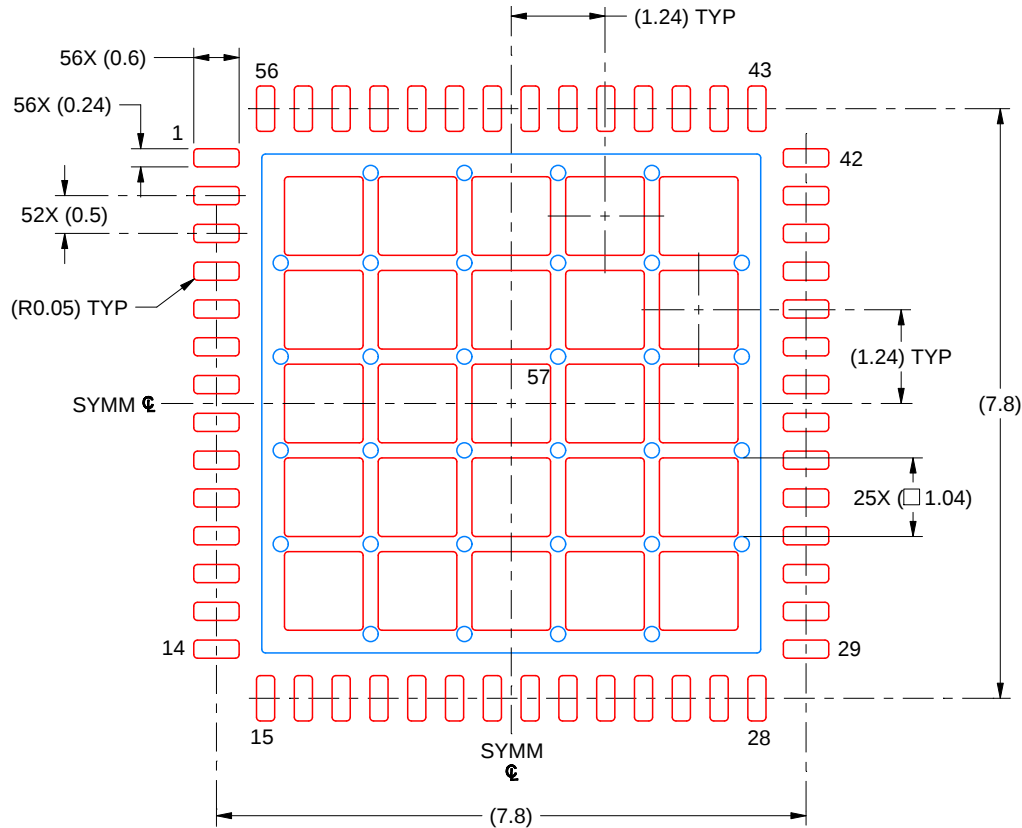
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RTQ0056C

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 10X

EXPOSED PAD 57
62% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

4224872/A 03/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

重要声明和免责声明

TI 均以“原样”提供技术性 & 可靠性数据（包括数据表）、设计资源（包括参考设计）、应用或其他设计建议、网络工具、安全信息和其他资源，不保证其中不含任何瑕疵，且不做任何明示或暗示的担保，包括但不限于对适销性、适合某特定用途或不侵犯任何第三方知识产权的暗示担保。

所述资源可供专业开发人员应用 TI 产品进行设计使用。您将对以下行为独自承担全部责任：(1) 针对您的应用选择合适的 TI 产品；(2) 设计、验证并测试您的应用；(3) 确保您的应用满足相应标准以及任何其他安全、安保或其他要求。所述资源如有变更，恕不另行通知。TI 对您使用所述资源的授权仅限于开发资源所涉及 TI 产品的相关应用。除此之外不得复制或展示所述资源，也不提供其它 TI 或任何第三方的知识产权授权许可。如因使用所述资源而产生任何索赔、赔偿、成本、损失及债务等，TI 对此概不负责，并且您须赔偿由此对 TI 及其代表造成的损害。

TI 所提供产品均受 TI 的销售条款 (<http://www.ti.com.cn/zh-cn/legal/termsofsale.html>) 以及 [ti.com.cn](http://www.ti.com.cn) 上或随附 TI 产品提供的其他可适用条款的约束。TI 提供所述资源并不扩展或以其他方式更改 TI 针对 TI 产品所发布的可适用的担保范围或担保免责声明。

邮寄地址：上海市浦东新区世纪大道 1568 号中建大厦 32 楼，邮政编码：200122
Copyright © 2019 德州仪器半导体技术（上海）有限公司